

MAX77714

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

General Description

The MAX77714 is a complete power-management IC (PMIC) for portable devices using System-on-Chip (SoC) applications processors.

Two 2A (SD2/3), one 3A (SD1), and one 4A (SD0) step-down regulator switch at 2MHz, allowing the use of small magnetic components. The output voltages for SD0 and SD1 are programmable from 0.26V to 1.52V in 10mV steps. The output voltage for SD2 is programmable from 0.6V to 2.194V in 6.5mV steps. The output voltage for SD3 is programmable from 0.6V to 3.78V in 12.5mV steps.

Nine low-dropout (LDO) linear regulators supply power to various system blocks. Each LDO features a programmable active-discharge circuit in shutdown. All LDOs feature two soft-start rates to limit inrush current during startup.

Eight programmable GPIOs can be programmed as general purpose inputs (GPI), general purpose outputs (GPO), or alternate modes for additional functionalities.

The real-time clock (RTC) with an external crystal oscillator provides time keeping and alarm wake-up functions. An internal silicon oscillator is available for systems that do not want to use the crystal oscillator. In addition, a watchdog timer is integrated for system monitoring purposes.

An integrated ON/OFF controller, in combination with flexible power sequencer (FPS), provides maximum flexibility in setting power-up/down sequences with minimal intervention from the applications processor.

The 70-bump, 4.1mm x 3.25mm x 0.7mm, 0.4mm pitch wafer-level package (WLP) is ideal for space constrained applications.

Factory-programmable options allow the MAX77714 to be tailored for many applications. Contact the factory for more information about programmable options; minimum order quantities may apply.

Applications

- Drones
- Smartphones/Tablet PCs
- Handheld Gaming Devices
- AR/VR Headsets
- Streaming Devices/Set-Top Boxes
- Home Automation Hubs
- Digital Cameras
- Automotive Aftermarket Accessories

Benefits and Features

- Highly Integrated
 - 4x Buck Regulators
 - SD0/1 Peak Efficiency > 90% at 3.6V_{IN}, 1.1V_{OUT}
 - SD2/3 Peak Efficiency > 93% at 3.6V_{IN}, 1.8V_{OUT}
 - Supports LDDR4x Memory requirements
 - 9x Low-Dropout Linear Regulator
 - Eight GPIOs
 - Real-Time Clock
 - Backup Battery Charger
 - Bidirectional Reset I/O
 - Interrupt Output
 - System Watchdog Timer
- Flexible and Configurable
 - I²C-Compatible Interface
 - Factory OTP Options Available
 - Flexible Power Sequencer
 - Configurable Power-Up/Power-Down/Sleep Mode Entry/Exit Timing
 - Highly Configurable GPIO ALT Modes
 - Three Resources Can Be Configured as 32kHz Oscillator Output
 - Four Resources Can Be Configured on FPS
 - One Resource Can Be Configured as ACOK Input
- Low Power
 - Low I_Q of 85μA in Sleep Mode
 - SD0/1 Low-Power Quiescent Current is 10μA
 - SD2/3 Low-Power Quiescent Current is 5μA
 - LDO Low-Power Quiescent Current is 1.5μA
- Small Size
 - 70-Bump, 0.4mm Pitch, 10x7 Ball Array WLP, 4.1mm x 3.25mm x 0.7mm Package Size
 - 230mm² Total Solution Size

Simplified Block Diagram

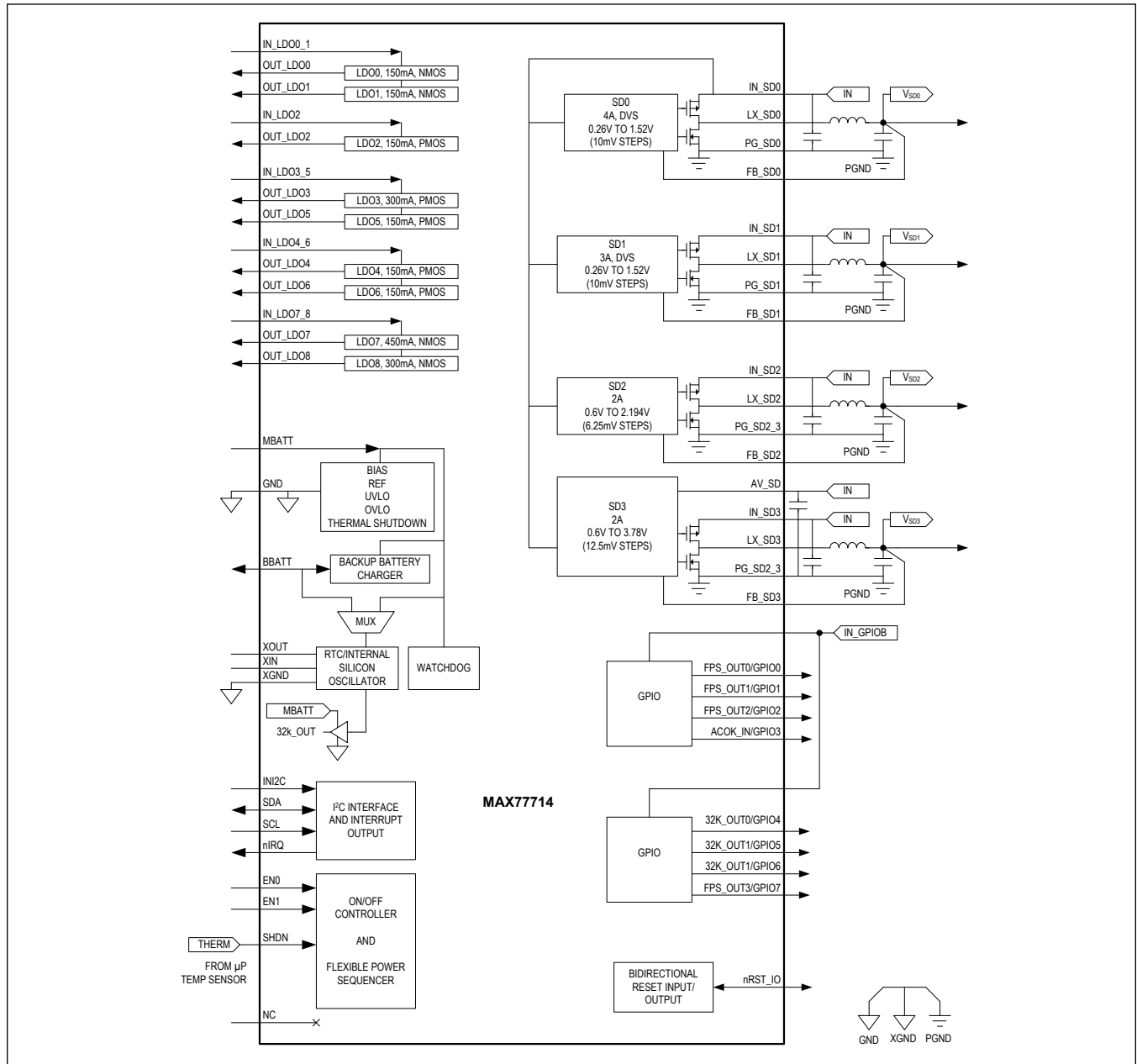


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Absolute Maximum Ratings

Top

| | |
|-----------------------|-----------------------------|
| EN0 to GND | -0.3V to $V_{MBATT} + 0.3V$ |
| EN1 to GND | -0.3V to $V_{MBATT} + 0.3V$ |
| SHDN to GND | -0.3V to $V_{MBATT} + 0.3V$ |
| nRST_IO to GND | -0.3V to $V_{MBATT} + 0.3V$ |
| nIRQ to GND | -0.3V to $V_{INI2C} + 0.3V$ |
| XOUT to XGND (Note 1) | -0.3V to $V_{VRTC} + 0.3V$ |
| XIN to XGND (Note 1) | -0.3V to $V_{VRTC} + 0.3V$ |
| BBATT to GND | -0.3V to +6.0V |
| MBATT to GND | -0.3V to +6.0V |
| nRST_IO Sink Current | 20mA |
| nIRQ Sink Current | 20mA |
| DGND to GND | -0.3V to +0.3V |
| XGND to GND | -0.3V to +0.3V |

LDO

| | |
|------------------|----------------------------------|
| IN_LDO0_1 to GND | -0.3V to +6.0V |
| OUT_LDO0 to GND | -0.3V to $V_{IN_LDO0-1} + 0.3V$ |
| IN_LDO2 to GND | -0.3V to +6.0V |
| OUT_LDO1 to GND | -0.3V to $V_{IN_LDO0-1} + 0.3V$ |
| IN_LDO3_5 to GND | -0.3V to +6.0V |
| OUT_LDO2 to GND | -0.3V to $V_{IN_LDO2} + 0.3V$ |
| IN_LDO4_6 to GND | -0.3V to +6.0V |
| OUT_LDO3 to GND | -0.3V to $V_{IN_LDO3-5} + 0.3V$ |
| IN_LDO7_8 to GND | -0.3V to +6.0V |
| OUT_LDO4 to GND | -0.3V to $V_{IN_LDO4-6} + 0.3V$ |
| OUT_LDO5 to GND | -0.3V to $V_{IN_LDO3-5} + 0.3V$ |
| OUT_LDO6 to GND | -0.3V to $V_{IN_LDO4-6} + 0.3V$ |
| OUT_LDO7 to GND | -0.3V to $V_{IN_LDO7-8} + 0.3V$ |
| OUT_LDO8 to GND | -0.3V to $V_{IN_LDO7-8} + 0.3V$ |

Step-Down

| | |
|-----------------------------------------------------------------------------------------------------|-------------------------------|
| IN_SD0 to PG_SD0 | -0.3V to $V_{MBATT} + 0.3V$ |
| IN_SD1 to PG_SD1 | -0.3V to $V_{MBATT} + 0.3V$ |
| IN_SD2 to PG_SD2 | -0.3V to $V_{MBATT} + 0.3V$ |
| LX_SD0 to PG_SD0 (Note 1) | -0.3V to $V_{IN_SD0} + 0.3V$ |
| LX_SD1 to PG_SD1 (Note 1) | -0.3V to $V_{IN_SD1} + 0.3V$ |
| LX_SD2 to PG_SD2 (Note 1) | -0.3V to $V_{IN_SD2} + 0.3V$ |
| LX_SDx RMS Current per Bump ($T_J = +110^\circ C$) (RMS Current per Pin ($T_J = +110^\circ C$)) | 1.6A |
| FB_SD0/1 to GND | -0.3V to $V_{MBATT} + 0.3V$ |
| PG_SDx to GND | -0.3V to +0.3V |
| IN_SD3 to PG_SD3 | -0.3V to +6.0V |
| LX_SD3 to PG_SD3 (Note 1) | -0.3V to $V_{IN_SD3} + 0.3V$ |
| FB_SD2 to GND | -0.3V to $V_{IN_SD2} + 0.3V$ |
| FB_SD3 to GND | -0.3V to $V_{IN_SD3} + 0.3V$ |

I²C

| | |
|------------------|-----------------------------|
| SDA, SCL to GND | -0.3V to $V_{INI2C} + 0.3V$ |
| SDA Sink Current | 25mA |

GPIO

| | |
|--------------------------------|---------------------------------|
| GPIO_INB to GND | -0.3V to +6.0V |
| GPIO4-7 to GND | -0.3V to $V_{GPIO_INB} + 0.3V$ |
| GPIO0-3 to GND | -0.3V to $V_{MBATT} + 0.3V$ |
| GPIOx Source Current | 12mA |
| GPIOx Sink Current | 20mA |
| Operating Temperature Range | -40°C to +85°C |
| Junction Temperature | +150°C |
| Storage Temperature Range | -40°C to +150°C |
| Soldering Temperature (reflow) | +260°C |

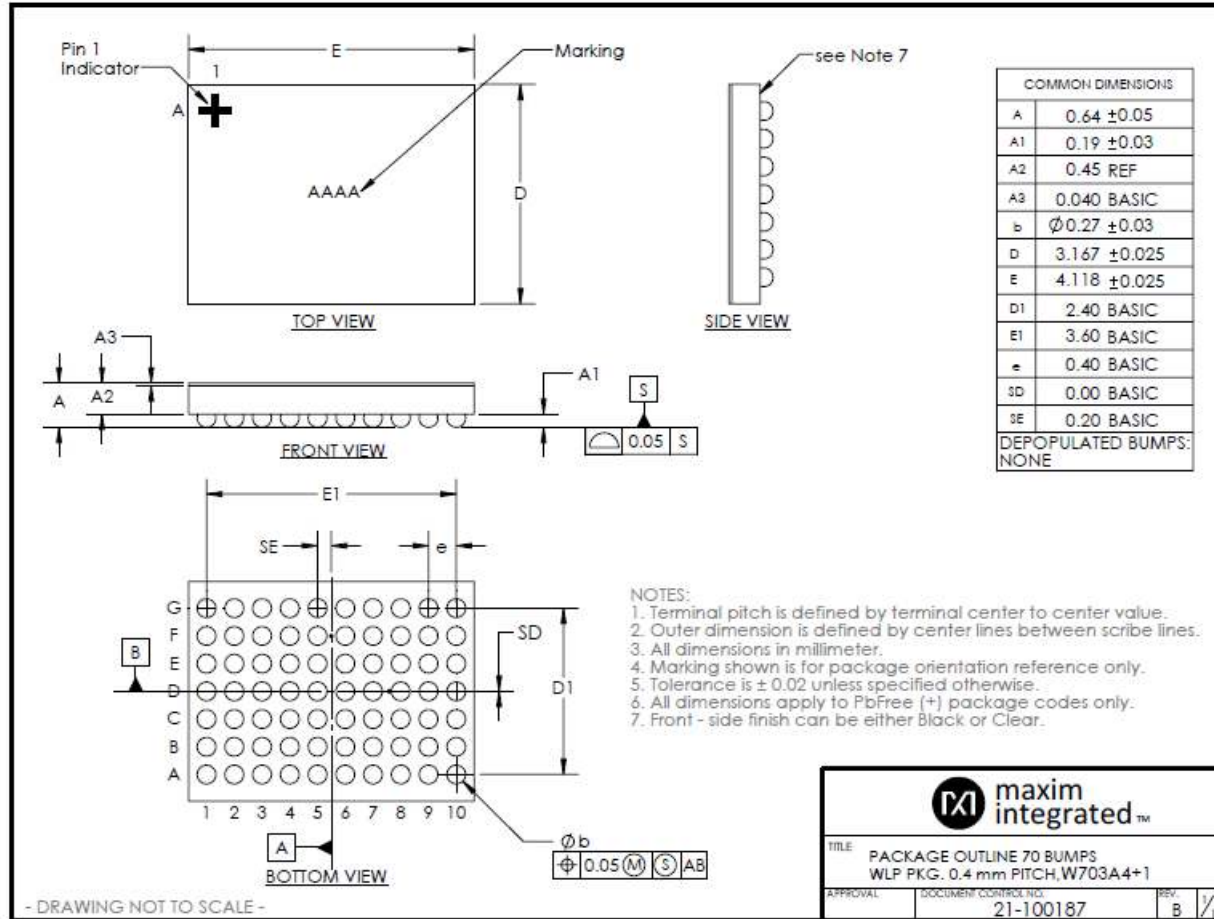
Note 1: The specified voltage limitation is for steady state conditions. Dead times of a few nano seconds exist as the dynamic step-down regulator transitions from inductor charging to inductor discharging and vice versa. These dead times allow internal clamping diodes to PGNDx and INBx to forward bias ($V_f \sim 1V$). When the LXx waveform is observed on a high-bandwidth oscilloscope ($\geq 100MHz$), the LXx transition edges are commonly seen with 1.5V spikes. These spikes are due to (1) the internal clamping diode forward voltage and (2) the high rate of current change through the current loop's inductance ($V = L \times di/dt$). Designs must follow the recommended printed circuit board (PCB) layout in order to minimize this current loop's inductance.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

WLP

| | |
|----------------------------------------------|------------------------------------------------|
| Package Code | W703A4+1 |
| Outline Number | 21-100187 |
| Land Pattern Number | Refer to Application Note 1891 |
| Thermal Resistance, Four-Layer Board: | |
| Junction to Ambient (θ_{JA}) | 37.43°C/W |
| Junction to Case (θ_{JC}) | NA |



For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics—Global Resources

(Limits are 100% tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range ($T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|-----------------------------------------|-----------------|---------------------------------------|------|------|------|-------|
| MAIN BATTERY POWER INPUT (MBATT) | | | | | | |
| MBATT Operating Voltage Range | V_{MBATT} | | 2.6 | | 5.5 | V |
| MBATT Undervoltage-Lockout Threshold | $V_{MBATTUVLO}$ | V_{MBATT} falling, 200mV hysteresis | | 2.5 | | V |
| MBATT Overvoltage Lockout Threshold | $V_{MBATTOVLO}$ | V_{MBATT} rising, 200mV hysteresis | 5.70 | 5.85 | 6.00 | V |

Electrical Characteristics—Global Resources (continued)

(Limits are 100% tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range ($T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|----------------------------------|----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------|-----|------|-----|---------------|
| Quiescent Supply Current | I_{Q_MBATT} | All regulators off, 32kHz oscillator in low-power mode (PWR_MD_32k = 0b1), $V_{MBATT} = 3.6\text{V}$, $I_{BBATT} = 0\mu\text{A}$ | | 0.8 | 12 | 25 | μA |
| | | All regulators off, 32kHz oscillator in low-power mode (PWR_MD_32k = 0b1), internal reference and bias circuitry active ($L_B_EN = 1$), $V_{MBATT} = 3.6\text{V}$, $I_{BBATT} = 0\mu\text{A}$ | | | 42 | | |
| No-Load LDO Supply Current | | Current into MBATT and all LDO power inputs, $V_{MBATT} = 3.6\text{V}$. All LDO power inputs are 3.6V, $I_{BBATT} = 0\mu\text{A}$, LDOs set to minimum output voltage, all step-down regulators disabled, 32kHz clock buffer disabled, 32kHz oscillator in low-power mode (PWR_MD_32k = 0b1), $V_{IN_GPIOB} = 0\text{V}$. This does not include any current into nRST_IO or nIRQ | Normal-power mode, all LDOs enabled | | 265 | | μA |
| | | | Low-power mode, LDO2-LDO6 enabled (PMOS) | | 58 | | |
| No-Load Step-Down Supply Current | | Current into MBATT and all step-down power inputs, $V_{MBATT} = 3.6\text{V}$, all regulator inputs are 3.6V, $I_{BBATT} = 0\mu\text{A}$, all step-downs enabled with their minimum output voltages, all LDOs disabled, 32kHz clock buffer disabled, 32kHz oscillator in low-power mode (PWR_MD_32k = 0b01), $V_{IN_GPIOB} = 0\text{V}$. This does not include any current into nRST_IO or nIRQ | Normal-power mode, all step-down regulators enabled | | 145 | | μA |
| | | | Low-power mode, all step-down regulators enabled | | 82.5 | | |

Electrical Characteristics—Global Resources (continued)

(Limits are 100% tested at T_A = +25°C. Limits over the operating temperature range (T_A = -40°C to +85°C) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|------------------------------------------|--------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------|-----|-----|-----|-------|
| No-Load LDO and Step-Down Supply Current | | Current into MBATT all step-down power inputs, and all LDO power inputs, V _{MBATT} = 3.6V, all regulator inputs are 3.6V, I _{BATT} = 0μA, all regulators set to minimum output voltage. 32kHz clock buffer disabled, 32kHz oscillator in low-power mode (PWR_MD_32k = 0b01), V _{IN_GPIOB} = 0V. This does not include any current into nRST_IO or nIRQ | Normal-power mode, all regulators enabled | | 375 | 520 | μA |
| | | Current into MBATT all step-down power inputs, and all LDO power inputs, V _{MBATT} = 3.6V, all regulator inputs are 3.6V, I _{BATT} = 0μA, all regulators set to minimum output voltage. 32kHz clock buffer disabled, 32kHz oscillator in low-power mode (PWR_MD_32k = 0b01), V _{IN_GPIOB} = 0V. This does not include any current into nRST_IO or nIRQ | Low-power mode, all regulators except LDO0/1/7/8 (NMOS) | | 110 | 165 | |

Electrical Characteristics—Global Resources (continued)

(Limits are 100% tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range ($T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|-------------------------------------------------------|--------------------------------|-----------------------------------------------------------------------------------------------------------------------------|------|-------|------|------------------|
| MBATT RESET COMPARATOR | | | | | | |
| Reset Falling Threshold Range | $V_{\text{MBATT_RESET}}$ | MBATT_RESET[2:0] = 0b000 | | 2.7 | | V |
| | | MBATT_RESET[2:0] = 0b001 | | 2.8 | | |
| | | MBATT_RESET[2:0] = 0b010 | | 2.9 | | |
| | | MBATT_RESET[2:0] = 0b011 | 2.95 | 3.0 | 3.05 | |
| | | MBATT_RESET[2:0] = 0b100 | | 3.1 | | |
| | | MBATT_RESET[2:0] = 0b101 | | 3.2 | | |
| | | MBATT_RESET[2:0] = 0b110 | | 3.3 | | |
| | | MBATT_RESET[2:0] = 0b111 | | 3.4 | | |
| Reset Threshold Hysteresis | $V_{\text{MBATT_RESET_HYS}}$ | MBATT_HYS[1:0] = b00 | | 0.1 | | V |
| | | MBATT_HYS[1:0] = 0b01 | | 0.2 | | |
| | | MBATT_HYS[1:0] = 0b10 | | 0.3 | | |
| | | MBATT_HYS[1:0] = 0b11 | | 0.4 | | |
| BIDIRECTIONAL RESET INPUT/OUTPUT (nRST_IO) | | | | | | |
| Reset Output Deassert Delay Time | $t_{\text{RST_O}}$ | OTP_TRSTO[1:0] = 0b00 | 0.8 | 1.0 | 1.2 | ms |
| | | OTP_TRSTO[1:0] = 0b01 | | 8 | | |
| | | OTP_TRSTO[1:0] = 0b10 | | 32 | | |
| | | OTP_TRSTO[1:0] = 0b11 | | 64 | | |
| Reset Input Debounce Timer | $t_{\text{DBNC_nRST_I}}$ | | 24 | 30 | 36 | ms |
| Input High Voltage | V_{IH} | RSO = 0 | 1.4 | | | V |
| Input Low Voltage | V_{IL} | RSO = 0 | | | 0.4 | V |
| Input Hysteresis | V_{HYS} | RSO = 0 | | 50 | | mV |
| Input Leakage Current | | $V_{\text{MBATT}} = 5.5\text{V}$, $V_{\text{nRST_IO}} = 0\text{V}$ and 5.5V , RSO = 0, $T_A = +25^\circ\text{C}$ | | 0.001 | 1 | μA |
| | | $V_{\text{MBATT}} = 5.5\text{V}$, $V_{\text{nRST_IO}} = 0\text{V}$ and 5.5V , RSO = 0, $T_A = +85^\circ\text{C}$ | | 0.01 | | |
| Output Voltage Low | V_{OL} | $I_{\text{SINK}} = 4\text{mA}$, RSO = 1 | | | 0.4 | V |
| Output High Leakage Current | | $V_{\text{MBATT}} = 5.5\text{V}$, $V_{\text{nRST_IO}} = 0\text{V}$ and 5.5V , RSO = 0, $T_A = +25^\circ\text{C}$ | | 0.001 | 1 | μA |
| | | $V_{\text{MBATT}} = 5.5\text{V}$, $V_{\text{nRST_IO}} = 0\text{V}$ and 5.5V , RSO = 0, $T_A = +85^\circ\text{C}$ | | 0.01 | | |
| DEDICATED ACTIVE-LOW OPEN-DRAIN OUTPUTS (nIRQ) | | | | | | |
| Output Voltage Low | V_{OL} | $I_{\text{SINK}} = 4\text{mA}$, RSO = 1 | | | 0.4 | V |
| Output High Leakage Current | I_{OZH} | $V_{\text{MBATT}} = 5.5\text{V}$, $V_{\text{nIRQ}} = 0\text{V}$ and 5.5V , RSO = 0, $T_A = +25^\circ\text{C}$ | | 0.001 | 1 | μA |
| | | $V_{\text{MBATT}} = 5.5\text{V}$, $V_{\text{nIRQ}} = 0\text{V}$ and 5.5V , RSO = 0, $T_A = +85^\circ\text{C}$ | | 0.01 | | |
| THERMAL ALARM AND SHUTDOWN | | | | | | |
| Thermal Alarm 1 | T_{J110} | T_{J} rising, $+5^\circ\text{C}$ hysteresis | | 110 | | $^\circ\text{C}$ |

Electrical Characteristics—Global Resources (continued)

(Limits are 100% tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range ($T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$) and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|-----------------------------------|-------------|-----------------------------------------------------------------|----------------------------|-----|-----|-----|------------------|
| Thermal Alarm 2 | T_{J130} | T_J rising, $+5^\circ\text{C}$ hysteresis | | | 130 | | $^\circ\text{C}$ |
| Thermal Shutdown Temperature | T_{JSHDN} | T_J rising, $+10^\circ\text{C}$ hysteresis | | | 145 | | $^\circ\text{C}$ |
| BACKUP-BATTERY POWER INPUT | | | | | | | |
| BBATT Current | I_{BBATT} | $V_{MBATT} = 0\text{V}$, $\text{PWR_MD_32k} = 0\text{b}0$ | $V_{BBATT} = 3.00\text{V}$ | | 4.2 | 8 | μA |

Electrical Characteristics—ON/OFF Controller

($V_{\text{SYS}} = 3.6\text{V}$, $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, limits are 100% tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|-----------------------------------|--------------|----------------------------------|-----|------|-----|-------|
| ON/OFF CONTROLLER | | | | | | |
| Input Voltage High | V_{IH} | | 1.4 | | | V |
| Input Voltage Low | V_{IL} | | | | 0.4 | V |
| Input Hysteresis | V_{HYS} | | | 0.05 | | V |
| Manual Reset Time | t_{HRDRST} | $\text{MRT}[2:0] = 0\text{b}000$ | | 2 | | s |
| | | $\text{MRT}[2:0] = 0\text{b}001$ | | 3 | | |
| | | $\text{MRT}[2:0] = 0\text{b}010$ | | 4 | | |
| | | $\text{MRT}[2:0] = 0\text{b}011$ | | 5 | | |
| | | $\text{MRT}[2:0] = 0\text{b}100$ | | 6 | | |
| | | $\text{MRT}[2:0] = 0\text{b}101$ | | 8 | | |
| | | $\text{MRT}[2:0] = 0\text{b}110$ | | 10 | | |
| | | $\text{MRT}[2:0] = 0\text{b}111$ | | 12 | | |
| Manual Reset Warning Time (MRWRN) | t_{MRWRN} | $\text{MRT}[2:0] = 0\text{b}000$ | | 2 | | s |
| | | $\text{MRT}[2:0] = 0\text{b}001$ | | 2 | | |
| | | $\text{MRT}[2:0] = 0\text{b}010$ | | 3 | | |
| | | $\text{MRT}[2:0] = 0\text{b}011$ | | 4 | | |
| | | $\text{MRT}[2:0] = 0\text{b}100$ | | 5 | | |
| | | $\text{MRT}[2:0] = 0\text{b}101$ | | 6 | | |
| | | $\text{MRT}[2:0] = 0\text{b}110$ | | 8 | | |
| | | $\text{MRT}[2:0] = 0\text{b}111$ | | 10 | | |

Electrical Characteristics—Flexible Power Supply (FPS)

($V_{SYS} = 3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$, limits are 100% tested at $T_A = +25^\circ C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|------------------------------------------------------|---------------|----------------------------------------------------------------------|-----|------|-----|---------|
| FLEXIBLE POWER SEQUENCE | | | | | | |
| Flexible Power Sequencer Enable Delay | t_{FSDON} | MAX77714 reference is already powered up prior to the enable command | | 91.5 | | μs |
| Flexible Power Sequencer Disable Delay | $t_{FPSDOFF}$ | | | 152 | | μs |
| Flexible Power Sequencer Event Period | t_{FST} | MSTR_PU[2:0], MSTR_PD[2:0] = 0b000 | | 31 | | μs |
| | | MSTR_PU[2:0], MSTR_PD[2:0] = 0b001 | | 63 | | |
| | | MSTR_PU[2:0], MSTR_PD[2:0] = 0b010 | | 127 | | |
| | | MSTR_PU[2:0], MSTR_PD[2:0] = 0b011 | | 256 | | |
| | | MSTR_PU[2:0], MSTR_PD[2:0] = 0b100 | | 508 | | |
| | | MSTR_PU[2:0], MSTR_PD[2:0] = 0b101 | | 984 | | |
| | | MSTR_PU[2:0], MSTR_PD[2:0] = 0b110 | | 1936 | | |
| | | MSTR_PU[2:0], MSTR_PD[2:0] = 0b111 | | 3904 | | |
| Flexible Power Sequencer Event Period Timer Accuracy | | Accuracy of the flexible power sequencer clock | -15 | | +15 | % |

Electrical Characteristics—Step-Down Regulators (SD0–4A Output)

($V_{SYS} = 3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$, limits are 100% tested at $T_A = +25^\circ C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---------------------------------------------|----------------------------|------------------------------------------------------------------------------------|------|-----|------|-------------|
| SUPPLY VOLTAGE AND CURRENT | | | | | | |
| Input Voltage Range | V_{INSD0} | | 2.6 | | 5.5 | V |
| OUTPUT VOLTAGE | | | | | | |
| Output Voltage Range | V_{OUT_SD0} | I ² C programmable in 10mV steps (SD0VOUT[6:0] = 0x01 to 0x7F) | 0.26 | | 1.52 | V |
| Output Voltage Accuracy | $V_{OUT_ACC_N_M_SD0}$ | FPWM mode, normal-power mode, no load, $T_A = +25^\circ C$, $V_{OUT_SD0} = 1.0V$ | -2 | | +2 | % |
| | $V_{OUT_ACC_LP_M_SD0}$ | Low-power mode, no load, $T_A = +25^\circ C$, $V_{OUT_SD0} = 1.000V$ | -4 | | +4 | |
| PERFORMANCE | | | | | | |
| Switching Frequency | f_{SW} | $V_{SYS} = 3.6V$ | 1.8 | 2 | 2.2 | MHz |
| Line Regulation | | $V_{INSD0} = 2.6V$ to $5.5V$, $V_{OUT_SD0} = 1.0V$ | | 0.2 | | %/V |
| Soft-Start Slew Rate | | SD0_SSRAMP = 0 | | 2.5 | | mV/ μs |
| | | SD0_SSRAMP = 1 | | 10 | | |
| Output Voltage Ramp-Up/Down Slew Rate (DVS) | | | | 10 | | mV/ μs |

Electrical Characteristics—Step-Down Regulators (SD0–4A Output) (continued)

($V_{SYS} = 3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---------------------------------------------------|-------------------------|------------------------------------------------------------------|------|------|------|------------|
| PMOS ON Resistance | R_{ON_PCH} | $V_{SYS} = V_{IN_SD0} = 5V$, $I_{OUT} = 150mA$ | | 38 | 60 | m Ω |
| | | $V_{SYS} = V_{IN_SD0} = 3.6V$, $I_{OUT} = 150mA$ | | 48 | 60 | |
| NMOS ON Resistance | R_{ON_NCH} | $V_{SYS} = V_{IN_SD0} = 5V$, $I_{OUT} = 150mA$ | | 18 | 40 | m Ω |
| | | $V_{SYS} = V_{IN_SD0} = 3.6V$, $I_{OUT} = 150mA$ | | 24 | 40 | |
| NMOS Zero-Crossing Threshold | I_{ZX_SKIP} | SKIP mode | | 20 | | mA |
| | I_{ZX_PWM} | Low-power mode | | 20 | | |
| LX Leakage | $I_{L_LX_25C}$ | $V_{LXSD0} = 5.5V$ or $0V$, $T_A = +25^{\circ}C$ | | 0.1 | 1 | μA |
| | $I_{L_LX_85C}$ | $V_{LXSD0} = 5.5V$ or $0V$, $T_A = +85^{\circ}C$ (Note 2) | | 1 | | |
| Output Active Discharge Resistance | R_{DISCHG_SD0} | Resistance from FBB0 to PGND0, output disabled | | 100 | | Ω |
| Turn-On Delay Time | $t_{ON_DLY_SD0}$ | EN signal to LX switching with bias on | | 200 | | μs |
| OUTPUT CURRENT | | | | | | |
| Maximum Output Current | $I_{OUT_MAX_NM_SD0}$ | RMS, normal mode | 4000 | | | mA |
| PMOS Peak Current Limit | I_{LIMP} | $T_A = +25^{\circ}C$ | 4825 | 5250 | 5675 | mA |
| | | $T_A = -40^{\circ}C$ to $+85^{\circ}C$ | 4825 | 5250 | 5675 | |
| NMOS Valley Current Limit | I_{LIMV} | | | 3000 | | mA |
| NMOS (Negative) Current Limit | I_{LIMN} | | | 2000 | | mA |
| BROWNOUT COMPARATOR | | | | | | |
| Output-Brownout Threshold | V_{BO_SD0} | Normal-power mode, falling threshold, $SD0_BO_THR[1:0] = 0b00$ | | 77 | | % |
| | | Normal-power mode, falling threshold, $SD0_BO_THR[1:0] = 0b01$ | | 81 | | |
| | | Normal-power mode, falling threshold, $SD0_BO_THR[1:0] = 0b10$ | | 85.7 | | |
| | | Normal-power mode, falling threshold, $SD0_BO_THR[1:0] = 0b11$ | | 91 | | |
| Output-Brownout Accuracy | | Normal-power mode. $V_{OUT_SD0} = 1.0V$ ($SD0_VOUT[6:0]$) | -4.5 | | +4.5 | % |
| Output-Brownout Threshold (Low-Power Mode) | V_{BO_SD0} | Falling threshold, low-power mode | | 86.0 | | % |
| Output-Brownout Accuracy | | Low-power mode. $V_{OUT_SD0} = 1.0V$ ($SD0_VOUT[6:0]$) | -4 | | +4 | % |
| Output-Brownout Hysteresis Range | $V_{BO_HYS_SD0}$ | 2-Bit control over I^2C . Max rising threshold limited to 96% | 5 | | 20 | % |
| Brownout-Voltage Hysteresis Programming Step Size | | Programmable with $SD0_BO_HYS[1:0]$ | | 5 | | % |

Electrical Characteristics—Step-Down Regulators (SD0–4A Output) (continued)

($V_{SYS} = 3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---------------------------------------------|-------------------------|---------------------------------|-----|-------|-----|-------|
| Output-Brownout Hysteresis (Low-Power Mode) | $V_{BO_HYS_SD0_LPM}$ | | | 5 | | % |
| OV COMPARATOR | | | | | | |
| Output OV Trip Level | $V_{OUT_SD0_OV}$ | Rising edge, $SD0_OV_THR = 1$ | | 117.1 | | % |
| Output OV Hysteresis | | $SD0_OV_THR = 1$ | | 8.6 | | % |
| Output OV Trip Level | $V_{OUT_SD0_OV}$ | Rising edge, $SD0_OV_THR = 0$ | | 108.5 | | % |
| Output OV Hysteresis | | $SD0_OV_THR = 0$ | | 3.9 | | % |
| Output OV Trip Level (Low-Power Mode) | $V_{OUT_SD0_OV}$ | Rising edge, low-power mode | | 108.3 | | % |
| Output OV Hysteresis (Low-Power Mode) | | Low-power mode | | 3.9 | | % |

Electrical Characteristics—Step-Down Regulators (SD1–3A Output)

($V_{SYS} = 3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|------------------------------------|----------------------------|---------------------------------------------------------------------------------|------|-----|------|-------|
| SUPPLY VOLTAGE AND CURRENT | | | | | | |
| Input Voltage Range | V_{IN_SD1} | | 2.6 | | 5.5 | V |
| OUTPUT VOLTAGE | | | | | | |
| Output Voltage Range | V_{OUT_SD1} | I ² C programmable in 10mV steps ($SD1VOUT[6:0] = 0x01$ to $0x7F$) | 0.26 | | 1.52 | V |
| Output Voltage Accuracy | $V_{OUT_ACC_N_M_SD1}$ | FPWM mode, normal mode, no load, $T_A = +25^{\circ}C$, $V_{OUT_SD1} = 1.0V$ | -2 | | +2 | % |
| | $V_{OUT_ACC_LP_M_SD1}$ | Low-power mode, no load, $T_A = +25^{\circ}C$, $V_{OUT_SD1} = 1.000V$ | -4 | | +4 | |
| PERFORMANCE | | | | | | |
| Switching Frequency | f_{SW} | $V_{MBATT} = 3.6V$ | 1.8 | 2 | 2.2 | MHz |
| Line Regulation | | $V_{INSD1} = 2.6V$ to $5.5V$, $V_{OUT_SD1} = 1.0V$ | | 0.2 | | %/V |
| PMOS ON Resistance | R_{ON_PCH} | $V_{MBATT} = V_{INSD1} = 5V$, $I_{OUT} = 150mA$ | | 45 | 90 | mΩ |
| | | $V_{MBATT} = V_{INSD1} = 3.6V$, $I_{OUT} = 150mA$ | | 58 | 90 | |
| NMOS ON Resistance | R_{ON_NCH} | $V_{MBATT} = V_{INSD1} = 5V$, $I_{OUT} = 150mA$ | | 28 | 60 | mΩ |
| | | $V_{MBATT} = V_{INSD1} = 3.6V$, $I_{OUT} = 150mA$ | | 35 | 60 | |
| NMOS Zero-Crossing Threshold | I_{ZX_SKIP} | Skip mode | | 20 | | mA |
| | I_{ZX_PWM} | Low-power mode | | 20 | | |
| LX Leakage | $I_{L_LX_25C}$ | $V_{LXSD1} = 5.5V$ or $0V$, $T_A = +25^{\circ}C$ | | 0.1 | 1 | μA |
| | $I_{L_LX_85C}$ | $V_{LXSD1} = 5.5V$ or $0V$, $T_A = +85^{\circ}C$ (Note 3) | | 1 | | |
| Output Active Discharge Resistance | R_{DISCHG_SD1} | Resistance from FB_SD1 to PG_SD1 , output disabled | | 100 | | Ω |

Electrical Characteristics—Step-Down Regulators (SD1–3A Output) (continued)

($V_{SYS} = 3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$, limits are 100% tested at $T_A = +25^\circ C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---------------------------------------------------|-------------------------|--------------------------------------------------------------------------|------|-------|------|---------|
| Turn-On Delay Time | $t_{ON_DLY_SD1}$ | EN signal to LX switching with bias on | | 200 | | μs |
| BROWNOUT COMPARATOR | | | | | | |
| Output-Brownout Threshold | V_{BO_SD1} | Normal-power mode, falling threshold, SD1_BO_THR[1:0] = 0b00 | | 77 | | % |
| | | Normal-power mode, falling threshold, SD1_BO_THR[1:0] = 0b01 | | 81 | | |
| | | Normal-power mode, falling threshold, SD1_BO_THR[1:0] = 0b10 | | 85.7 | | |
| | | Normal-power mode, falling threshold, SD1_BO_THR[1:0] = 0b11 | | 91 | | |
| Output-Brownout Accuracy | | Normal-power mode. $V_{OUT_SD1} = 1.0V$ (SD1_VOUT[6:0]) | -4.5 | | +4.5 | % |
| Output-Brownout Threshold (Low-Power Mode) | V_{BO_SD1} | Falling threshold, low-power mode | | 86.0 | | % |
| Output-Brownout Accuracy | | Low-power mode, $V_{OUT_SD1} = 1.0V$ (SD1_VOUT[6:0]) | -4 | | +4 | % |
| Output-Brownout Hysteresis Range | $V_{BO_HYS_SD1}$ | 2-Bit control over I ² C. Max rising threshold limited to 96% | 5 | | 20 | % |
| Brownout-Voltage Hysteresis Programming Step Size | | Programmable with SD1_BO_HYS[1:0] | | 5 | | % |
| Output-Brownout Hysteresis (Low-Power Mode) | $V_{BO_HYS_SDx_LPM}$ | | | 5 | | % |
| OUTPUT CURRENT | | | | | | |
| Maximum Output Current | $I_{OUT_MAX_NM_SD1}$ | RMS, normal mode | | 3000 | | mA |
| PMOS Peak Current Limit | I_{LIMP} | $T_A = +25^\circ C$ | 3825 | 4250 | 5100 | mA |
| | | $T_A = -40^\circ C$ to $+85^\circ C$ | 3825 | 4250 | 5200 | |
| NMOS Valley Current Limit | I_{LIMV} | | | 3000 | | mA |
| NMOS (Negative) Current Limit | I_{LIMN} | | | 2000 | | mA |
| OV COMPARATOR | | | | | | |
| Output OV Trip Level | V_{OUTSD1_OV} | Rising edge, SD1_OV_THR = 1 | | 117.1 | | % |
| Output OV Hysteresis | | SD1_OV_THR = 1 | | 8.6 | | % |
| Output OV Trip Level | V_{OUTSD1_OV} | Rising edge, SD1_OV_THR = 0 | | 108.5 | | % |
| Output OV Hysteresis | | SD1_OV_THR = 0 | | 3.9 | | % |
| Output OV Trip Level (Low-Power Mode) | V_{OUTSD1_OV} | Rising edge, low-power mode | | 108.3 | | % |
| Output OV hysteresis (Low-Power Mode) | | Low-power mode | | 3.9 | | % |

Electrical Characteristics—Step-Down Regulators (SD2/3–2A Output)

($V_{SYS} = 3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$, limits are 100% tested at $T_A = +25^\circ C$. Limits over the operating temperature range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|------------------------------------|----------------------------|----------------------------------------------------------------------------------------------|-------|------|-------|-------------|
| SUPPLY VOLTAGE AND CURRENT | | | | | | |
| Input Voltage Range | V_{IN_SDx} | | 2.6 | | 5.5 | V |
| OUTPUT VOLTAGE | | | | | | |
| Output Voltage Range | V_{OUT_SD2} | Programmable in 6.25mV steps with $SD2VOUT[7:0]$ | 0.600 | | 2.194 | V |
| | V_{OUT_SD3} | Programmable in 12.5mV steps with $SD3VOUT[7:0]$ | 0.600 | | 3.78 | |
| Output Voltage Accuracy | $V_{OUT_ACC_N_M_SD2}$ | FPWM mode, normal-power mode, no load, $V_{OUT_SD2} = 1.1V$ | -2 | | +2 | % |
| | $V_{OUT_ACC_LP_M_SD2}$ | Low-power mode, no load, $V_{OUT_SD2} = 1.1V$ | -4 | | +4 | |
| | $V_{OUT_ACC_N_M_SD3}$ | FPWM mode, normal mode, no load, $V_{OUT_SD3} = 1.1V$ | -2 | | +2 | |
| | $V_{OUT_ACC_LP_M_SD3}$ | Low-power mode, no Load, $V_{OUT_SD3} = 1.1V$ | -4 | | +4 | |
| OUTPUT CURRENT | | | | | | |
| Maximum Output Current | $I_{OUT_MAX_NM_SD2_3}$ | RMS, normal mode, $L = 1\mu H$ | 2000 | | | mA |
| PMOS Peak Current Limit | I_{LIMP} | $V_{MBATT} = 3.6V$ | 2300 | 2875 | 4200 | mA |
| | | $V_{MBATT} = 5V$ | 2300 | 2875 | 4200 | |
| NMOS Valley Current Limit | I_{LIMV} | $V_{SYS} = 3.6V$ | | 2125 | | mA |
| | | $V_{SYS} = 5V$ | | 2125 | | |
| NMOS Negative Current Limit | I_{LIMN} | $V_{SYS} = 3.6V$ | | 800 | | mA |
| | | $V_{SYS} = 5V$ | | 800 | | |
| PERFORMANCE | | | | | | |
| Line Regulation | | $V_{MBATT} = V_{IN_SD2_3} = 2.6V$ to $5.5V$ | | 0.2 | | %/V |
| Switching Frequency | f_{SW} | $V_{MBATT} = 3.3V$ | 1.8 | 2 | 2.2 | MHz |
| | | $V_{MBATT} = 5V$ | 1.8 | 2 | 2.2 | |
| Soft-Start Slew Rate | | Fixed for SD2 | | 6.5 | | mV/ μs |
| | | Fixed for SD3 | | 17 | | |
| Output Voltage Ramp-Up Slew Rate | | Fixed for SD2, 3 (Notes 4, 7, 8), $C_{OUT} = 22\mu F$ | | 40 | | mV/ μs |
| Output Voltage Ramp-Down Slew Rate | | Fixed for SD2, 3 (Notes 4, 7), $C_{OUT} = 22\mu F$, $SDxFPWMEN = 1$ ($x = 1, 2$), no load | | 18 | | mV/ μs |
| PMOS ON Resistance | R_{ON_PCH} | $V_{SYS} = V_{IN_SDx} = 3.6V$, $I_{OUT} = 150mA$ | | 100 | 150 | m Ω |
| | | $V_{SYS} = V_{IN_SDx} = 5V$, $I_{OUT} = 150mA$, | | 100 | 150 | |
| NMOS ON Resistance | R_{ON_NCH} | $V_{SYS} = V_{IN_SDx} = 3.6V$, $I_{OUT} = 150mA$ | | 60 | 100 | m Ω |
| | | $V_{SYS} = V_{IN_SDx} = 5V$, $I_{OUT} = 150mA$ | | 60 | 100 | |
| NMOS Zero-Crossing Threshold | I_{ZX} | SKIP mode | | 20 | | mA |

Electrical Characteristics—Step-Down Regulators (SD2/3–2A Output) (continued)

($V_{SYS} = 3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---------------------------------------------------|-------------------------|--------------------------------------------------------------------------|-----|-------|-----|----------|
| LX Leakage | $I_{L_LX_25C}$ | $V_{LX2_3} = 5.5V$ or $0V$, $T_A = +25^{\circ}C$ | | 0.1 | 1 | μA |
| | $I_{L_LX_85C}$ | $V_{LX2_3} = 5.5V$ or $0V$, $T_A = +85^{\circ}C$ (Note 4) | | 1 | | |
| Output Active Discharge Resistance | R_{DISCHG_SDx} | Resistance from FBBx to PGNDx, output disabled, (Note 6) | | 100 | | Ω |
| Turn-On Delay Time | $t_{ON_DLY_SDx}$ | EN Signal to LX Switching with Bias ON | | 30 | | μs |
| BROWNOUT COMPARATOR | | | | | | |
| Output-Brownout Threshold | V_{BO_SDx} | Normal-power mode, falling threshold, $SDx_BO_THR[1:0] = 0b00$ | | 75 | | % |
| | | Normal-power mode, falling threshold, $SDx_BO_THR[1:0] = 0b01$ | | 80 | | |
| | | Normal-power mode, falling threshold, $SDx_BO_THR[1:0] = 0b10$ | | 85 | | |
| | | Normal-power mode, falling threshold, $SDx_BO_THR[1:0] = 0b11$ | | 90 | | |
| Output-Brownout Accuracy | | Normal-power mode. $V_{OUT_SDx} = 1.0V$ ($SDxVOUT[7:0]$) | -4 | | +4 | % |
| Output-Brownout Threshold (Low-Power Mode) | V_{BO_SDx} | Falling threshold, low-power mode | | 86.0 | | % |
| Output-Brownout Accuracy | | Low-power mode. $V_{OUT_SDx} = 1.0V$ ($SDxVOUT[7:0]$) | -4 | | +4 | % |
| Output-Brownout Hysteresis Range | $V_{BO_HYS_SDx}$ | 2-Bit control over I ² C. Max rising threshold limited to 96% | 5 | | 20 | % |
| Brownout-Voltage Hysteresis Programming Step Size | | Programmable with $SDx_BO_HYS[1:0]$ | | 5 | | % |
| Output-Brownout Hysteresis (Low-Power Mode) | $V_{BO_HYS_SDx_LPM}$ | | | 5 | | % |
| OV COMPARATOR | | | | | | |
| Output OV Trip Level | V_{OUTSDx_OV} | Rising edge, $SDx_OV_THR = 1$, referenced to output voltage setting | | 116.6 | | % |
| Output OV Hysteresis | | $SDx_OV_THR = 1$ | | 9.1 | | % |
| Output OV Trip Level | V_{OUTSDx_OV} | Rising edge, $SDx_OV_THR = 0$ referenced to output voltage setting | | 108.3 | | % |
| Output OV Hysteresis | | $SDx_OV_THR = 0$ | | 2.8 | | % |
| Output OV Trip Level (Low-Power Mode) | V_{OUTSDx_OV} | Rising edge, low-power mode | | 108.3 | | % |
| Output OV Hysteresis (Low-Power Mode) | | Low-power mode | | 2.8 | | % |

Electrical Characteristics—150mA PMOS LDO (LDO2, LDO4, LDO5, LDO6)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS | |
|----------------------------------------|----------------|----------------------------------------------------|------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------|------|-------|-------|-----|
| GENERAL CHARACTERISTICS | | | | | | | | |
| Input Voltage Range | V_{IN_LDOx} | Guaranteed by output accuracy | | 1.7 | | 5.5 | V | |
| Undervoltage Lockout | V_{UVLOxx} | Rising, 100mV hysteresis | | | 1.6 | 1.7 | V | |
| Output Voltage Range | V_{OUTxx} | V_{INxx} is the maximum of 3.7 or $V_{OUT}+0.3V$ | 50mV/step (6-bit), LDO2, LDO5, LDO6 | 0.8 | | 3.95 | V | |
| | | | 50mV step from 0.4V to 0.5V and 12.5mV step (7-bit), LDO4 from 0.5 to 1.275V | 0.4 | | 1.275 | | |
| Maximum Output Current | I_{MAXxx} | Guaranteed by output accuracy | Normal mode | 150 | | | mA | |
| | | | Low-power mode | | 5 | | | |
| CORE PERFORMANCE SPECIFICATIONS | | | | | | | | |
| Output Voltage Accuracy | | | Normal mode | $V_{IN} = V_{NOM}+0.3V$ to 5.5V with 1.7V minimum, $I_{OUT} = 0.1mA$ to I_{MAX} , V_{NOM} set to any voltage | -3 | | +3 | % |
| | | | LDO4 Normal mode | $V_{IN} = V_{NOM}+0.3V$ to 5.5V with 1.7V minimum, $I_{OUT} = 0.1mA$ to I_{MAX} , V_{NOM} set to any voltage | -4.5 | | +4.5 | |
| | | | Low-power mode | $V_{IN} = V_{NOM}+0.3V$ to 5.5V with 1.7V minimum, $I_{OUT} = 0.1mA$ to 5mA, V_{NOM} set to any voltage | -5 | | +5 | |
| Load Regulation (Note 15) | | | Normal mode | $I_{OUT} = 0.1mA$ to I_{MAX} , $V_{IN} = V_{NOM}+0.3V$ with 1.7V minimum, V_{NOM} set to any voltage | | 0.05 | | % |
| | | | Low-power mode | $I_{OUT} = 0.1mA$ to 5mA, $V_{IN} = V_{NOM}+0.3V$ with 1.7V minimum, V_{NOM} set to any voltage | | 0.05 | | |
| Line Regulation (Note 15) | | | Normal mode | $V_{IN} = V_{NOM}+0.3V$ to 5.5V with 1.7V minimum, $I_{OUT} = 0.1mA$, V_{NOM} set to any voltage | | 0.01 | | %/V |

Electrical Characteristics—150mA PMOS LDO (LDO2, LDO4, LDO5, LDO6) (continued)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|-------------------------------------------------|--------------|-------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|-----|------|-----|-------------|
| Line Regulation (Note15) | | Low-power mode | $V_{IN} = V_{NOM} + 0.3$ to 5.5V with 1.7V minimum. $I_{OUT} = 0.1mA$, V_{NOM} set to any voltage | | 0.01 | | %/V |
| Dropout Voltage | V_{DOxx} | Normal mode, $I_{OUT} = I_{MAX}$, LDO4 not tested | $V_{IN} = 3.7V$ | | 50 | 100 | mV |
| | | | $V_{IN} = 1.7V$ | | 150 | 300 | |
| | | Low-power mode, $I_{OUT} = 5mA$, $V_{IN} = 3.7V$ | | | 150 | 300 | |
| Output Current Limit | I_{LIMxx} | $V_{OUT} = 0V$, % of I_{MAX} | | 110 | 180 | 250 | % |
| DYNAMIC CHARACTERISTICS | | | | | | | |
| Soft-Start and Dynamic Voltage Change Ramp Rate | t_{SSxx} | After enabling, $SS_Lx = 1$ (Note 10) | | | 5 | | mV/ μs |
| | | After enabling, $SS_Lx = 0$ (Note 10) | | | 100 | | |
| Active Discharge Resistance | | Output disabled, $V_{OUT} = 1V$, resistance from OUT_LDOx to GND, active discharge enabled ($Lxx_ADE = 1$) | | | 65 | | Ω |
| THERMAL SHUTDOWN | | | | | | | |
| Thermal Shutdown | | Output disabled or enabled | T_J rising | | 165 | | $^\circ C$ |
| | | | T_J falling | | 150 | | |
| POWER-OK COMPARATOR | | | | | | | |
| Power-OK Threshold | V_{POKTHL} | V_{OUT} when V_{POK} switches | V_{OUT} falling | 84 | 87 | | % |
| | | | V_{OUT} rising | | 92 | 96 | |

Electrical Characteristics—300mA PMOS LDO (LDO3)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|--------------------------------|----------------|------------------------------------------------------|-------------------------|-----|-----|------|-------|
| GENERAL CHARACTERISTICS | | | | | | | |
| Input Voltage Range | V_{IN_LDOx} | Guaranteed by output accuracy | | 1.7 | | 5.5 | V |
| Undervoltage Lockout | V_{UVLOxx} | Rising, 100mV hysteresis | | | 1.6 | 1.7 | V |
| Output Voltage Range | V_{OUTxx} | V_{INxx} is the maximum of 3.7 or $V_{OUT} + 0.3V$ | 50mV/step (6-bit), LDO3 | 0.8 | | 3.95 | V |
| Maximum Output Current | I_{MAXxx} | Guaranteed by output accuracy | | 300 | | | mA |
| | | | | | 5 | | |

Electrical Characteristics—300mA PMOS LDO (LDO3) (continued)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | |
|-------------------------------------------------|-------------|---------------------------------------------------|--------------------------------------------------------------------------------------------------------------------|-----|------|-------|-------------|
| CORE PERFORMANCE SPECIFICATIONS | | | | | | | |
| Output Voltage Accuracy | | Normal mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V with 1.7V minimum, $I_{OUT} = 0.1mA$ to I_{MAX} , V_{NOM} set to any voltage | -3 | | +3 | % |
| | | Low-power mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V with 1.7V minimum, $I_{OUT} = 0.1mA$ to 5mA, V_{NOM} set to any voltage | -5 | | +5 | |
| Load Regulation (Note 15) | | Normal mode | $I_{OUT} = 0.1mA$ to I_{MAX} , $V_{IN} = V_{NOM} + 0.3V$ with 1.7V minimum, V_{NOM} set to any voltage | | 0.05 | | % |
| | | Low-power mode | $I_{OUT} = 0.1mA$ to 5mA, $V_{IN} = V_{NOM} + 0.3V$ with 1.7V minimum, V_{NOM} set to any voltage | | 0.05 | | |
| Line Regulation (Note 15) | | Normal mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V with 1.7V minimum, $I_{OUT} = 0.1mA$, V_{NOM} set to any voltage | | 0.01 | | %/V |
| Line Regulation (Note 15) | | Low-power mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V with 1.7V minimum, $I_{OUT} = 0.1mA$, V_{NOM} set to any voltage | | 0.01 | | %/V |
| Dropout Voltage | V_{DOxx} | Normal mode, $I_{OUT} = I_{MAX}$ | $V_{IN} = 3.7V$ | | 50 | 100 | mV |
| | | Low-power mode, $I_{OUT} = 5mA$, $V_{IN} = 3.7V$ | $V_{IN} = 1.7V$ | | 150 | 450 | |
| Output Current Limit | I_{LIMxx} | $V_{OUT} = 0V$, % of I_{MAX} | 110 | 180 | 250 | % | |
| DYNAMIC CHARACTERISTICS | | | | | | | |
| Soft-Start and Dynamic-Voltage-Change Ramp Rate | t_{SSxx} | After enabling (Note 12) | $SS_Lx = 1$ | | 5 | | mV/ μs |
| | | After enabling, (Note 12) | $SS_Lx = 0$ | | 100 | | |

Electrical Characteristics—300mA PMOS LDO (LDO3) (continued)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|-----------------------------|--------------|------------------------------------------------------------------------------------------------------------------|-------------------|-----|-----|-----|------------|
| Active Discharge Resistance | | Output disabled, $V_{OUT} = 1V$, resistance from OUT_LDOx to GND, active discharge enabled ($ADE_LX = 1$) | | | 65 | | Ω |
| THERMAL SHUTDOWN | | | | | | | |
| Thermal Shutdown | | Output disabled or enabled | T_J rising | | 165 | | $^\circ C$ |
| | | | T_J falling | | 150 | | |
| POWER-OK COMPARATOR | | | | | | | |
| Power-OK Threshold | V_{POKTHL} | V_{OUT} when V_{POK} switches | V_{OUT} falling | 84 | 87 | | % |
| | | | V_{OUT} rising | | 92 | 96 | |

Electrical Characteristics—150mA NMOS LDO (LDO0, LDO1)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS | |
|----------------------------------------|----------------|----------------------------------------------------|-------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|-----|-------|-------|---|
| GENERAL CHARACTERISTICS | | | | | | | | |
| Input Voltage Range | V_{IN_LDOx} | Guaranteed by output accuracy | | V_{OUT} | | 5.5 | V | |
| Output Voltage Range | V_{OUTxx} | V_{INxx} is the maximum of 3.7 or $V_{OUT}+0.3V$ | 25mV/step (6-bit), LDO0, LDO1 | 0.8 | | 2.375 | V | |
| Maximum Output Current | I_{MAXxx} | Guaranteed by output accuracy | Normal mode | 150 | | | mA | |
| | | | Low-power mode | | 5 | | | |
| CORE PERFORMANCE SPECIFICATIONS | | | | | | | | |
| Output Voltage Accuracy | | | Normal mode | $V_{IN} = V_{NOM}+0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ to I_{MAX} , V_{NOM} set to any voltage, $V_{MBATT} = V_{NOM}+1.5V$ with 2.45V minimum | -3 | | +3 | % |
| | | | Low-power mode | $V_{IN} = V_{NOM}+0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ to 5mA, V_{NOM} set to any voltage, $V_{MBATT} = V_{NOM}+1.5V$ with 2.45V minimum | -5 | | +5 | |

Electrical Characteristics—150mA NMOS LDO (LDO0, LDO1) (continued)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|-------------------------------------------------|--------------|------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------|-----|------|-----|-------------|
| Load Regulation (Note 15) | | Normal mode | $I_{OUT} = 0.1mA$ to I_{MAX} , $V_{IN} = V_{NOM} + 0.3V$, $V_{MBATT} = V_{NOM} + 1.5V$ with 2.45V minimum | | 0.05 | | % |
| | | Low-power mode | $I_{OUT} = 0.1mA$ to 5mA, $V_{IN} = V_{NOM} + 0.3V$, $V_{MBATT} = V_{NOM} + 1.5V$ with 2.45V minimum | | 0.05 | | |
| Line Regulation (Note 15) | | Normal mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ | | 0.01 | | %/V |
| Line Regulation (Note 15) | | Low-power mode | $V_{MBATT} = V_{NOM} + 0.3V$ to 5.5V with 2.45V minimum, $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ | | 0.01 | | %/V |
| Dropout Voltage | V_{DOxx} | Normal mode, $I_{OUT} = I_{MAX}$ | $V_{MBATT} - V_{OUT} = 2.5V$ | | 50 | 100 | mV |
| | | | $V_{MBATT} - V_{OUT} = 1.7V$ | | 150 | 300 | |
| | | Low-power mode, $I_{OUT} = 5mA$, $V_{IN} = 3.7V$ | | | 150 | 300 | |
| Output Current Limit | I_{LIMxx} | $V_{OUT} = 0V$, % of I_{MAX} | | 103 | 180 | 250 | % |
| DYNAMIC CHARACTERISTICS | | | | | | | |
| Soft-Start and Dynamic-Voltage-Change Ramp Rate | t_{SSxx} | After enabling, (Note 14) | $SS_Lx = 0$ | | 100 | | mV/ μs |
| | | After enabling (Note 14) | $SS_Lx = 1$ | | 5 | | |
| Active Discharge Resistance | | Output disabled, $V_{OUT} = 1V$, resistance from OUT_LDOx to GND, active discharge enabled ($ADE_Lx = 1$) | | | 65 | | Ω |
| THERMAL SHUTDOWN | | | | | | | |
| Thermal Shutdown | | Output disabled or enabled | T_J rising | | 165 | | $^\circ C$ |
| | | | T_J falling | | 150 | | |
| POWER-OK COMPARATOR | | | | | | | |
| Power-OK Threshold | V_{POKTHL} | V_{OUT} when V_{POK} switches | V_{OUT} falling | 84 | 87 | | % |
| | | | V_{OUT} rising | | 92 | 96 | |

Electrical Characteristics—300mA NMOS LDO (LDO8)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|----------------------------------------|----------------|----------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|-----------|------|------|-------|
| GENERAL CHARACTERISTICS | | | | | | | |
| Input Voltage Range | V_{IN_LDOx} | Guaranteed by output accuracy | | V_{OUT} | | 5.5 | V |
| Output Voltage Range | V_{OUTxx} | V_{INxx} is the maximum of 3.7 or $V_{OUT}+0.3V$ | 50mV/step (6-bit), LDO8 | 0.8 | | 3.95 | V |
| Maximum Output Current | I_{MAXxx} | Guaranteed by output accuracy | Normal mode | 300 | | | mA |
| | | | Low-power mode | | 5 | | |
| CORE PERFORMANCE SPECIFICATIONS | | | | | | | |
| Output Voltage Accuracy | | Normal mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ to I_{MAX} , V_{NOM} set to any voltage, $V_{MBATT} = V_{NOM} + 1.5V$ with 2.45V minimum | -3 | | +3 | % |
| | | Low-power mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ to 5mA, V_{NOM} set to any voltage, $V_{MBATT} = V_{NOM} + 1.5V$ with 2.45V minimum | -5 | | +5 | |
| Load Regulation (Note 15) | | Normal mode | $I_{OUT} = 0.1mA$ to I_{MAX} , $V_{IN} = V_{NOM}+0.3V$, $V_{MBATT} = V_{NOM}+1.5V$ with 2.45V minimum | | 0.05 | | % |
| | | Low-power mode | $I_{OUT} = 0.1mA$ to 5mA, $V_{IN} = V_{NOM}+0.3V$, $V_{MBATT} = V_{NOM}+1.5V$ with 2.45V minimum | | 0.05 | | |
| Line Regulation (Note 15) | | Normal mode | $V_{IN} = V_{NOM}+0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ | | 0.01 | | %/V |
| Line Regulation (Note 15) | | Low-power mode | $V_{MBATT} = V_{NOM} + 0.3V$ to 5.5V with 2.45V minimum, $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ | | 0.01 | | %/V |

Electrical Characteristics—300mA NMOS LDO (LDO8) (continued)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|-------------------------------------------------|--------------|------------------------------------------------------------------------------------------------------------------|-------------------------|-----|-----|-----|-------------|
| Dropout Voltage | V_{DOxx} | Normal mode, $I_{OUT} = I_{MAX}$ | $V_{MBATT-VOUT} = 2.5V$ | | 50 | 100 | mV |
| | | | $V_{MBATT-VOUT} = 1.7V$ | | 150 | 450 | |
| | | Low-power mode, $I_{OUT} = 5mA$, $V_{IN} = 3.7V$ | | 150 | 300 | | |
| Output Current Limit | I_{LIMxx} | $V_{OUT} = 0V$, % of I_{MAX} | | 110 | 180 | 250 | % |
| DYNAMIC CHARACTERISTICS | | | | | | | |
| Soft-Start and Dynamic-Voltage-Change Ramp Rate | t_{SSxx} | After enabling, (Note 16) | $SS_Lx = 0$ | | 100 | | mV/ μs |
| | | After enabling (Note 16) | $SS_Lx = 1$ | | 5 | | |
| Active Discharge Resistance | | Output disabled, $V_{OUT} = 1V$, resistance from OUT_LDOx to GND, active discharge enabled ($ADE_Lx = 1$) | | | 65 | | Ω |
| THERMAL SHUTDOWN | | | | | | | |
| Thermal Shutdown | | Output disabled or enabled | T_J rising | | 165 | | $^\circ C$ |
| | | | T_J falling | | 150 | | |
| POWER-OK COMPARATOR | | | | | | | |
| Power-OK Threshold | V_{POKTHL} | V_{OUT} when V_{POK} switches | V_{OUT} falling | 84 | 87 | | % |
| | | | V_{OUT} rising | | 92 | 96 | |

Electrical Characteristics—450mA NMOS LDO (LDO7)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|--------------------------------|----------------|----------------------------------------------------|-------------------------|-----------|-----|------|-------|
| GENERAL CHARACTERISTICS | | | | | | | |
| Input Voltage Range | V_{IN_LDOx} | Guaranteed by output accuracy | | V_{OUT} | | 5.5 | V |
| Output Voltage Range | V_{OUTxx} | V_{INxx} is the maximum of 3.7 or $V_{OUT}+0.3V$ | 50mV/step (6-bit), LDO7 | 0.8 | | 3.95 | V |
| Maximum Output Current | I_{MAXxx} | Guaranteed by output accuracy | Normal mode | 450 | | | mA |
| | | | Low-power mode | | 5 | | |

Electrical Characteristics—450mA NMOS LDO (LDO7) (continued)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | |
|----------------------------------------|-------------|---------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-------|--------|
| CORE PERFORMANCE SPECIFICATIONS | | | | | | | |
| Output Voltage Accuracy | | Normal mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ to I_{MAX} , V_{NOM} set to any voltage, $V_{MBATT} = V_{NOM} + 1.5V$ with 2.45V minimum | -3 | | +3 | % |
| | | Low-power mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ to 5mA, V_{NOM} set to any voltage, $V_{MBATT} = V_{NOM} + 1.5V$ with 2.45V minimum | -5 | | +5 | |
| Load Regulation (Note 15) | | Normal mode | $I_{OUT} = 0.1mA$ to I_{MAX} , $V_{IN} = V_{NOM} + 0.3V$, $V_{MBATT} = V_{NOM} + 1.5V$ with 2.45V minimum | | 0.05 | | % |
| | | Low-power mode | $I_{OUT} = 0.1mA$ to 5mA, $V_{IN} = V_{NOM} + 0.3V$, $V_{MBATT} = V_{NOM} + 1.5V$ with 2.45V minimum | | 0.05 | | |
| Line Regulation (Note 15) | | Normal mode | $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ | | 0.01 | | %/ V |
| | | Low-power mode | $V_{MBATT} = V_{NOM} + 0.3V$ to 5.5V with 2.45V minimum, $V_{IN} = V_{NOM} + 0.3V$ to 5.5V, $I_{OUT} = 0.1mA$ | | 0.01 | | |
| Dropout Voltage | V_{DOxx} | Normal mode, $I_{OUT} = I_{MAX}$ | $V_{MBATT} - V_{OUT} = 2.5V$ | | 50 | 100 | mV |
| | | | $V_{MBATT} - V_{OUT} = 1.5V$ | | 150 | 450 | |
| | | Low-power mode, $I_{OUT} = 5mA$, $V_{IN} = 3.7V$ | | 150 | 300 | | |
| Output Current Limit | I_{LIMxx} | $V_{OUT} = 0V$, % of I_{MAX} | 110 | 180 | 250 | % | |

Electrical Characteristics—450mA NMOS LDO (LDO7) (continued)

($V_{SYS} = 3.7V$, $V_{IN_LDO} = 3.7V$, $C_{IN_LDO} = 1\mu F$, $C_{OUT_LDO} = 2.2\mu F$. Limits are 100% production tested at $T_A = +25^\circ C$. Limits over the operating temperature range ($T_A = -40^\circ C$ to $+85^\circ C$) are guaranteed by design and characterization, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|-------------------------------------------------|--------------|----------------------------------------------------------------------------------------------------------------|-------------------|-----|-----|-----|-------------|
| DYNAMIC CHARACTERISTICS | | | | | | | |
| Soft-Start and Dynamic-Voltage-Change Ramp Rate | t_{SSxx} | After enabling, (Note 18) | $SS_Lx = 0$ | | 100 | | mV/ μs |
| | | After enabling (Note 18) | $SS_Lx = 1$ | | 5 | | |
| Active Discharge Resistance | | Output disabled, $V_{OUT}=1V$, resistance from OUT_LDOx to GND, active discharge enabled ($ADE_Lx = 1$) | | | 65 | | Ω |
| THERMAL SHUTDOWN | | | | | | | |
| Thermal Shutdown | | Output disabled or enabled | T_J rising | | 165 | | $^\circ C$ |
| | | | T_J falling | | 150 | | |
| POWER-OK COMPARATOR | | | | | | | |
| Power-OK Threshold | V_{POKTHL} | V_{OUT} when V_{POK} switches | V_{OUT} falling | 84 | 87 | | % |
| | | | V_{OUT} rising | | 92 | 96 | |

Electrical Characteristics—GPIO

($V_{SYS} = 3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$, limits are 100% tested at $T_A = +25^\circ C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|-----------------------|------------------|------------------------------------------------------------------------------------------------------|---------------------|-----------------------|-------|-----|---------|
| POWER SUPPLY | | | | | | | |
| Power-Supply Voltage | V_{MBATT} | GPIO0-3 (Note 20) | | 2.6 | | 5.5 | V |
| | V_{GPIO_INB} | GPIO4-7 (Note 20) | | 1.7 | | 5.5 | |
| Supply Current | I_{GPIO_INB} | GPIO configured as input and connected to ground | | | | 1 | μA |
| GPIO INPUT | | | | | | | |
| Input Voltage Low | V_{IL} | GPIO0-3, $V_{MBATT} = 2.6V$ to $5.5V$ GPIO4-7, $V_{IN_GPIOB} = 1.7V$ to $5.5V$ | | | | 0.5 | V |
| Input Voltage High | V_{IH} | GPIO0-3, $V_{MBATT} = 2.6V$ to $5.5V$ | | 0.7 x V_{MBATT} | | | V |
| | | GPIO4-7, $V_{IN_GPIOB} = 1.7V$ to $5.5V$ | | 0.7 x V_{GPIO_INB} | | | |
| Input Hysteresis | V_{HYS_GPIO} | | | | 0.25 | | V |
| Input Leakage Current | I_{LKG_GPIOx} | $V_{IN_GPIOB} = V_{MBATT} = 5.5V$, $V_{GPIOx} = 0V$ and $5.5V$, internal pull-up/down disabled | $T_A = +25^\circ C$ | | 0.001 | 1 | μA |
| | | | $T_A = +85^\circ C$ | | 0.01 | | |

Electrical Characteristics—GPIO (continued)

($V_{SYS} = 3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|----------------------------|----------------|---------------------------------------------------|------------------------------------------------|-----|------|----------------------------|------------|
| GPIO OUTPUT | | | | | | | |
| Output Voltage Low | V_{OL} | $I_{SINK} = 4mA$, open-drain and push-pull mode | | | | 0.08 | V |
| | | $I_{SINK} = 12mA$, open-drain and push-pull mode | | | | 0.25 | |
| Output Voltage High | V_{OH} | GPIO4-7 | $V_{IN_GPIOB} = 1.7V$, $I_{SOURCE} = 4mA$ | | | $0.7 \times V_{IN_GPIOB}$ | V |
| | | GPIO0-3 | $V_{MBATT} = 3.6$, $I_{SOURCE} = 4mA$ | | | $0.7 \times V_{MBATT}$ | |
| GPIO Open Leakage Current | | $V_{IN_GPIOB} = V_{MBATT} = 5.5V$ | $T_A = +25^{\circ}C$ | | 0.01 | 1 | μA |
| | | | $T_A = +85^{\circ}C$ | | 0.1 | | |
| INTERNAL RESISTANCE | | | | | | | |
| Pullup Resistance | R_{PU_GPIO} | | | 50 | 100 | 160 | k Ω |
| Pulldown Resistance | R_{PD_GPIO} | | | 50 | 100 | 160 | k Ω |

Electrical Characteristics—32kHz Oscillator

($V_{SYS} = 3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|-------------------------------------|---------------|----------------------------------------|--|-----------------|-----------|-----------|---------|
| CRYSTAL OSCILLATOR | | | | | | | |
| Crystal-Oscillator Supply Voltage | V_{RTC} | (Note 21) | | 1.71 | 2.5 | | V |
| Crystal Loading | | $32KLOAD = 0b01$ (Note 22) | | | 6.5 | | μF |
| | | $32KLOAD = 0b10$ (Note 22) | | | 7.5 | | |
| | | $32KLOAD = 0b11$ (Note 22) | | | 12.5 | | |
| BYPASS MODE | | | | | | | |
| XIN I/O Voltage | V_{RTC} | Maximum V_{RTC} external load of 1mA | | | V_{RTC} | | V |
| XIN Input Low Voltage | V_{XIN_IL} | | | 0 | | 0.4 | V |
| XIN Input High Voltage | V_{XIN_IH} | | | $V_{RTC} - 0.4$ | | V_{RTC} | V |
| XIN Input Hysteresis | | | | | 400 | | mV |
| XIN Input Leakage Current | | $T_A = +25^{\circ}C$ | | -1 | | +1 | μA |
| SILICON OSCILLATOR | | | | | | | |
| Silicon-Oscillator Supply Voltage | V_{RTC} | | | 1.71 | 2.5 | | V |
| Silicon Oscillator Output Frequency | | | | | 32768 | | Hz |

Electrical Characteristics—32kHz Oscillator (continued)

($V_{SYS} = 3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---------------------------------------|----------------|-------------------------------------|-----|-----|-----|--------|
| VALID FREQUENCY DETECTOR | | | | | | |
| Valid XOSCOK Signal Minimum Frequency | f_{DET_MIN} | | | 10 | | kHz |
| Valid XOSCOK Signal Maximum Frequency | f_{DET_MAX} | | | 110 | | kHz |
| OK32K Signal Debounce (Note 23) | | Primary crystal oscillator (XOSCOK) | | 256 | | cycles |
| | | Backup silicon oscillator (XOSCOK) | | 32 | | cycles |

Electrical Characteristics—Backup Battery Charger

($V_{SYS} = 3.6V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, limits are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization. Specifications marked "GBD" are guaranteed by design and not production tested.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | |
|----------------------------------------------|--------|-----------------------------------------|-------------------------------|-------|-------|------------|---|
| BACKUP BATTERY CHARGER | | | | | | | |
| Programmable Output Voltage Range | | $I_{LOAD} = 1\mu A$ | BBCVS[1:0] = 0x00 | 2.420 | 2.500 | 2.580 | V |
| | | | BBCVS[1:0] = 0x01 | 2.910 | 3.000 | 3.090 | |
| | | | BBCVS[1:0] = 0x02 | 3.200 | 3.300 | 3.400 | |
| | | | BBCVS[1:0] = 0x03 | 3.395 | 3.500 | 3.605 | |
| Constant Current Limit | | V_{BBATT} short to GND, BBCLOWIEN = 0 | BBCCS[1:0] = 0x00, 0x01, 0x02 | 50 | | μA | |
| | | | BBCCS[1:0] = 0x03 | 100 | | | |
| | | V_{BBATT} short to GND, BBCLOWIEN = 1 | BBCCS[1:0] = 0x00 | 200 | | | |
| | | | BBCCS[1:0] = 0x00 | 600 | | | |
| | | | BBCCS[1:0] = 0x02 | 800 | | | |
| | | | BBCCS[1:0] = 0x03 | 400 | | | |
| Output Resistance | | | BB CRS[1:0] = 0x00 | 0.1 | | k Ω | |
| | | | BB CRS[1:0] = 0x01 | 1 | | | |
| | | | BB CRS[1:0] = 0x02 | 3 | | | |
| | | | BB CRS[1:0] = 0x03 | 6 | | | |
| Reverse Leakage Current from BBATT to VMBATT | | Input = 0V, $V_{BBATT} = 3.0V$ | $T_A = +25^{\circ}C$ | 0.01 | 10 | μA | |
| | | | $T_A = +85^{\circ}C$ | 0.1 | | | |

Note 2: Design guidance only and is not production tested.

Note 3: Design guidance only and is not production tested.

Note 4: Design guidance only and is not production tested.

Note 5: Individual step-down supply current is not production tested. It is covered by a combined test by turning on all step-down regulators.

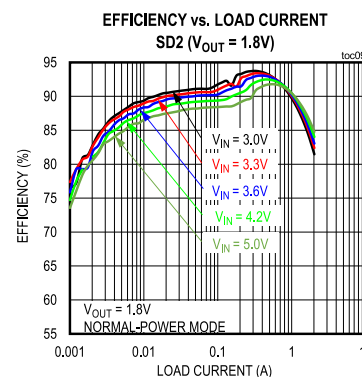
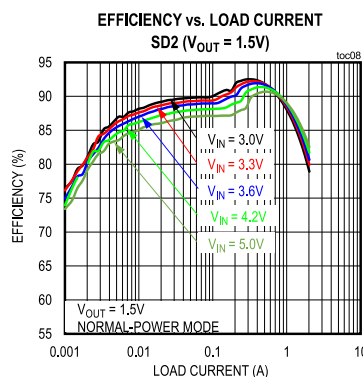
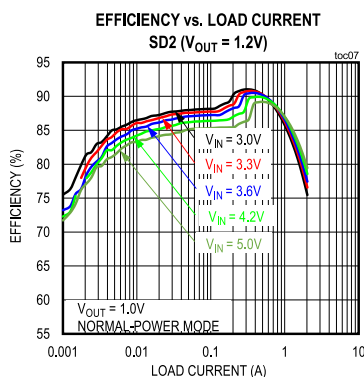
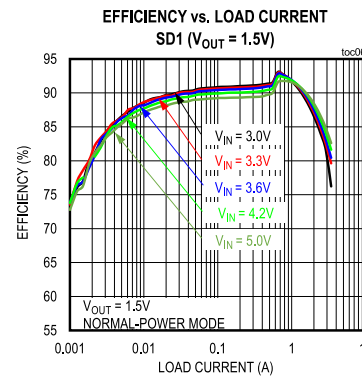
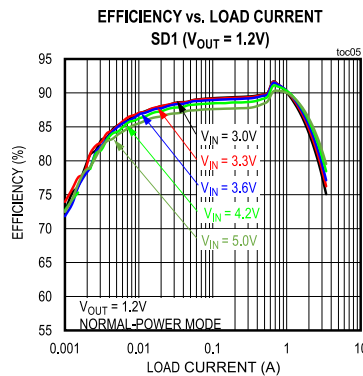
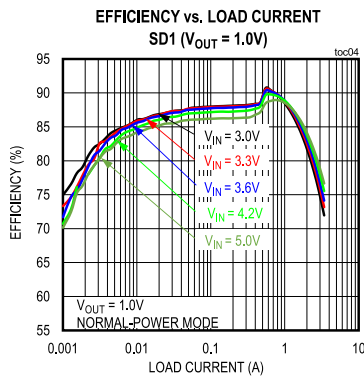
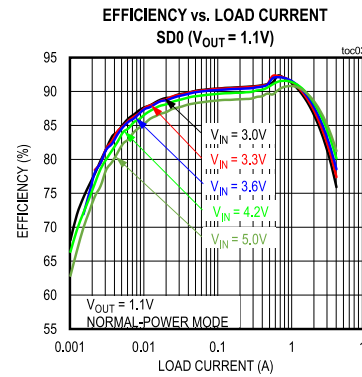
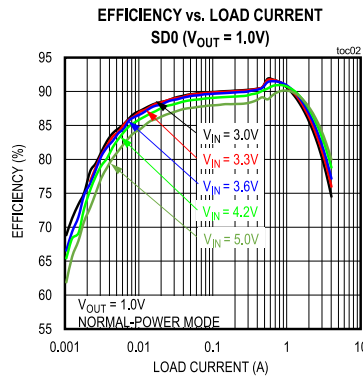
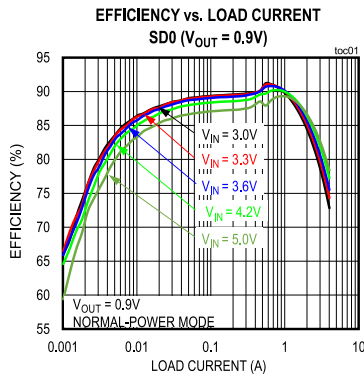
Note 6: There is an n-channel MOSFET in series with the output active discharge resistance. This NMOS requires $V_{SYS} > 1.2V$ to be enhanced.

Note 7: The ramp-down slew rate when the output voltage is decreased via I²C is a function of the negative current limit and the output capacitance. With no load, forced PWM mode, and 22 μF output capacitor, the ramp-down slew rate is $dv/dt = i / C = 0.4A / 22\mu F = 18mV/\mu s$.

- Note 8:** DVS and soft-start ramp rates can be expected to vary by up to 30%.
- Note 9:** The input and output voltage range of SD2/3 ensure that the 90% duty cycle limitation can never practically be reached. Additionally, SD2/3 is capable of 100% duty cycle for output voltages above 1.9V.
- Note 10:** Limits are 100% production tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.
- Note 11:** Does not include ESR of the capacitance or trace resistance of the PCB.
- Note 12:** Limits are 100% production tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.
- Note 13:** Does not include ESR of the capacitance or trace resistance of the PCB.
- Note 14:** Limits are 100% production tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.
- Note 15:** Does not include ESR of the capacitance or trace resistance of the PCB.
- Note 16:** Limits are 100% production tested at $T_A = +25^\circ\text{C}$. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.
- Note 17:** Does not include ESR of the capacitance or trace resistance of the PCB.
- Note 18:** Does not include ESR of the capacitance or trace resistance of the PCB.
- Note 19:** During a soft-start event or a DVS transition, the regulators output current increases by $C_{OUT} \times dV/dt$. In the event that the load current plus the additional current imposed by the soft-start or DVS transition reach the regulator's current limit, the current limit is enforced. When the current limit is enforced, the advertised transition rate (dV/dt) does not occur.
- Note 20:** Guaranteed by V_{IH} and V_{IL} tests.
- Note 21:** Minimum supply for basic functionality with reduced accuracy.
- Note 22:** Includes 3pF of parasitic capacitance on XIN and XOUT.
- Note 23:** Number of valid cycles the frequency detector needs to count before it asserts OK32K.

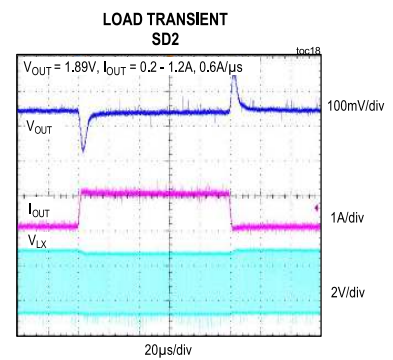
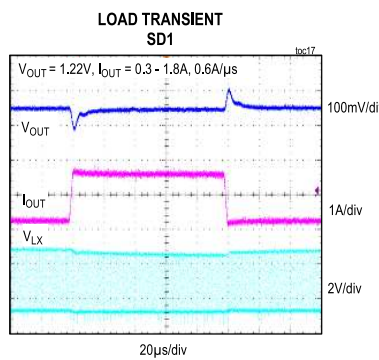
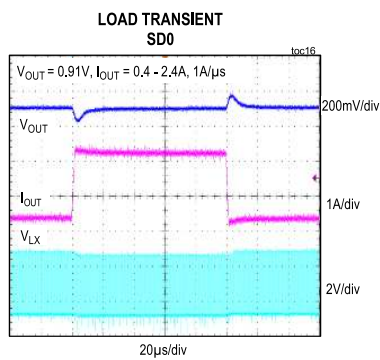
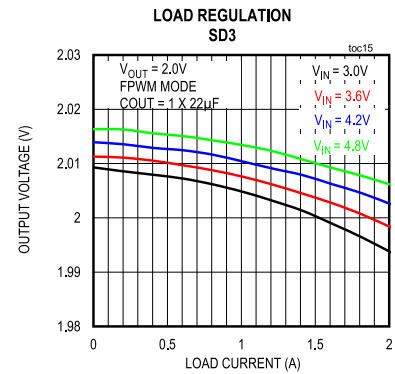
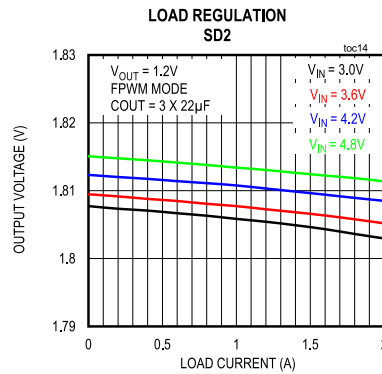
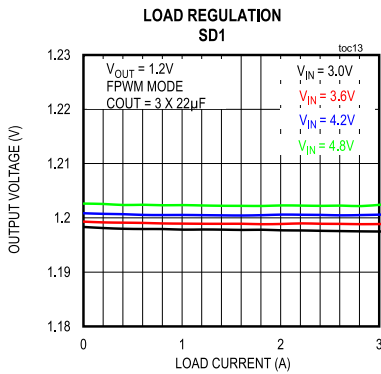
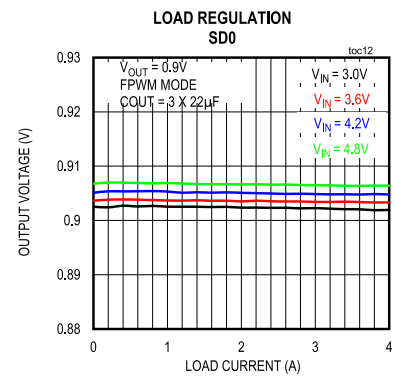
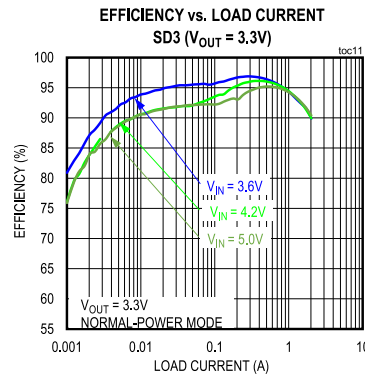
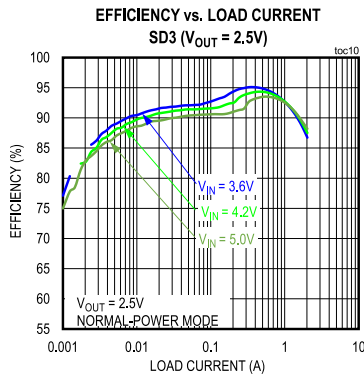
Typical Operating Characteristics

($AV_{DD} = +3.3V$, $V_{DDIO} = +1.8V$, $V_{REFP} - V_{REFN} = V_{REF} = 2.5V$; No Line-Frequency Rejection, Continuous-Conversion Mode, Internal Clock; $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted.)



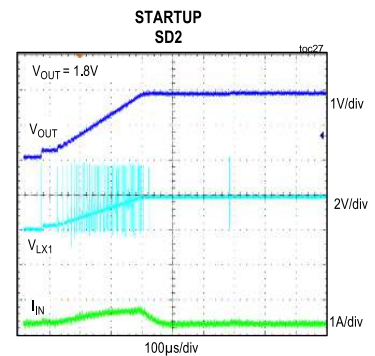
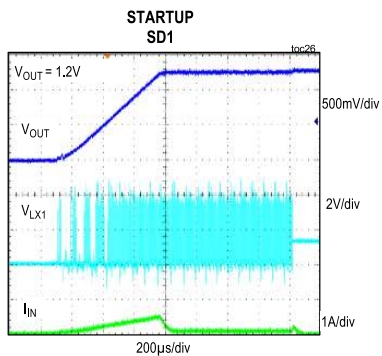
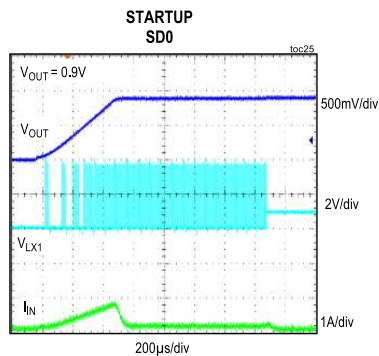
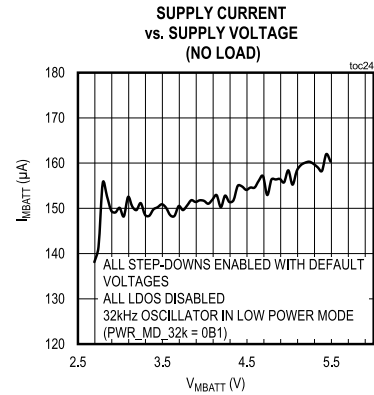
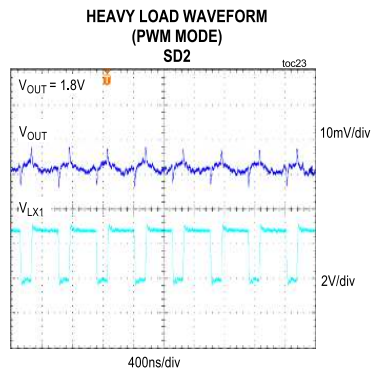
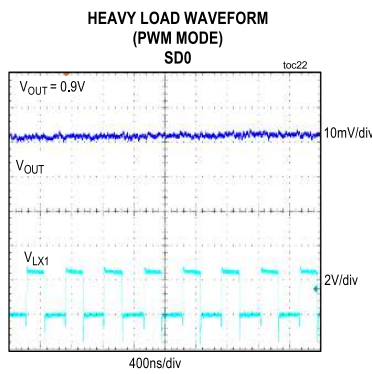
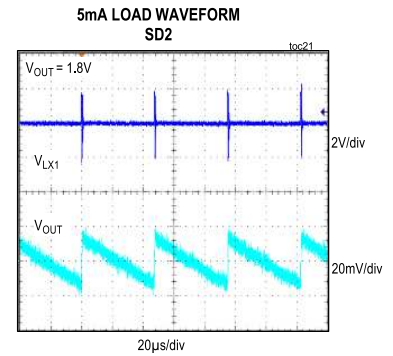
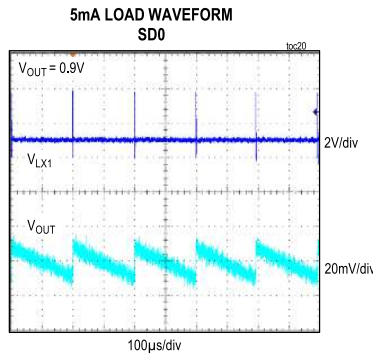
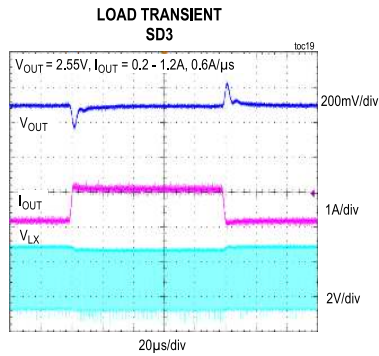
Typical Operating Characteristics (continued)

($AV_{DD} = +3.3V$, $V_{DDIO} = +1.8V$, $V_{REFP} - V_{REFN} = V_{REF} = 2.5V$; No Line-Frequency Rejection, Continuous-Conversion Mode, Internal Clock; $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted.)



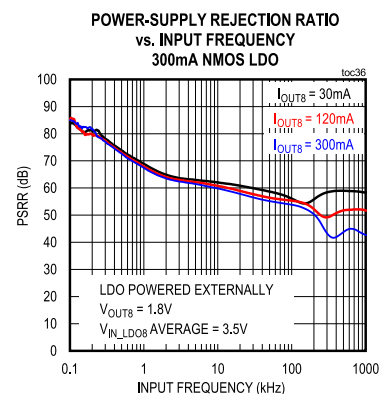
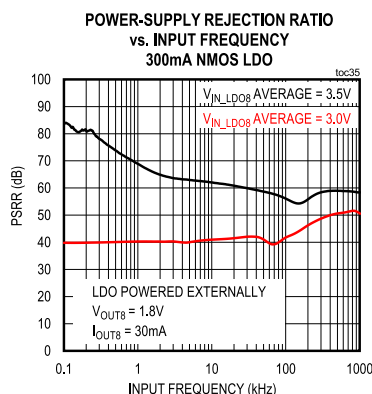
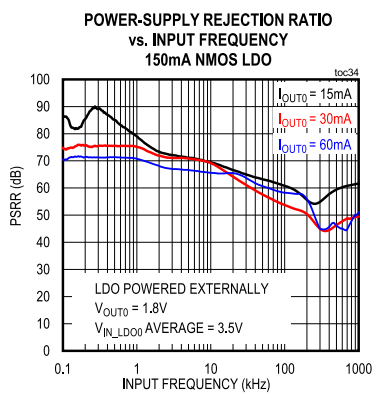
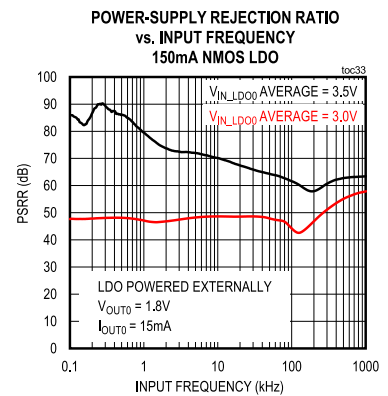
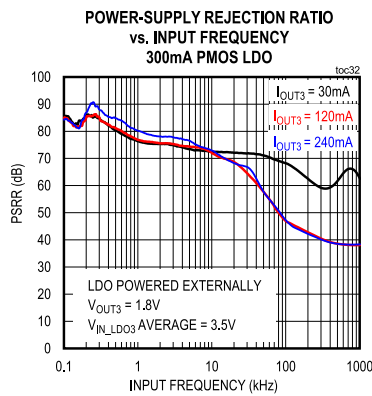
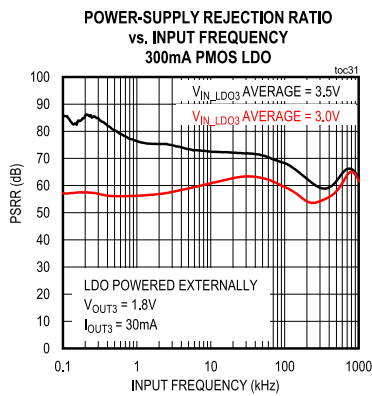
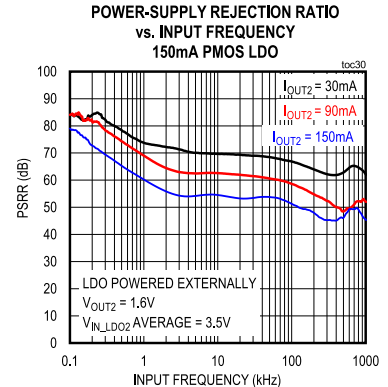
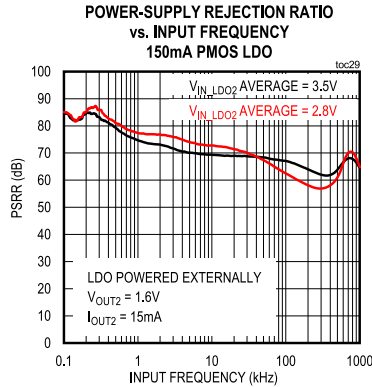
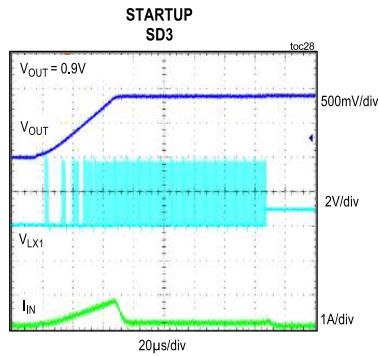
Typical Operating Characteristics (continued)

($A_{V_{DD}} = +3.3V$, $V_{DDIO} = +1.8V$, $V_{REFP} - V_{REFN} = V_{REF} = 2.5V$; No Line-Frequency Rejection, Continuous-Conversion Mode, Internal Clock; $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted.)



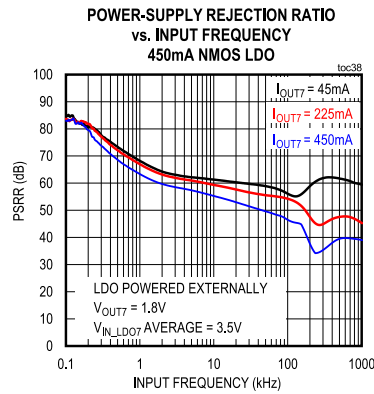
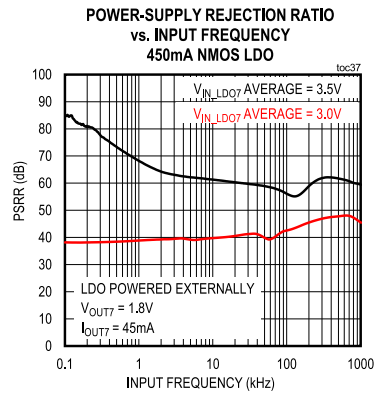
Typical Operating Characteristics (continued)

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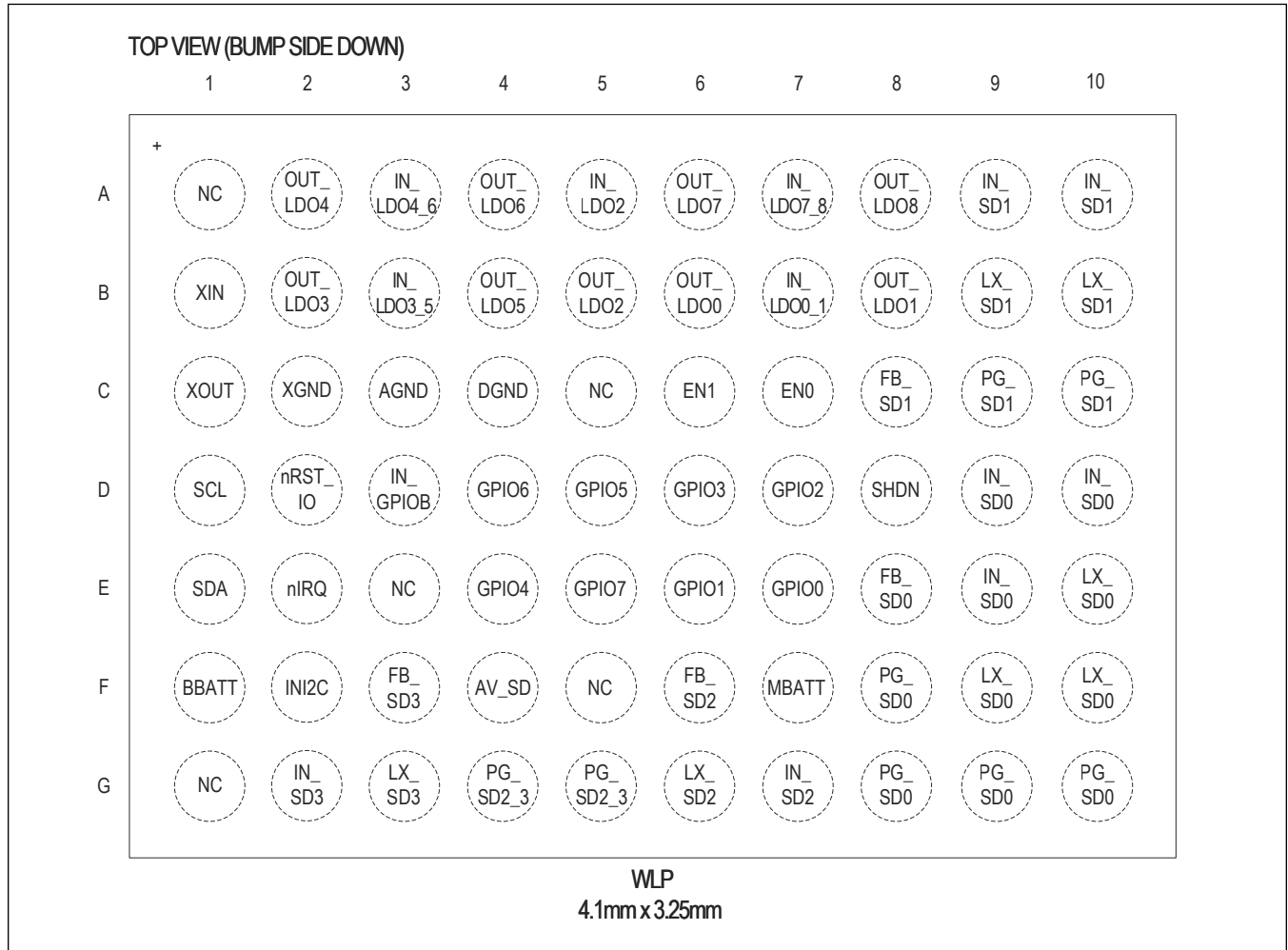
Typical Operating Characteristics (continued)

($A_{V_{DD}} = +3.3V$, $V_{DDIO} = +1.8V$, $V_{REFP} - V_{REFN} = V_{REF} = 2.5V$; No Line-Frequency Rejection, Continuous-Conversion Mode, Internal Clock; $T_A = T_{MIN}$ to T_{MAX} unless otherwise noted.)



Bump Configuration

MAX77714



Bump Description

| PIN | NAME | FUNCTION | TYPE |
|------------|-------|----------------------------------------------------------------------------------------------------------------|----------------|
| TOP | | | |
| F7 | MBATT | Low-Noise PMIC Power Input. Bypass MBATT with a 0.1µF ceramic capacitor to ground. | Power Input |
| F1 | BBATT | Backup Battery Connection. Bypass BBATT with a 0.1µF ceramic capacitor to ground. | Power Input |
| C1 | XOUT | 32.768kHz Crystal Oscillator Output. XOUT has on-chip programmable load capacitors for the crystal oscillator. | Output |
| B1 | XIN | 32.768kHz Crystal Oscillator Input. XIN has on-chip programmable load capacitors for the crystal oscillator. | Input |
| C2 | XGND | Crystal Oscillator Ground. All XGND pins must be connected together. | Ground |
| E2 | nIRQ | Active-Low Interrupt Output. nIRQ is an open-drain output. | Digital Output |

Bump Description (continued)

| PIN | NAME | FUNCTION | TYPE |
|-----------------------|-----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|
| C7 | EN0 | Enable Input 0 to the Flexible Power Sequencer. EN0 is typically connected to the system's ONKEY. | Digital Input |
| C6 | EN1 | Enable Input 1 to the Flexible Power Sequencer. EN1 is typically connected to the system's AP. | Digital Input |
| D8 | SHDN | The shutdown input (SHDN) is a digital input to the ON/OFF controller that causes the device to reset through a global shutdown event. The signal for SHDN typically comes from a temperature sensor that measures the internal die temperature of the AP. | Digital Input |
| D2 | nRST_IO | This is a bidirectional, active-low, open-drain, reset input/output. | Digital I/O |
| C3 | AGND | Analog Ground. All GND pins must be connected together. | Ground |
| C4 | DGND | Digital Ground. DGND carries ground current for digital circuits such as the I ² C. | Ground |
| A1, G1, E3, F5, C5 | NC | No Connect. This bump is not internally connected to any node. This can be connected to GND to help improve thermal performance. | Ground |
| LDO | | | |
| B7 | IN_LDO0_1 | Linear Regulator 0 and 1 Power Input. Bypass IN_LDOx to GND with a 2.2μF ceramic capacitor. | Power Input |
| B6 | OUT_LDO0 | 150mA NMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO0 or leave it unconnected. | Power Output |
| B8 | OUT_LDO1 | 150mA NMOS LDO1 Output. If the LDO1 is not used, it is recommended to either ground OUT_LDO1 or leave it unconnected. | Power Output |
| A5 | IN_LDO2 | Linear Regulator 2 Power Input. Bypass IN_LDO2 to GND with a 2.2μF ceramic capacitor. | Power Input |
| B5 | OUT_LDO2 | 150mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO2 or leave it unconnected. | Power Output |
| B3 | IN_LDO3_5 | Linear Regulator 3 and 5 Power Input. Bypass IN_LDO3_5 to GND with a 2.2μF ceramic capacitor. | Power Input |
| B2 | OUT_LDO3 | 300mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO3 or leave it unconnected. | Power Output |
| B4 | OUT_LDO5 | 150mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO5 or leave it unconnected. | Power Output |
| A3 | IN_LDO4_6 | Linear Regulator 4 and 6 Power Input. Bypass IN_LDO4_6 to GND with a 2.2μF ceramic capacitor. | Power Input |
| A2 | OUT_LDO4 | 150mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO4 or leave it unconnected. | Power Output |
| A4 | OUT_LDO6 | 150mA PMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO6 or leave it unconnected. | Power Output |
| A6 | OUT_LDO7 | 450mA NMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO7 or leave it unconnected. | Power Output |
| A7 | IN_LDO7_8 | Linear Regulator 7 and 8 Power Input. Bypass IN_LDO7_8 to GND with a 2.2μF ceramic capacitor. | Power Input |
| A8 | OUT_LDO8 | 300mA NMOS LDO Output. If the LDO is not used, it is recommended to either ground OUT_LDO8 or leave it unconnected. | Power Output |
| STEP-DOWN | | | |
| D9, E9, D10 | IN_SD0 | SD0 Power Input. IN_SD0 is the drain connection of BUCK0's main power FET. IN_SD0 is a critical discontinuous-current node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect IN_SD01 and its bypass capacitor. | Power Input |

Bump Description (continued)

| PIN | NAME | FUNCTION | TYPE |
|-----------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|
| F9, F10, E10 | LX_SD0 | SD0 Switching Node. Connect the required inductor between LX_SD0 and the output capacitor. LX_SD0 is a critical node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect LX_SD0 to the power inductor. | Power I/O |
| F8, G8, G9, G10 | PG_SD0 | SD0 Power Ground are internally combined. PG_SD0 is the source connection of BUCK0's synchronous rectifier. PG_SD0 is a critical discontinuous current node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect the various ground nodes of this device. | Ground |
| E8 | FB_SD0 | SD0 Output Voltage Feedback Node. Connect FB_SD0 to the local output capacitor at the Buck output. In addition to setting the output voltage regulation threshold, FB_SD0 can also be programmed to discharge the output capacitor when the converter is shutdown. FB_SD0 is a critical analog input that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect FB_SD0 to the regulator output. | Analog Input |
| A9, A10 | IN_SD1 | SD1 Power Input. IN_SD1 is the drain connection of BUCK1's main power FET. IN_SD1 is a critical discontinuous-current node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect IN_SD1 and its bypass capacitor. | Power Input |
| B9, B10 | LX_SD1 | SD1 Switching Node. Connect the required inductor between LX_SD1 and the output capacitor. LX_SD1 is a critical node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect LX_SD1 to the power inductor. | Power I/O |
| C9, C10 | PG_SD1 | SD1 Power Ground are internally combined. PG_SD1 is the source connection of BUCK1's synchronous rectifier. PG_SD1 is a critical discontinuous-current node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect the various ground nodes of this device. | Ground |
| C8 | FB_SD1 | SD1 Output Voltage Feedback Node. Connect FB_SD1 to the local output capacitor at the Buck output. In addition to setting the output voltage regulation threshold, FB_SD1 can also be programmed to discharge the output capacitor when the converter is shutdown. FB_SD1 is a critical analog input that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect FB_SD1 to the regulator output. | Analog Input |
| G7 | IN_SD2 | SD2 Power Input. IN_SD2 is the drain connection of BUCK2's main power FET. IN_SD2 is a critical discontinuous-current node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect IN_SD2 and its bypass capacitor. | Power Input |
| G6 | LX_SD2 | SD2 Switching Node. Connect the required inductor between LX_SD2 and the output capacitor. LX_SD2 is a critical node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect LX_SD2 to the power inductor. | Power I/O |
| G4, G5 | PG_SD2_3 | SD2 and SD3 Power Ground are internally combined. PG_SD2_3 is the source connection of SD2 and 3's synchronous rectifier. PG_SD2_3 is a critical discontinuous-current node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect the various ground nodes of this device. | Ground |
| F6 | FB_SD2 | SD2 Output Voltage Feedback Node. Connect FB_SD2 to the local output capacitor at the Buck output. In addition to setting the output voltage regulation threshold, FB_SD2 can also be programmed to discharge the output capacitor when the converter is shutdown. FB_SD2 is a critical analog input that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect FB_SD2 to the regulator output. | Analog Input |

Bump Description (continued)

| PIN | NAME | FUNCTION | TYPE |
|-----------------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|
| G2 | IN_SD3 | SD3 Power Input. IN_SD3 is the drain connection of BUCK1's main power FET. IN_SD3 is a critical discontinuous-current node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect IN_SD3 and its bypass capacitor. | Power Input |
| G3 | LX_SD3 | SD3 Switching Node. Connect the required inductor between LX_SD3 and the output capacitor. LX_SD3 is a critical node that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect LX_SD3 to the power inductor. | Power I/O |
| F3 | FB_SD3 | SD3 Output Voltage Feedback Node. Connect FB_SD3 to the local output capacitor at the Buck output. In addition to setting the output voltage regulation threshold, FB_SD3 can also be programmed to discharge the output capacitor when the converter is shutdown. FB_SD3 is a critical analog input that requires careful PCB layout. See the PCB Layout Guidelines section for advice on how to connect FB_SD3 to the regulator output. | Analog Input |
| F4 | AV_SD | SD3 Analog Power input. Connect AV_SD to the local output capacitor at the Buck Input. This supply powers the internal analog circuit. | Analog Input |
| I²C | | | |
| E1 | SDA | Serial Interface Data Bidirectional Open-Drain. | Digital I/O |
| D1 | SCL | Serial Interface Clock Input. Open-Drain Output. | Digital Input |
| F2 | INI2C | Internal Logic Supply for SDA and SCL. | Power Input |
| GPIO | | | |
| E7 | GPIO0 | General Purpose Input Output resource can be controlled using the Flexible Power Sequencer. | Digital I/O |
| E6 | GPIO1 | General Purpose Input Output resource can be controlled using the Flexible Power Sequencer. | Digital I/O |
| D7 | GPIO2 | General Purpose Input Output resource can be controlled using the Flexible Power Sequencer. | Digital I/O |
| D6 | GPIO3 | General Purpose Input Output resource and can be configured as an ACOK input when configured in ALT mode. | Digital I/O |
| E4 | GPIO4 | General Purpose Input Output resource and can be configured to output 32kHz clock when configured in ALT mode. | Digital I/O |
| D5 | GPIO5 | General Purpose Input Output resource and can be configured to output 32kHz clock when configured in ALT mode. | Digital I/O |
| D4 | GPIO6 | General Purpose Input Output resource and can be configured to output 32kHz clock when configured in ALT mode. | Digital I/O |
| E5 | GPIO7 | General Purpose Input Output resource can be controlled using the Flexible Power Sequencer. | Digital I/O |
| D3 | IN_GPIOB | Input for the General Purpose Input Output resource 4-7. | Digital I/O |

Detailed Description

OTP Options

Refer to [Table 1](#) for the default register settings.

Table 1. OTP Options

| RESOURCE | MAX77714EWC+ | MAX77714FEWC+ | MAX77714GEWC+ |
|--------------------|---------------------------------------------------------------------|---------------------------------------------------------------------|---------------------------------------------------------------------------|
| CID4 | 0x01 | 0x06 | 0x08 |
| MSTR_PU[2:0] | 3904μs | 984μs | 984μs |
| MSTR_PD[2:0] | 3904μs | 31μs | 31μs |
| MSTR_SLPENTRY[2:0] | 3904μs | 984μs | 984μs |
| MSTR_SLPEXT[2:0] | 3904μs | 31μs | 31μs |
| SD0 | 0.90V, FPS0, UPSLT1, DNSLT1 | 1.20V, FPS1, UPSLT1, DNSLT0 | 1.20V, FPS1, UPSLT1, DNSLT0 |
| SD1 | 1.29V, FPS0, UPSLT3, DNSLT3 | 0.90V, FPS1, UPSLT3, DNSLT0 | 0.90V, FPS1, UPSLT3, DNSLT0 |
| SD2 | 1.80V, FPS0, UPSLT5, DNSLT5 | 0.625V, FPS0, UPSLT5, DNSLT0 | 0.625V, FPS0, UPSLT5, DNSLT0 |
| SD3 | 0.90V, FPS0, UPSLT4, DNSLT4 | 3.6V, NOT CONFIGURED IN FPS, OUTPUT DISABLED | 3.6V, NOT CONFIGURED IN FPS, OUTPUT DISABLED |
| LDO0 | 1.80V, FPS0, UPSLT6, DNSLT6 | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED |
| LDO1 | 0.90V, FPS0, UPSLT6, DNSLT6 | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED |
| LDO2 | 3.30V, FPS0, UPSLT6, DNSLT6 | 2.5V, FPS1, UPSLT2, DNSLT0, NORMAL-POWER MODE | 2.5V, FPS1, UPSLT4, DNSLT6, NORMAL POWER MODE |
| LDO3 | 2.90V, FPS0, UPSLT6, DNSLT6 | 3.3V, FPS1, UPSLT6, DNSLT0, GLOBAL LOW-POWER MODE | 3.3V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED |
| LDO4 | 0.90V, FPS0, UPSLT6, DNSLT6 | 0.4V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED | 0.4V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED |
| LDO5 | 3.30V, FPS0, UPSLT6, DNSLT6 | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED |
| LDO6 | 1.80V, FPS0, UPSLT4, DNSLT4 | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED | 0.8V, FPS1, UPSLT4, DNSLT0, OUTPUT DISABLED |
| LDO7 | 3.30V, FPS0, UPSLT6, DNSLT6 | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED |
| LDO8 | 2.90V, FPS0, UPSLT7, DNSLT7 | 0.8V, FPS1, UPSLT6, DNSLT0, OUTPUT DISABLED | 0.8V, FPS1, UPSLT7, DNSLT0, GLOBAL LOW-POWER MODE |
| GPIO0 | FPS0, UPSLT0, DNSLT0 | NOT CONFIGURED IN FPS | FPS0, UPSLT7, DNSLT7 |
| RSTIO | FPS0, UPSLT7, DNSLT7 | FPS0, UPSLT4, DNSLT7 | FPS0, UPSLT7, DNSLT7 |
| 32KSOURCE_OTP | 0b1 (Silicon Oscillator) | 0b1 (Silicon Oscillator) | 0b1 (Silicon Oscillator) |
| OTP_EN0[1:0] | 0b10 (ON/OFF Software) | 0b01 (Slide Switch) | 0b01 (Slide Switch) |
| OTP_MR | 0b0 (Manual reset with no wakeup) | 0b0 (Manual reset with no wakeup) | 0b0 (Manual reset with no wakeup) |
| OTP_I2CADDR[1:0] | 0b00 PMIC 7-bit address = 0x38 RTC 7-bit slave address = 0x90 | 0b00 PMIC 7-bit address = 0x38 RTC 7-bit slave address = 0x90 | 0b01 PMIC 7-bit slave address = 0x3C RTC 7-bit slave address = 0x94 |

Table 1. OTP Options (continued)

| | | | |
|----------------|------------------------------------------------------------------|------------------------------------------------------------------|------------------------------------------------------------------|
| OTP_MBATT | 0b0 (MBATT wakeup signal disabled) | 0b0 (MBATT wakeup signal disabled) | 0b0 (MBATT wakeup signal disabled) |
| OTP_TRSTO[1:0] | 0b10 (32ms) | 0b00 (1ms) | 0b00 (1ms) |
| OTP_SHDNAL | 0b0 (Active-high) | 0b0 (Active-high) | 0b0 (Active-high) |
| OTP_BBATT | 0b0 (BBCVS[0] will always reset to 1b0) | 0b0 (BBCVS[0] will always reset to 1b0) | 0b0 (BBCVS[0] will always reset to 1b0) |
| OTP_ACOKAL | 0b0 (Active-high) | 0b0 (Active-high) | 0b0 (Active-high) |
| OTP_EN1AL | 0b0 (Active-high) | 0b0 (Active-high) | 0b1 (Active-low) |
| OTP_EN0AL | 0b0 (Active-high) | 0b0 (Active-high) | 0b0 (Active-high) |
| OTP_WDTEN | 0b0 (Watchdog default off, can be enabled with I ² C) | 0b0 (Watchdog default off, can be enabled with I ² C) | 0b0 (Watchdog default off, can be enabled with I ² C) |

Detailed Description—Global Resources

Voltage References, Bias Currents, and Timing References

Centralized voltage references, bias current, and timing references support all of the functional blocks within the MAX77714. These resources are automatically enabled when any of the peripheral functions within the device require them. The supply current associated with the minimum set of these resources make up the quiescent current (I_{Q_MBATT}).

Voltage Monitors

The MBATT undervoltage lockout (UVLO) and MBATT overvoltage lockout (OVLO) comparators force the entire device off when the supply voltage (V_{MBATT}) is not within the acceptable window of operation. Disabling the device when the supply is outside of its acceptable range ensures reliable consistent behavior when the supply voltage is removed/applied and prevents overvoltage stress to the device. The main-battery low signal is also available through the nRST_IO signal when LBRSTEN = 1. With all peripheral blocks of the device disabled, the quiescent current of the device is 12μA (I_{Q_MBATT}).

Thermal Monitors

Several on-chip thermal sensors force the device to shutdown if the junction temperature exceeds +165°C (T_{JSHDN}). In addition to the +165°C shutdown threshold, these thermal sensors also provide interrupts when the temperature exceeds +120°C (thermal alarm 1) and +140°C (thermal alarm 2).

Bidirectional Reset Input/Output

The device has a bidirectional, active-low, open-drain, reset input/output (nRST_IO). The RSO signal within the bidirectional reset IO logic is asserted by the device when it needs to drive nRST_IO low. If the device is not driving nRST_IO low (i.e., RSO is low), and an external device such as a reset button pulls nRST_IO low, then the RSI signal within the bidirectional reset IO logic is asserted. If RSI is asserted for longer than t_{DBNC}, then a global shutdown event is triggered (GLBALSHDN). A global shutdown due to RSI is recorded in the POERC register such that when the system's microprocessor recovers from the reset it can recognize that the cause of the power down was due to RSI. If a global shutdown event is triggered by RSI, then the device automatically generates a wakeup event after the global shutdown event has completed.

The reset output is a programmable slave to the flexible power sequencer. Allowing the RSO to respond to the flexible power sequencer gives it the capability to drive the nRST_IO line low as the first action in the power down sequence. The RSTIOFPS register configures how nRST_IO behaves with respect to the flexible power sequencer.

Once all conditions for allowing the reset output to go high-impedance have been met, a reset delay timer is initiated before RSO is deasserted (t_{RST_O}).

The following bulleted list summarizes all the conditions required for the device to set RSO low and allow nRST_IO to go high-impedance.

MAX77714

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

- The device must not be in a global shutdown state.
- The 32kHz oscillator must be stable (32K_OK).
- The flexible power sequencer (FPS_RSO) must be satisfied.
- Reset timer has expired (t_{RST_O}).

An example configuration that allows nRST_IO to go high-impedance is:

- No global shutdown events.
- The main-battery voltage is within the valid region.
- The 32kHz clock is stable.
- FPS0 (flexible power sequencer 0) has gotten past power-up cycle 4 (FPS_RSO).
- t_{RST_O} expired.
- No external device such as a reset button are pulling nRST_IO low.

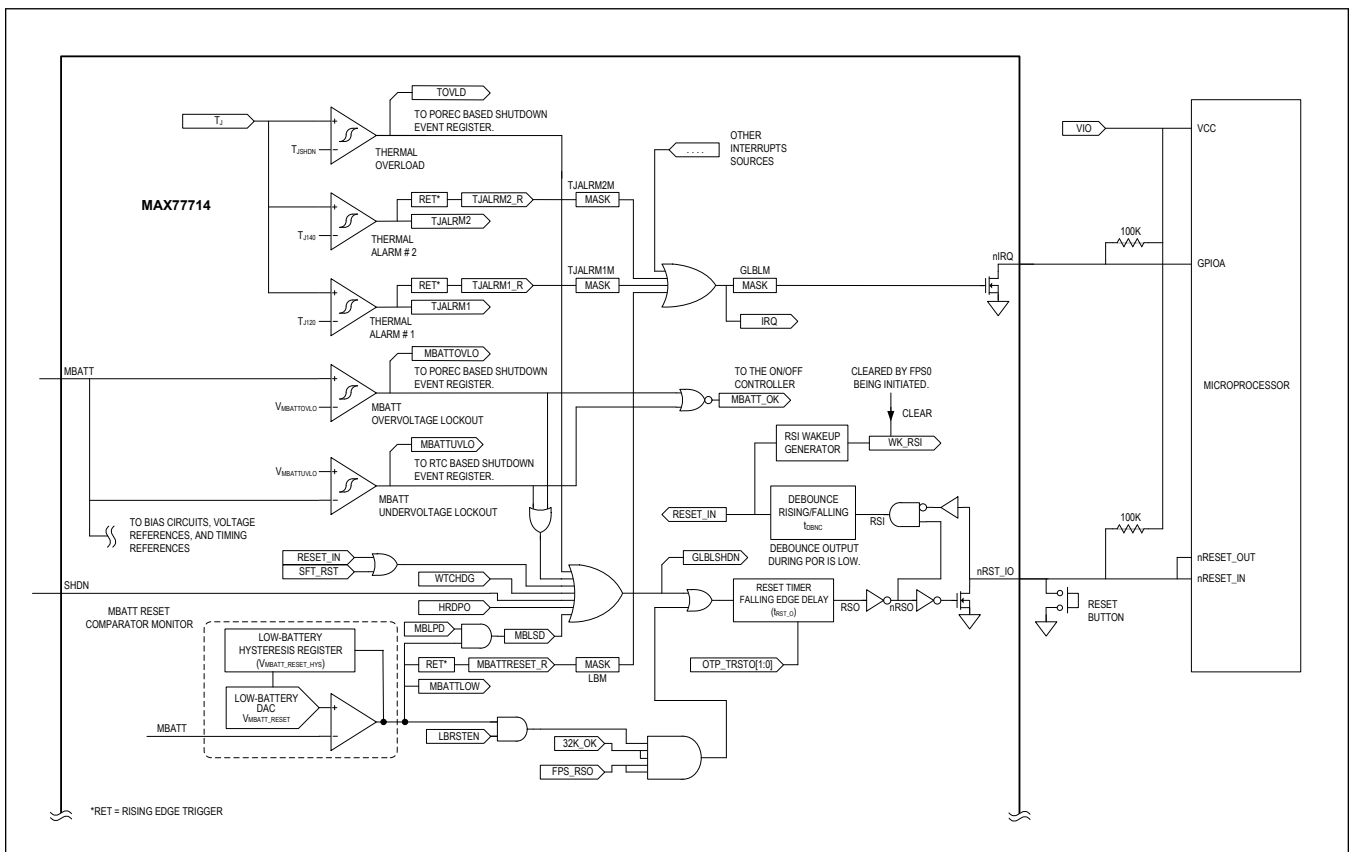


Figure 1. Global Resource Logic

Global Shutdown

This document uses the term “global shutdown” to refer to any event that causes a shutdown of all regulators and a reset for most of the registers within the device. The POERC register records the source of a “global shutdown” event. The various conditions which cause a global shutdown are as follows:

- The battery voltage is low ($MBATT < MBATT_RESET$ falling)
- Hardware reset input (RSI) event detected
- Manual Reset event detected
- Watchdog timer expires
- $SFT_RST = 1$
- $PWR_OFF = 1$
- The junction temperature is too high ($T_J > T_{JSHDN}$)
- SHDN pin is asserted ($SHDN = 1$)
- $SRCFPS0 = 1$ and ENFPS0 register transitions from HIGH to LOW

After a global shutdown occurs, the device can be powered up normally as long as the main-battery voltage and the die temperature are within their valid ranges. Although all regulators are forced off in response to a global shutdown, the RTC remains powered and continues to record the calendar.

From any state in the device, there are three ways of implementing a “global shutdown”. The source of the global shutdown event determines how a global shutdown is implemented as described in the following:

Global Shutdown Events with Sequenced Shutdown and Automatic Wakeup

The events in this category are associated with faulty system states where the software may not be working properly but the system could potentially recover by powering down the microprocessor, resetting all the global shutdown registers, and then powering up the microprocessor again. The following events initiate a sequenced shutdown followed by automatic wakeup:

- RSI event (hardware reset input)
- SFT_RST event if $SFT_RST_WK = 1$ (software reset input)
- Watchdog timer expires if $WD_RST_WK = 1$
- Manual reset event if $OTP_MR = 1$

Global Shutdown Events with Sequenced Shutdown to the OFF State

Six events initiate “sequenced global shutdown to the off state.” With the exception of PWR_OFF, which is a normal system function, the events in this category are associated with undesirable system states that may occur in a normally functioning product. Powering down the microprocessor and resetting all the global shutdown registers helps the system resolve these undesirable events. In general, a wakeup event such as an onkey press is required to power-up the microprocessor again.

In the case of a software reset input (SFT_RST) with $SFT_RST_WK = 0$, the global shutdown state machine results in the default state with the device off and waiting for a wakeup event. It is possible for the system software to program a wakeup event based on an RTC alarm. For example, once the state machine lands in the default state it waits there until the RTC alarm generates the wakeup event.

The following six conditions fall into this category:

- Watchdog timer expires if $WD_RST_WK = 0$
- Manual reset event if $OTP_MR = 0$
- SFT_RST event if $SFT_RST_WK = 0$ (software reset input)
- $PWR_OFF = 1$
- $T_J > T_{JSHDN}$ (thermal overload)
- SHDN input event

Global Shutdown Events with Immediate Shutdown

Four events initiate an “immediate shutdown.” The events in this category are associated with potentially hazardous system events. Powering down the microprocessor and resetting all the registers helps mitigate any issues that may

occur due to these potentially hazardous system events.

The following four events fall in this category:

- $V_{MBATT} < V_{MBATTUVLO}$ (main-battery undervoltage)
- $V_{MBATT} > V_{MBATTOVLO}$ (main-battery overvoltage)
- $OK32K = 0$ (in or after standby state)
- $BRDY = 0$ (in or after ready state)

System Watchdog Timer

The MAX77714 contains a system watchdog timer to ensure safe and reliable operation. The system watchdog timer prevents the device from powering a system in the event that the system controller (processor) hangs or otherwise isn't communicating correctly. The default state of the system watchdog timer enable bit (WDTEN) can be factory programmed with an OTP bit (OTP_WDTEN). To use the watchdog timer feature, enable the feature by setting WDTEN. While enabled, the system controller must reset the system watchdog timer within the timer period (t_{WD}) for the charger to operate normally. Reset the system watchdog timer by programming $WDTC[1:0] = 0b01$. t_{WD} is programmable from 2s to 128s with $TWD[1:0]$.

With WDTEN set, an internal counter is incremented with the internal oscillator. When the internal counter matches a value programmed by $TWD[1:0]$, the device asserts $nRST_IO$, powers down all of its regulators with a global shutdown condition, and sets the WDT bit in the non-volatile event recorder.

To prevent the system watchdog timer from initiating a global shutdown event and disabling the device, a properly operating processor clears the system watchdog timer within the timer period programmed by $TWD[1:0]$. The system watchdog time is cleared by setting $WDTC[1:0] = 0b01$.

The system watchdog timer can be set to automatically clear when the AP enters its sleep or off states. The device interprets the AP sleep state as FPS1 being disabled. The device interprets the off state as FPS1 being disabled.

Note that the device contains both a system watchdog timer and an I²C watchdog timer.

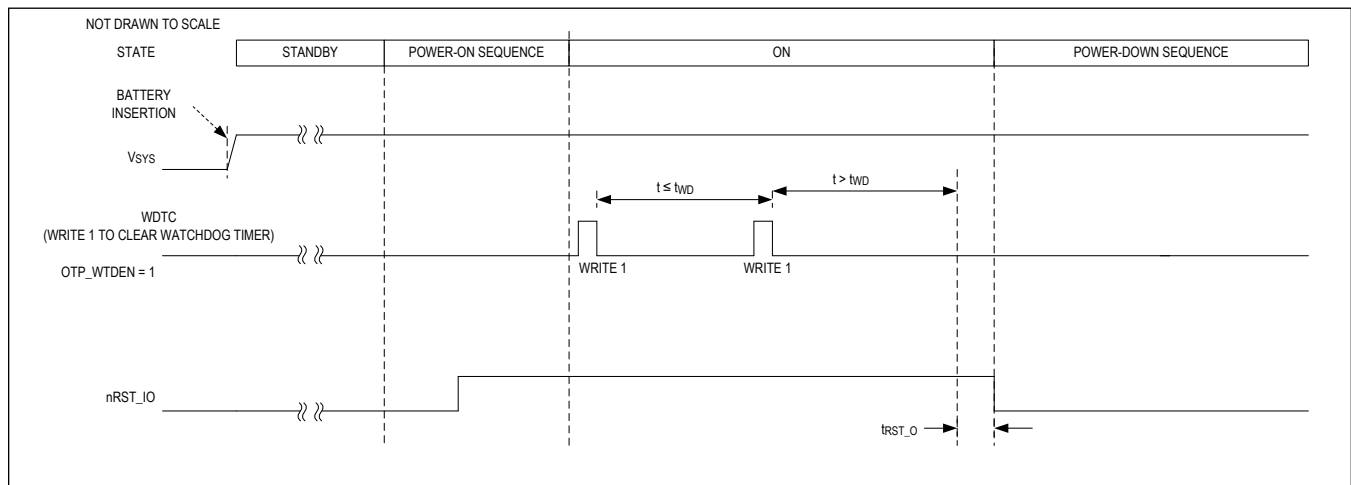


Figure 2. System Watchdog Timer

EN0 Functionality

The EN digital input can be configured to work with a push-button switch, a slide-switch, or a ON/OFF logic signal (e.g., PGOOD). (Figure 3) shows EN's functionality for power-on sequencing and manual reset. Applications that use a slide-switch on-key or ON/OFF logic signal configuration must set OTP_EN0[1:0]. The polarity of EN0 can be controlled using the OTP_EN0AL bit.

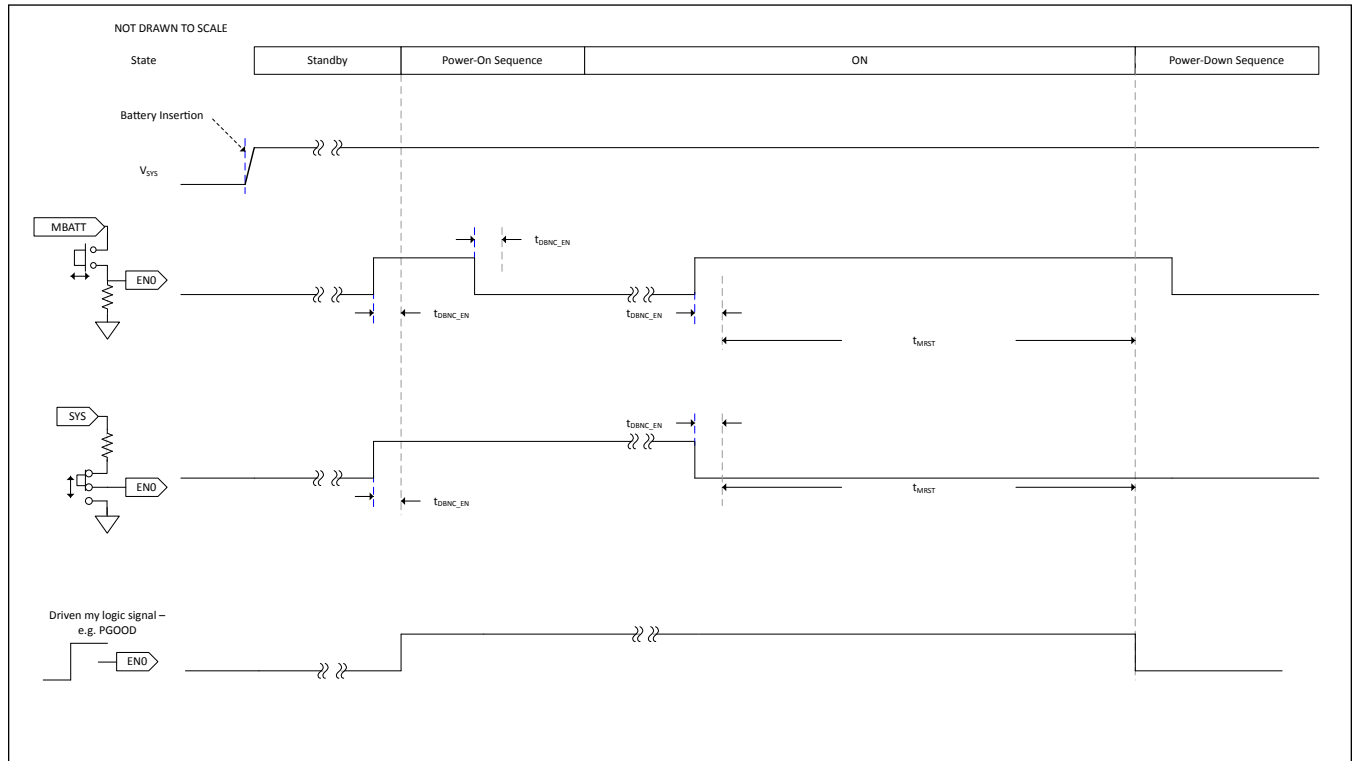


Figure 3. EN0 Functionality Options

Interrupt Logic

Several interrupt and interrupt mask registers monitor key information and assert the nIRQ output signal when an interrupt event has occurred. nIRQ is an active-low, open-drain output that is typically routed to the processor's interrupt input to allow for quick notification of interrupt events. A pullup resistor is required for this signal. This pullup resistor is typically found inside the processor that interprets the interrupt signal, but a board-mounted pullup resistor is required if one is unavailable.

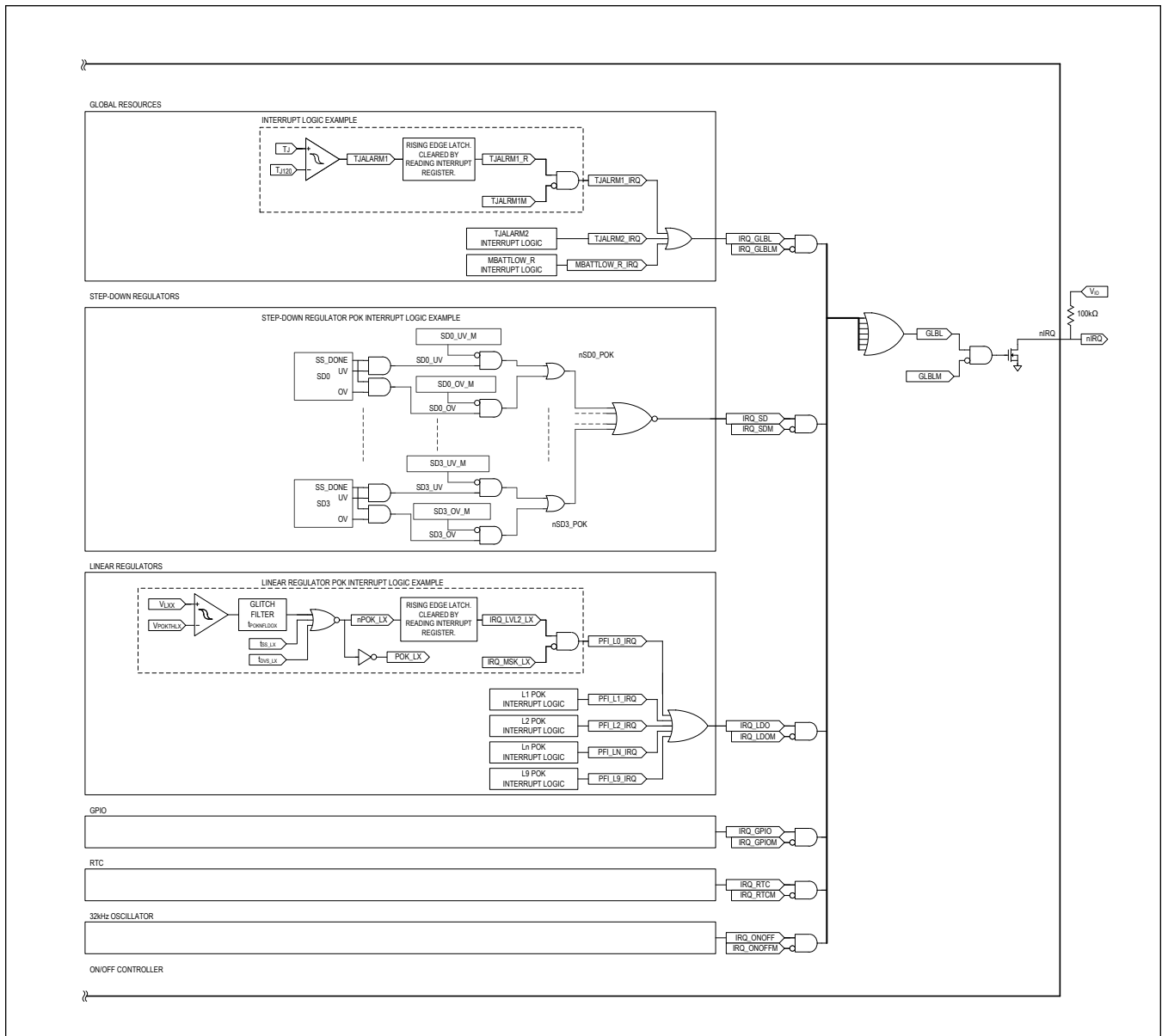


Figure 4. Simplified Interrupt Status and Mask Logic

Detailed Description—ON/OFF Controller

ON/OFF Controller

The ON/OFF controller monitors multiple wakeup sources to intelligently enable all resources that are necessary for the AP to boot (i.e., FPS0 and FPS1). The ON/OFF controller monitors wakeup events on the EN0, EN1, ACOK, and nRST_IO hardware inputs. Additionally, internal wakeup events are also monitored: SMPL, ALARM1, and ALARM2 internal signals. Wakeup events go through logic to affect flexible power sequencers 0 and 1 (FPS0, FPS1). Many wakeup signals can be masked (WK_ACOK, WK_ALARM1, WL_ALARM2, WK_EN0).

Many signals within the ON/OFF controller generate interrupts and are recorded in the status registers.

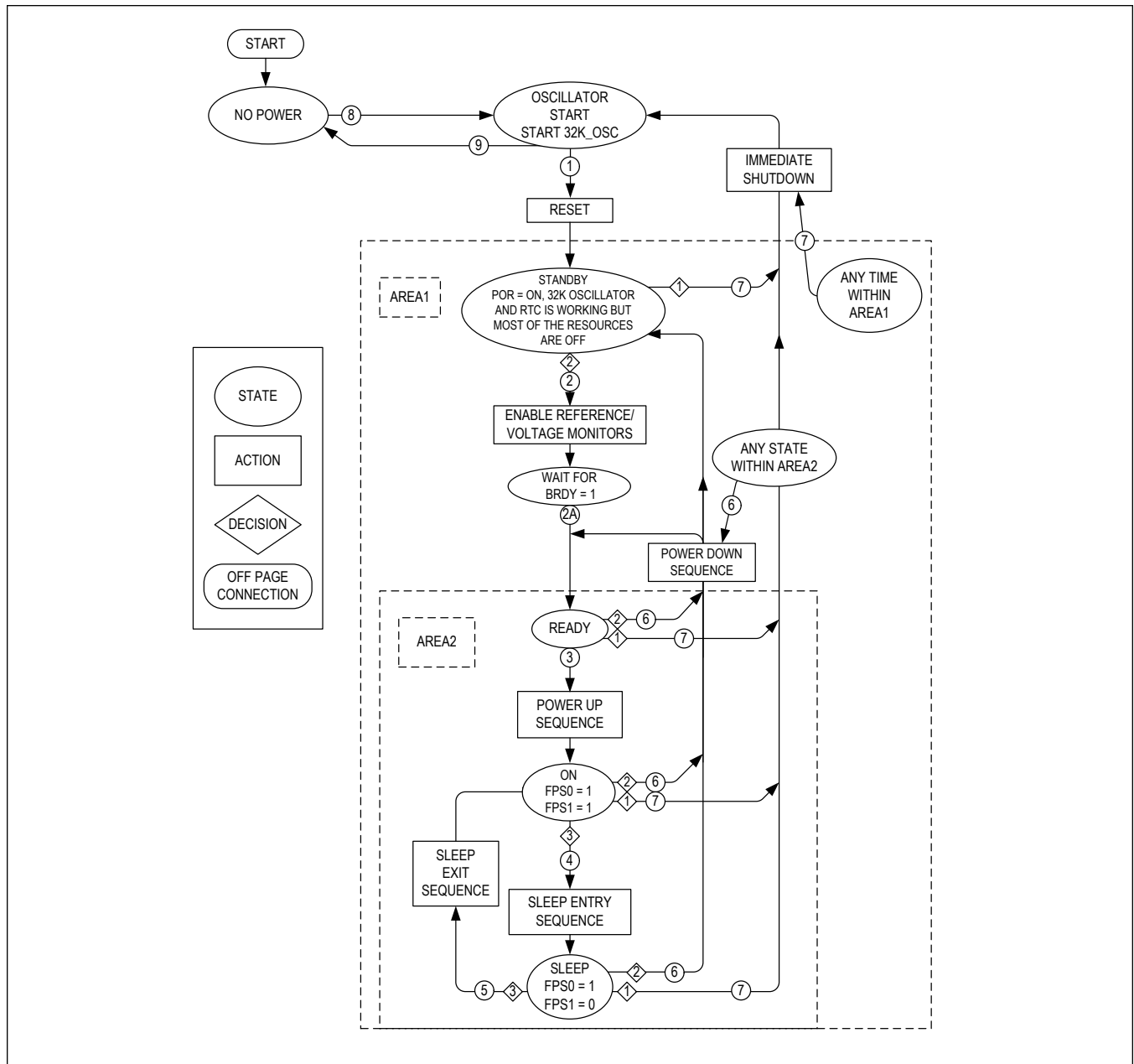


Figure 5. State Diagram: ON/OFF Controller Top Level

Table 2. ON/OFF Controller Transition Conditions

| TRANSITION | CONDITION |
|------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1 | The fundamental system voltages and resources are available. Move to the standby state. <ul style="list-style-type: none"> • 32kHz oscillator is OK (OK32K = 1) OR • The battery voltage is undervoltage ($V_{MBATT} > V_{MBATTUVLO}$) OR • The battery voltage is overvoltage ($V_{MBATT} < V_{MBATTOVLO}$) |

Table 2. ON/OFF Controller Transition Conditions (continued)

| | |
|----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2 | <p>I²C Bias Enable Command OR</p> <p>A wakeup signal has been received from one of the following sources:</p> <ul style="list-style-type: none"> • A debounced EN0 press (i.e., edge) and WK_EN0 is SET has been detected OR • ALARM1_R event occurs and WK_ALRM1R is set OR • ALARM2_R event occurs and WK_ALRM2R is set OR • SMPL_EVENT occurs and SMPL_EN is set OR • ACOK event (i.e., level) occurs and WK_ACOK is set OR • MBATT > MBATTUVLO rising and WK_MBATT is set OR • WAKEUP flag is set by the previous sequenced shutdown (starts at STANDBY state post power-down event) • SRCFPS0 = 1 and ENFPS0 register transitions from LOW to HIGH |
| 2A | <p>The basic system resources are okay</p> <ul style="list-style-type: none"> • BRDY = 1 and t_{BRDY_TMR} not expired |
| 3 | <p>If a wakeup signal was initiated at transition "2" then proceed to powerup sequence, else stay in Ready state and wait for wakeup</p> |
| 4 | <p>Enter Sleep Mode</p> <ul style="list-style-type: none"> • Sleep mode is enabled (SLPEN = 1) and EN1 transitions from high to low (OTP_EN1AL = 1) OR • SRCFPS1 = 1 and ENFPS1 register transitions from HIGH to LOW |
| 5 | <p>Exit Sleep Mode</p> <ul style="list-style-type: none"> • Sleep mode is enabled (SLPEN = 1) and EN1 transitions from low to high OR • A debounced EN0 press and WK_EN0 is SET has been detected OR • ALARM1_R event occurs and WK_ALRM1R is set OR • ALARM2_R event occurs and WK_ALRM2R is set OR • ACOK event (i.e. level) occurs and WK_ACOK is set OR • SRCFPS0 = 1 and ENFPS0 register transitions from LOW to HIGH • SRCFPS1 = 1 and ENFPS1 register transitions from LOW to HIGH |
| 6 | <p>Enter the Power-Down Sequence with Register Reset</p> <ul style="list-style-type: none"> • The battery voltage is low (MBATT < MBATT_RESET falling) OR • Hardware reset input (RSI) event detected OR • Manual reset event detected OR • SFT_RST = 1 OR • PWR_OFF = 1 OR • The junction temperature is too high (T_J > T_{JSHDN}) OR • SHDN pin is asserted (SHDN = 1) • SRCFPS0 = 1 and ENFPS0 register transitions from HIGH to LOW |
| 7 | <p>Immediate Shutdown</p> <ul style="list-style-type: none"> • The battery voltage is undervoltage (V_{MBATT} < V_{MBATTUVLO}) OR • The battery voltage is overvoltage (V_{MBATT} > V_{MBATTOVLO}) OR • OK32K = 0 OR • BRDY = 0 t_{BRDY_TMR} expired |
| 8 | <p>Oscillator Start</p> <ul style="list-style-type: none"> • V_{MBATT} > V_{MBATTPOR} |
| 9 | <p>No Power</p> <ul style="list-style-type: none"> • V_{MBATT} < V_{MBATTPOR} |

Power-Up/Down Sequence

The device integrated a flexible power sequencer (FPS) that controls the power-up and power-down timing of the system. The functionality of the FPS is described as follows:

- The power-up/down sequence consists of two FPS masters (FPS0 and FPS1) each contains 8 slots.
- The 8 slots count sequentially in time during both power-up and power-down.
- During the power-up sequence ([Figure 6](#)), the slots count upwards from 0 to 7.
- During the power-down sequence ([Figure 7](#)), the slots count downwards from 7 to 0.
- The events in this category are associated with faulty system states where the software may not be working properly but the system could potentially recover by powering down the microprocessor, resetting all the global shutdown registers, and then powering up the microprocessor again.
- Regulators enable in their assigned slots in the power-up sequence. Regulators disabled in their assigned slots in the power-down sequence.
- GPIOs assert logic-high in their assigned slot in the power-up sequence. GPIOs assert logic-low in their assigned slot in the power-down sequence.
- Three dedicated bits are available to program the slot pitch (t_{FPST} , time between slots) and are programmable between $31\mu\text{s}$ to $3904\mu\text{s}$ in eight binary weighted steps.
- FPS0 power-up sequence (MSTR_PU[2:0]), power-down sequence (MSTR_PD[2:0]).
- FPS1 sleep exit power-up sequence (MSTR_SLPEXT[2:0]), Sleep entry power-down sequence (MSTR_SLPENTY[2:0]).

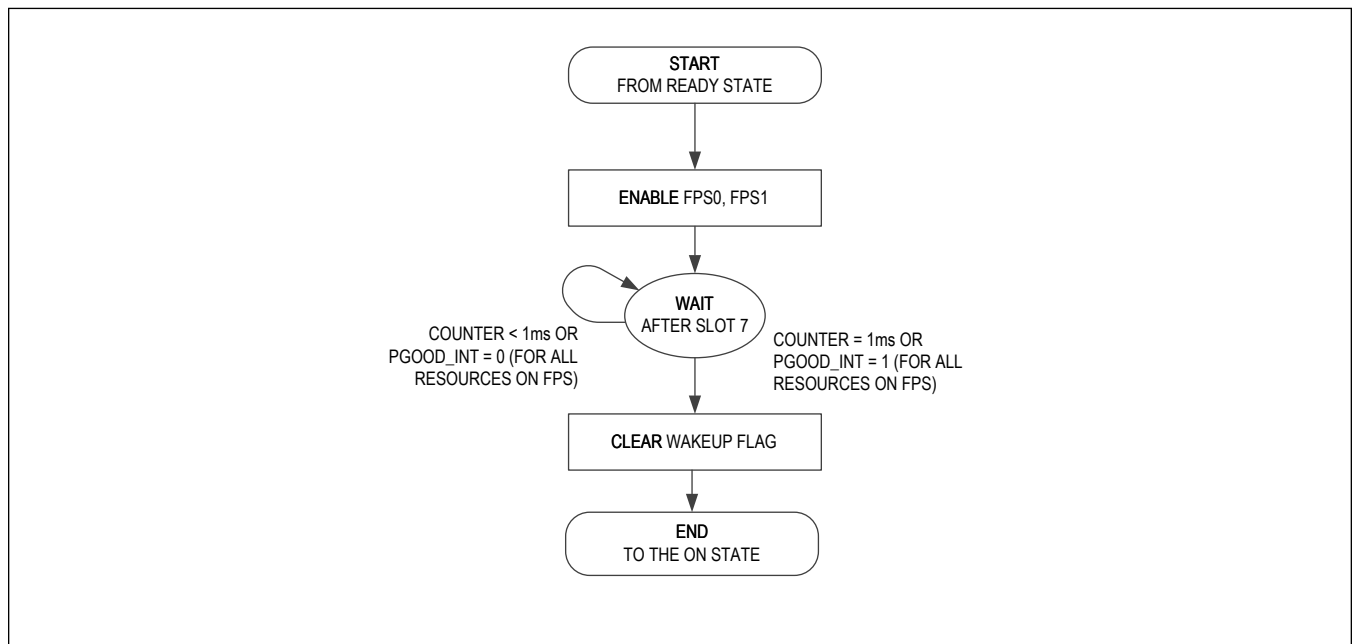


Figure 6. Flow Chart—Power-Up Sequence

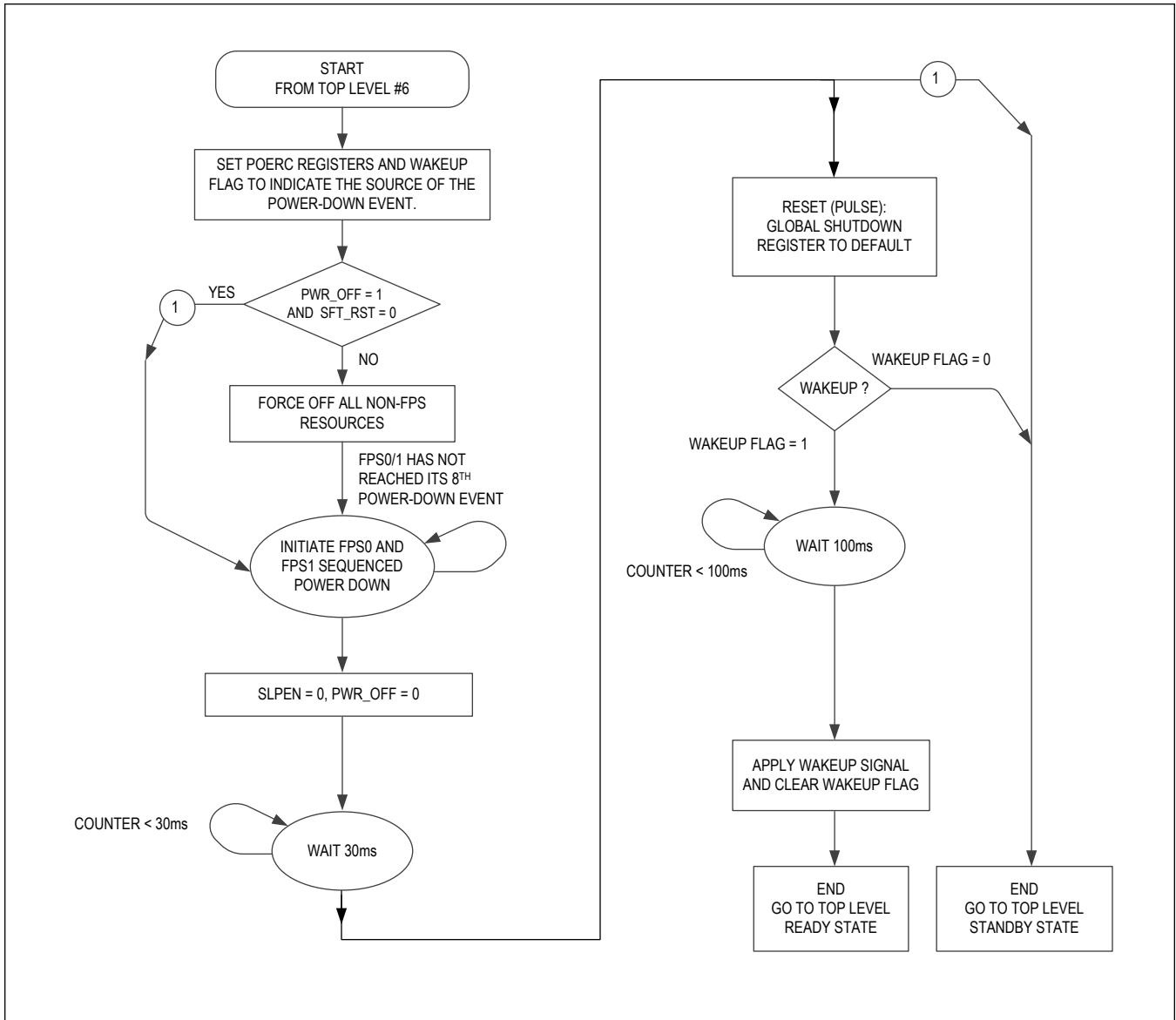


Figure 7. Flow Chart—Power-Down Sequence

Immediate Shutdown

The events in this category are associated with potentially hazardous system events. Powering down the microprocessor and resetting all the device registers helps mitigate any issues that may occur due to these potentially hazardous system events.

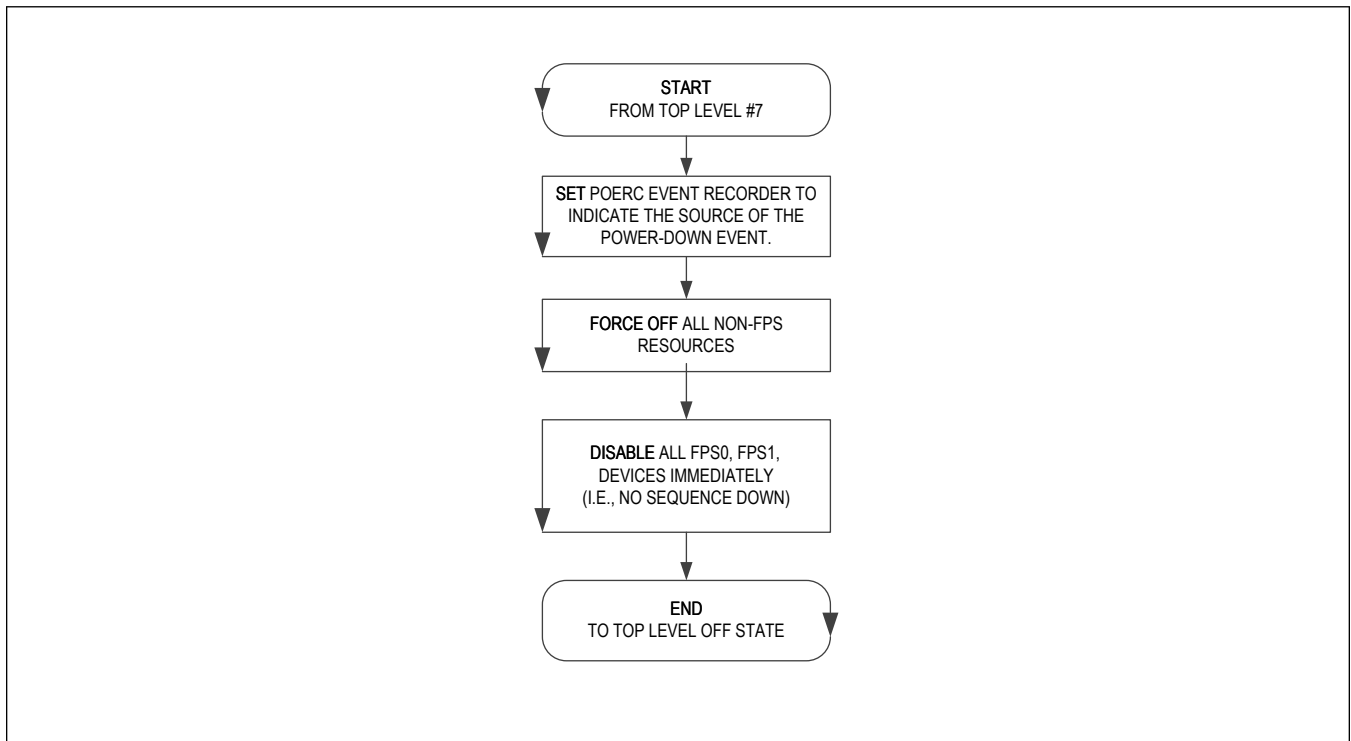


Figure 8. Flow Diagram: Immediate Shutdown

RESET

The reset state puts the PMIC in an initial known state by following the flow in (Figure 9).

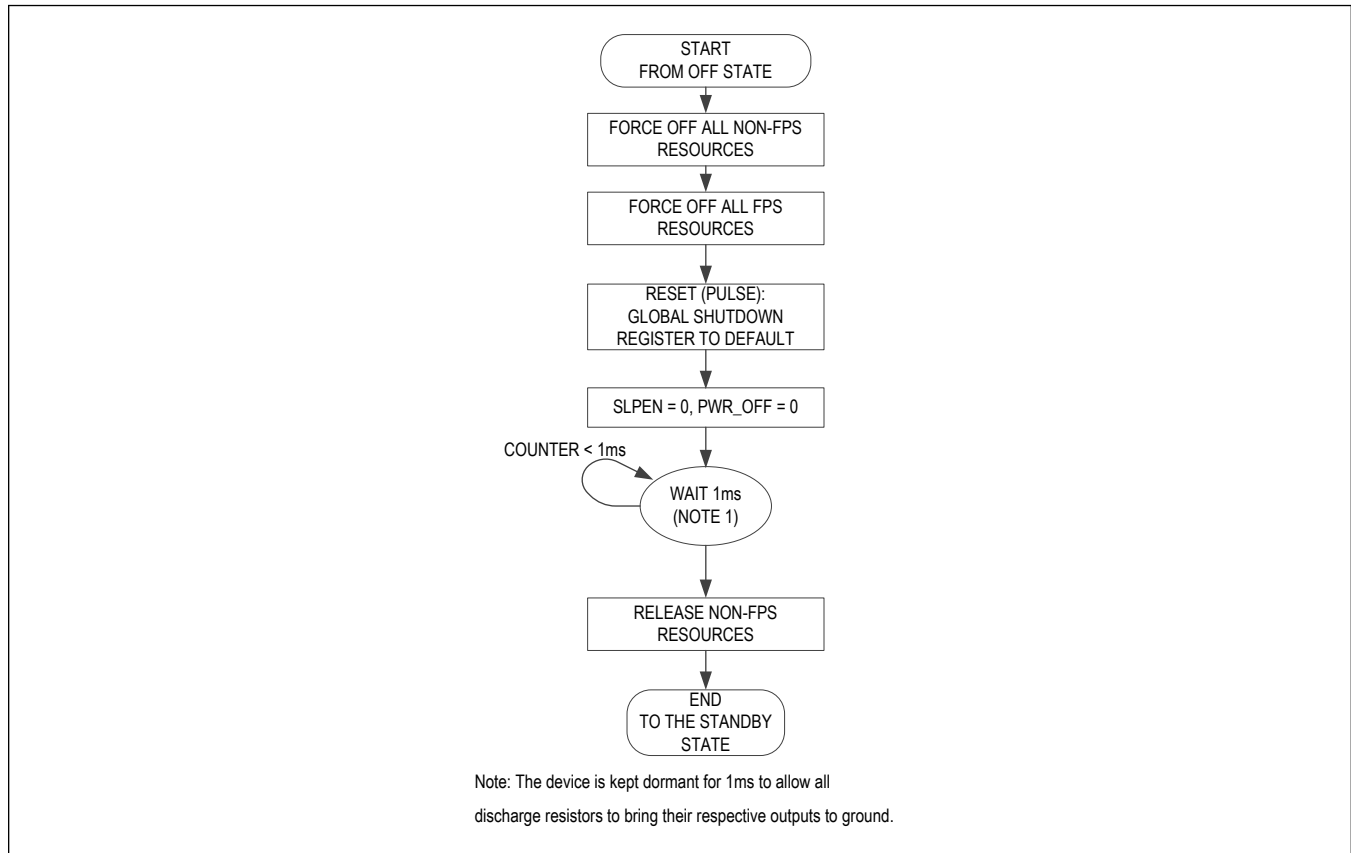


Figure 9. Reset Flow Diagram

EN0

EN0 is a digital input to the ON/OFF controller that typically comes from the system's on-key. EN0 is factory-programmable with OTP (OTP_EN0[1:0]) to either be push-button mode, slide switch mode, or On/Off software mode. The EN0 polarity is factory-programmable with OTP (OTP_EN0AL) to be active-high or active-low.

EN1

EN1 is a digital input to the ON/OFF controller that typically comes from the system's AP. EN1 is used to control sleep modes. The EN1 polarity is factory-programmable with OTP (OTP_EN1AL) to be active-high or active-low.

ACOK

ACOK is a digital input (GPIO3 ALT mode) to the ON/OFF controller that typically comes from the system's battery charger. ACOK indicates the presence/absence of the external charge adapter. The ACOK polarity is factory-programmable with OTP (OTP_ACOKAL) to be active-high or active-low with the appropriate internal pull-up/down.

SHDN

The shutdown input (SHDN) is a digital input to the ON/OFF controller that causes the device to reset through a global shutdown event. The signal for SHDN typically comes from a temperatures sensor such as the MAX6642 that measures the internal die temperature of the AP. The SHDN polarity is factory-programmable with OTP (OTP_SHDNAL) to be active high or active low with the appropriate internal pull-up/down. A system shutdown based on SHDN is recorded in the non-volatile power-off event recorder.

SMPL, ALARM1, and ALARM2

SMPL, ALARM1, and ALARM2 are signal generated from the RTC and used by the ON/OFF controller. See the [RTC](#) section for more information on these signals.

MBATT_OK and MBATTLOW

MBATT_OK and MBATTLOW are digital signals that come from the systems' main-battery monitor. MBATT_OK gates several wakeup sources so that they cannot enable FPS0 and FPS1 until the battery is above the system undervoltage-lockout threshold ($V_{MBATTUVLO}$). MBATTLOW prevents FPS0 and FPS1 from being enabled when the main-battery is below a programmed minimum voltage.

Resource Power Mode**Table 3. LDO and Step-Down Resource Power Mode**

| # | REGISTER BIT | INTERNAL SIGNAL | REGISTER BIT | REGISTER BIT | REGISTER BIT | ON/OFF | POWER MODE |
|----|---------------------------------------------|--------------------------------|---------------------------------------|---------------------------------------|--------------|--------|------------|
| # | FPSSRC_Lx = 0b11 or FPSSRC_SDx = 0b11 | FPS_EN_SDx or FPS_EN_LDO | PWR_MD_SDx[1] or PWR_MD_LDOx[1] | PWR_MD_SDx[0] or PWR_MD_LDOx[0] | GLBL_LPM | | |
| 1 | Y | x | 0 | 0 | x | OFF | OFF |
| 2 | Y | x | 0 | 1 | 1 | ON | Low power |
| 3 | Y | x | 0 | 1 | 0 | ON | Normal |
| 4 | Y | x | 1 | 0 | x | ON | Low power |
| 5 | Y | x | 1 | 1 | x | ON | Normal |
| 6 | N | 1 | 0 | 0 | x | OFF | OFF |
| 7 | N | 1 | 0 | 1 | 1 | ON | Low power |
| 8 | N | 1 | 0 | 1 | 0 | ON | Normal |
| 9 | N | 1 | 1 | 0 | x | ON | Low power |
| 10 | N | 1 | 1 | 1 | x | ON | Normal |
| 11 | N | 0 | x | x | x | OFF | OFF |

Table 4. 32k Resource Power Mode

| # | REGISTER BIT | REGISTER BIT | REGISTER BIT | ON/OFF | POWER MODE |
|---|---------------|---------------|--------------|--------|------------|
| # | PWR_MD_32K[1] | PWR_MD_32K[0] | GLBL_LPM | | |

Table 4. 32k Resource Power Mode (continued)

| | | | | | |
|---|---|---|---|-----|----------------------------------|
| 1 | 0 | 0 | x | OFF | OFF |
| 2 | 0 | 1 | 1 | ON | Low-power mode |
| 3 | 0 | 1 | 0 | ON | Low-jitter mode (Normal mode) |
| 4 | 1 | 0 | x | ON | Low-power mode |
| 5 | 1 | 1 | x | ON | Low-jitter mode (Normal mode) |

Detailed Description—Flexible Power Supply (FPS)

Power-Off Event Recorder

Several events within a MAX77714 based system can autonomously cause a power-off (i.e., global shutdown). The source of the power-down event is recorded in a register so that when the system's microprocessor powers on again it can determine the source of the previous power-off condition. This power-off event recorder register is non-volatile as long as the RTC's coin cell (BBATT) remains within its valid voltage range. Unlike most interrupt registers, the POERC register does not have a corresponding interrupt mask and status register. Additionally, it does not affect the nIRQ pin. No status register is provided since all POERC events result in a global shutdown which would subsequently reset any related status. Once a bit is set, the controller has to write a 1 to clear it.

Flexible Power Sequencer (FPS)

The FPS allows each regulator to power-up under hardware or software control. Additionally, each regulator can power on independently or among a group of other regulators with an adjustable power-up and power-down delays (sequencing). GPIO0, GPIO1, GPIO2, and GPIO7 can be programmed to be part of a sequence allowing external regulators to be sequenced along with internal regulators. nRST_IO can be programmed to be part of a sequence.

(Figure 10) shows LDO0, LDO1, LDO2, and LDO3 powering up under the control of flexible power sequencer 2.

The time period between each sequencer event for power-up, power-down, sleep entry, and sleep exit can be configured by setting MSTR_PU[2:0], MSTR_PD[2:0], MSTR_SLPENTRY[2:0], and MSTR_SLPEXT[2:0] respectively.

The flexible sequencing structure consists of two hardware enable inputs (EN0, EN1), and three master sequencing timers. Each master-sequencing timer is programmable through its configuration register to have a hardware enabled source or a software enabled source (CNFG_GLBLx). When enabled/disabled the master-sequencing timer generates eight sequencing events. The time period between each event is programmable within the configuration register.

Each regulator, GPIO0, GPIO1, GPIO2, GPIO7 and nRST_IO has a flexible-power-sequence slave register (FPS_x) which allows its enable source to be specified as a flexible-power-sequence timer or a software bit. When a FPSSRCx specifies the enable source to be a flexible power sequencer, the power-up and power-down delays are configured by MSTR_PU[2:0] and MSTR_PD[2:0] and can be specified in that regulator's flexible-power-sequencer configuration register.

If any of the FPS hardware inputs (EN0, EN1) are not needed, connect them to ground. Grounding these inputs when they are not needed ensures that they do not accidentally turn on any voltage regulators—furthermore it improves the thermal impedance of the MAX77714 package.

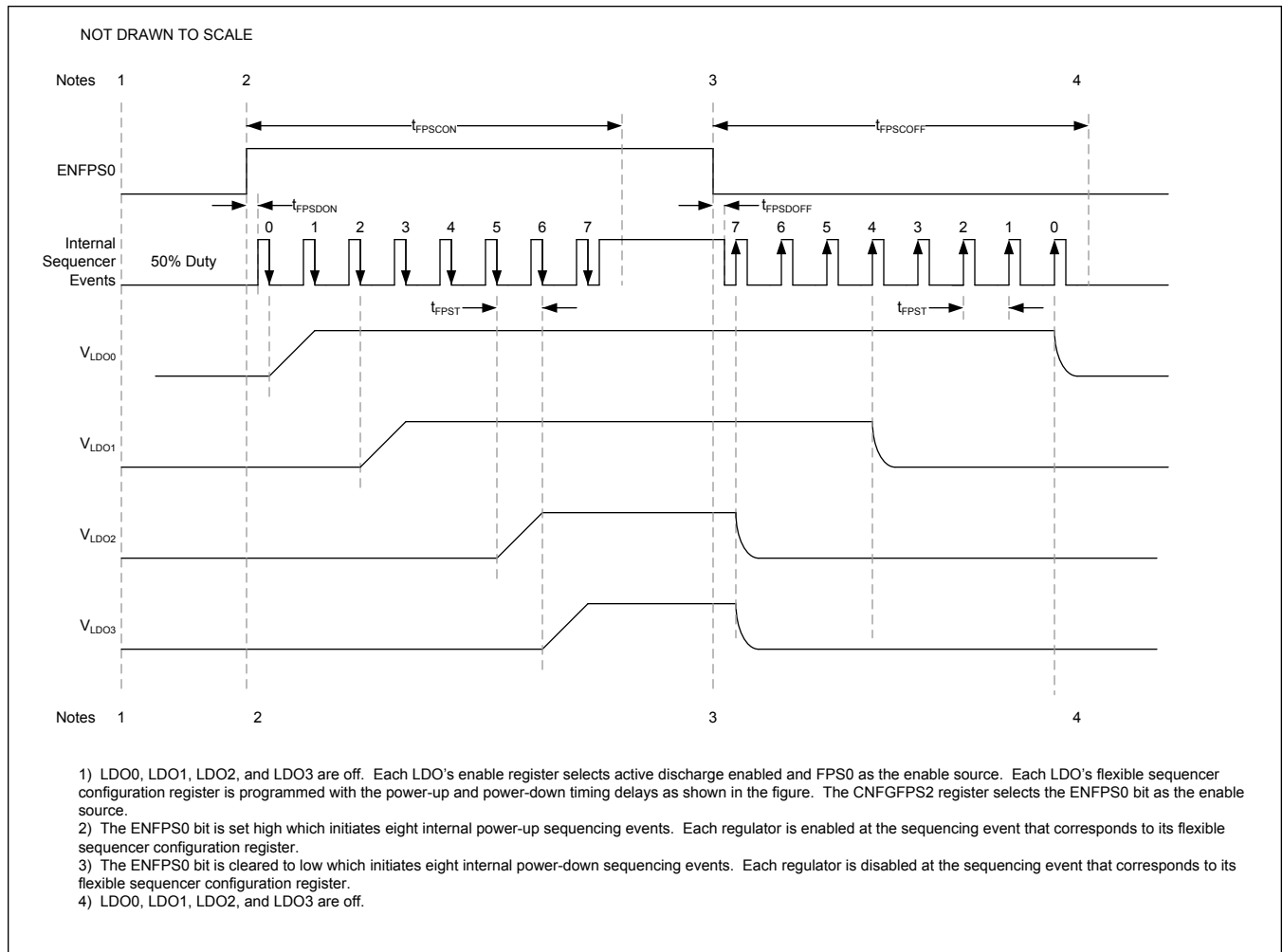


Figure 10. Flexible Power Sequencer

Features

- Two Sequencers
- Power-Up/Down Sequencing Control
- Eight Power-Up Sequence Time Slots
- Eight Power-Down Sequence Time Slots
- Adjustable Time Period Between Time Slots from 31µs to 3,904µs in Eight Binary Weighted Steps
- Sequence Enable/Disable can be Controlled by Hardware and Software
- Capable of Controlling:
 - All Regulators
 - GPIO0, GPIO1, GPIO2, and GPIO7
 - nRST_IO

FPS0

Flexible Power Sequencer 0 is the enable signal for the resources that need to be enabled when the AP is in its normal operating mode and its sleep mode. When the AP is in normal operating mode, both FPS0 and FPS1 are enabled.

FPS1

Flexible Power Sequencer 1 is the enable signal for the resources that need to be enabled when the AP is in its normal operating mode and disabled when the AP is in sleep mode. When the AP is in normal operating mode, both FPS0 and FPS1 are enabled.

FPS Sequence Power-Up/Down

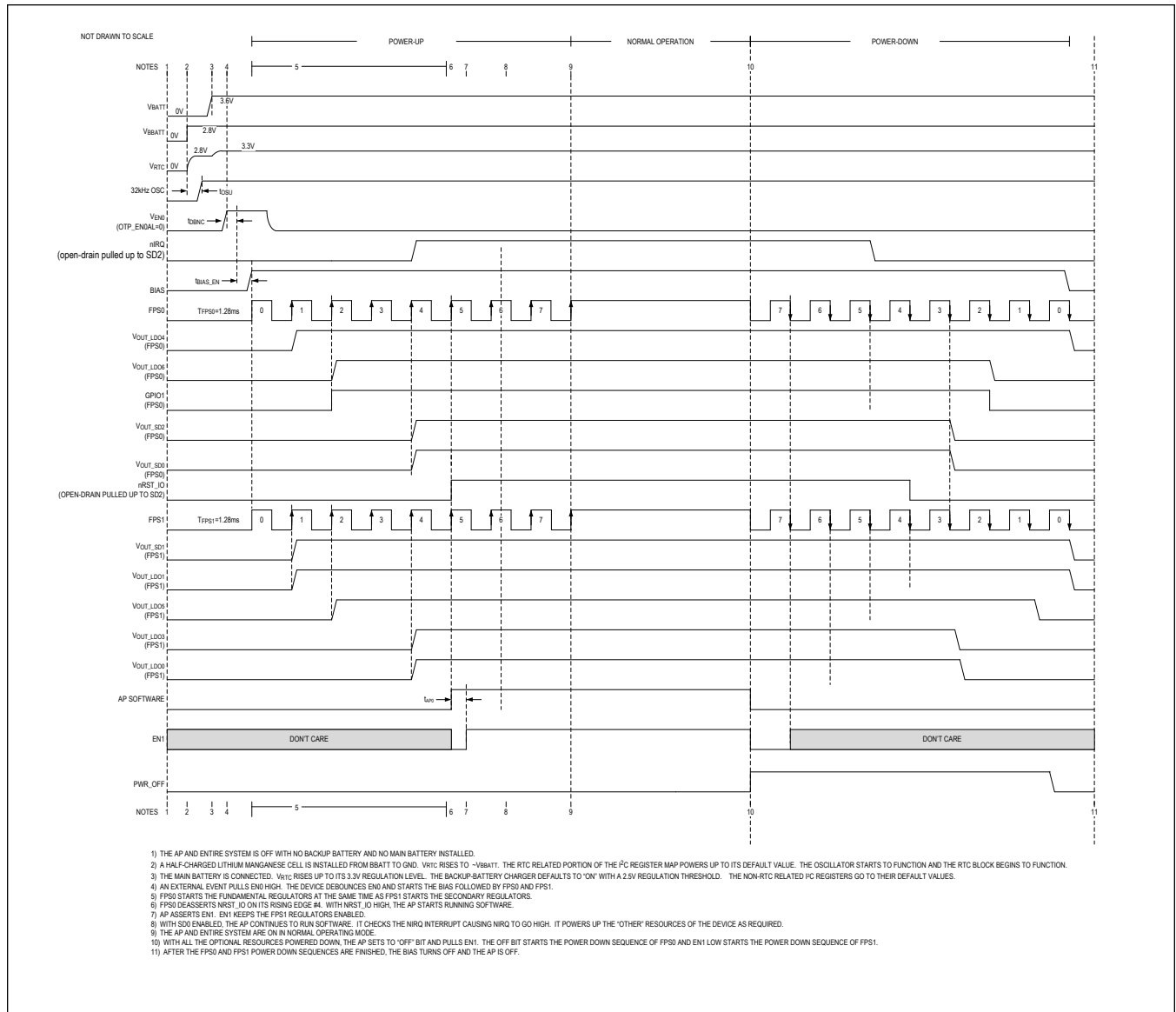


Figure 11. FPS Sequence Power-Up/Down

FPS Sequence Sleep Entry/Exit

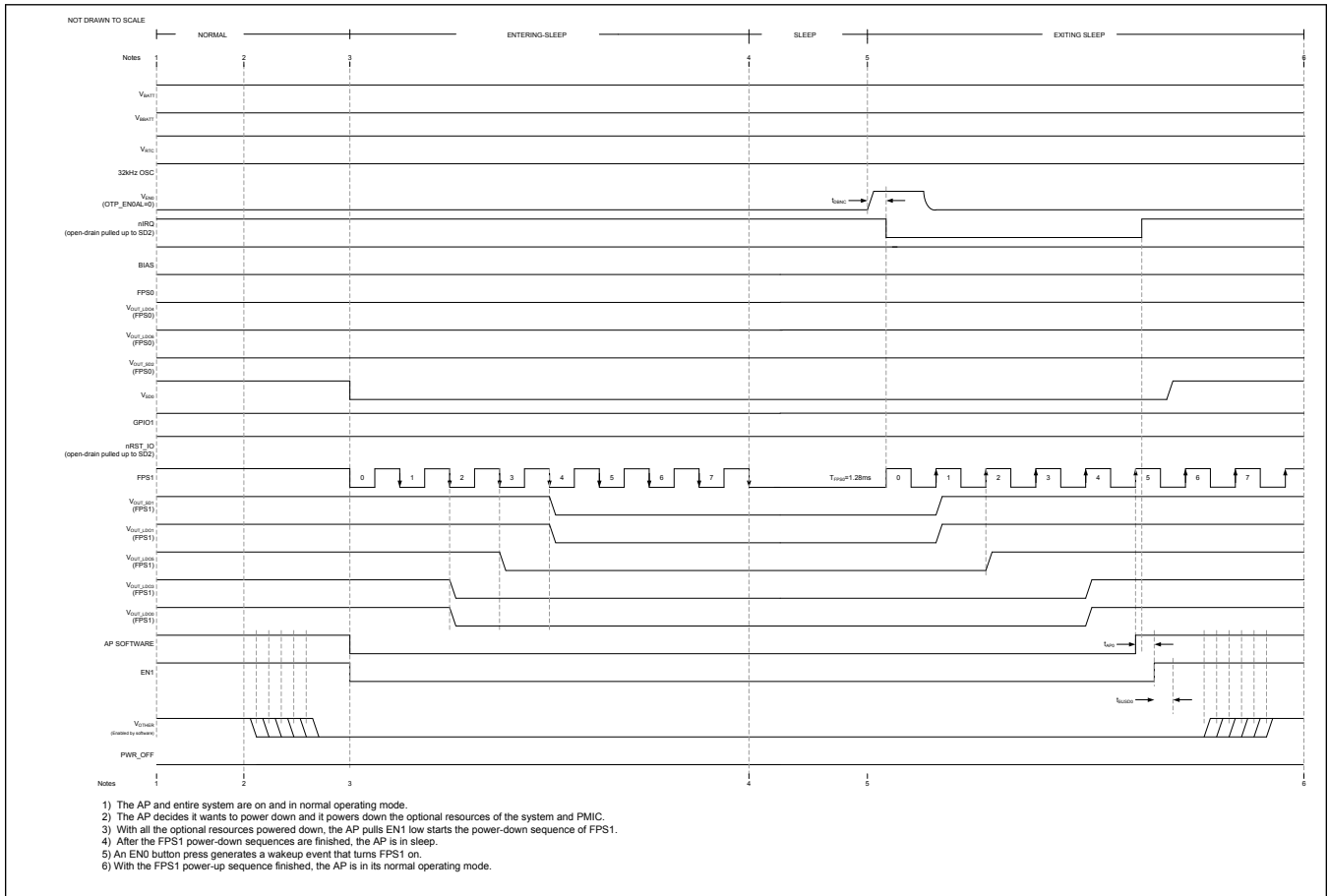


Figure 12. FPS Sleep Entry/Exit

Detailed Description—Step-Down Regulators (SD0–4A Output)

SD0 is a step-down converter with the following features:

- Programmable output voltage from 0.26V to 1.52V in 10mV steps.
- ±2% Initial output accuracy.
- Capable of 4A continuous output current.
- Capable of powering up into a prebiased output.
- Automatic transition from pulse-skipping mode to fixed-frequency mode to provide high efficiency across load range.
- Programmable low-power-mode (LPM) to enable efficient low-power PMIC states.
- Programmable soft-start to minimize inrush current.
- Inductor current limits to limit power output to a short circuit or overload.
- Capable of active discharge.
- Programmable brownout and over-voltage comparators.

Active Discharge

- When the active discharge feature is enabled (SD0ADDIS = 0) and the step-down is disabled (either through I²C or by the sequencer), there is a 100Ω active discharge resistance that is enabled from the output to ground.

Output Monitoring

SD0 has multiple ways of ensuring the health of its output.

- There is a programmable brownout monitor that sets an interrupt flag (SD0_UV_I) when the output voltage falls below the programmed brownout threshold.
 - If the SD0_UV_M mask bit is unmasked, this allows the brownout on the output of the step-down to initiate a power-down sequence.
 - When the step-down is first enabled, either through I²C or by the sequencer, the brownout condition is not asserted until the soft-start is complete. However, if the output capacitance is large enough, the soft-start process completes before the output reaches the rising UV threshold and thereby the UV interrupt would get set, although the output would eventually rise above the UV threshold.
 - However, when the output voltage target is increased through I²C (write to SD0VOUT[6:0]) and the step-down converter is in the process of performing the controlled ramp to the new target, a brownout condition is not triggered until the controlled ramp is complete.
- There is a programmable overvoltage monitor that sets an interrupt flag (SD0_OV_I) when the output voltage rises above the programmed overvoltage threshold.
 - If the SD0_OV_M mask bit is unmasked, this allows the overvoltage on the output of the step-down to initiate a power-down sequence and assert the nIRQ output.
 - However, when the output voltage target is decreased through I²C (write to SD0VOUT[6:0]) and the step-down converter is in the process of performing the controlled ramp to the new target (if SD0FSREN = 1), an overvoltage condition is not triggered until the controlled ramp is complete. Note that if the controlled ramp for decreasing output voltage target is disabled (SD0FSREN = 0), then the over-voltage condition triggers and causes a power down sequence if unmasked (SD0_OV_M = 0). If this situation is expected, it is recommended to mask it by setting SD0_OV_M to 1.
 - When the step-down is first enabled, either through I²C or by the sequencer, it is possible that the combination of the programmed soft-start ramp rate (SD0SSRAMP) and the output capacitance is such that it can cause the inductor current to reach the PMOS peak current limit.
 - Similarly, when the output voltage target is increased (by a write to SD0VOUT[6:0]) and the slew rate for dynamic voltage scaling is high enough (SD0SSRAMP), it can cause the inductor current to reach the PMOS peak current limit.
- All of the above conditions have associated status bits that provide a real-time status of the condition.

Enable and Power Mode Control

- SD0 can be enabled and disabled either by the flexible power sequencer or by I²C.
- The SD0FPS register configures if it is part of the sequence, and the master and slots numbers that it is assigned to.
- The bits PWR_MD_SD0[1:0] control whether the step-down is in normal-power mode or low-power mode.
 - The step-down can be configured to dynamically transition to low-power mode when the PMIC transitions to the DevSlp state.
 - The step-down can also be forced to transition to low-power mode through an I²C command. See ([Table 3](#)) in the Resource Power Mode section for additional information.

PCB Layout Guidelines

Careful circuit board layout is critical to achieve low-switching power losses and clean, stable operation.

When designing the PCB, follow these guidelines:

1. Place the inductor and output capacitor close to the device and keep the loop area of switching current small.
2. When wiring the high current paths, short and wide traces should be used. For example, the trace between LX and the inductor. The voltage on this node is switching very quickly and additional area creates more radiated emissions.
3. The ground loop for the input and output capacitor should be as small as possible.
4. AGND should be connected to PGND through a via. Connect DGND and AGND together at the return terminal of the output capacitor. Do not connect them anywhere else.
5. Keep the power traces and load connections short and wide. This practice is essential for high-efficiency.
6. The feedback pin should be routed away from the switching node to increase noise immunity. This pin is a high-impedance input which is highly noise sensitive.
7. When possible, ground planes and traces should be used to help shield the feedback signal and minimize noise and magnetic interference.

Detailed Description—Step-Down Regulators (SD1–3A Output)

SD1 is a step-down converter with the following features:

- Programmable output voltage from 0.26V to 1.52V in 10mV steps.
- $\pm 2\%$ Initial output accuracy.
- Capable of 3A continuous output current.
- Capable of powering up into a prebiased output.
- Automatic transition from pulse-skipping mode to fixed-frequency mode to provide high-efficiency across load range.
- Programmable low-power mode (LPM) to enable efficient low-power PMIC states.
- Programmable soft-start to minimize inrush current.
- Inductor current limits to limit power output to a short circuit or overload.
- Capable of active discharge.
- Programmable brownout and over-voltage comparators.

Active Discharge

- When the active discharge feature is enabled ($SD1ADDIS = 0$) and the step-down is disabled (either through I²C or by the sequencer), there is a 100 Ω active discharge resistance that is enabled from the output to ground.

Output Monitoring

SD1 has multiple ways of ensuring the health of its output.

- There is a programmable brownout monitor that sets an interrupt flag ($SD1_UV_I$) when the output voltage falls below the programmed brownout threshold.
 - If the $SD1_UV_M$ mask bit is unmasked, this allows the brownout on the output of the step-down to initiate a power-down sequence.
 - When the step-down is first enabled, either through I²C or by the sequencer, the brownout condition is not asserted until the soft-start is complete. However, if the output capacitance is large enough, the soft-start process completes before the output reaches the rising UV threshold and thereby the UV interrupt would get set, although the output would eventually rise above the UV threshold.
 - However, when the output voltage target is increased through I²C (write to $SD1VOUT[6:0]$) and the step-down converter is in the process of performing the controlled ramp to the new target, a brownout condition is not triggered until the controlled ramp is complete.
- There is a programmable overvoltage monitor that sets an interrupt flag (SD_OV_I) when the output voltage rises above the programmed overvoltage threshold.
 - If the $SD1_OV_M$ mask bit is unmasked, this allows the overvoltage on the output of the step-down to initiate a power-down sequence and assert the $nIRQ$ output.
 - However, when the output voltage target is decreased through I²C (write to $SDVOUT[6:0]$) and the step-down

converter is in the process of performing the controlled ramp to the new target (if SD1FSREN = 1), an overvoltage condition is not triggered until the controlled ramp is complete. Note that if the controlled ramp for decreasing output voltage target is disabled (SD1FSREN = 0), then the over-voltage condition triggers and could cause a power-down sequence if unmasked (SD1_OV_M = 0). If this situation is expected, it is recommended to mask it by setting SD1_OV_M to 1.

- When the step-down is first enabled, either through I²C or by the sequencer, it is possible that the combination of the programmed soft-start ramp rate (SD1SSRAMP) and the output capacitance is such that it can cause the inductor current to reach the PMOS peak current limit.
- Similarly, when the output voltage target is increased (by a write to SD1VOUT[6:0]) and the slew rate for dynamic voltage scaling is high enough (SD1SSRAMP), it can cause the inductor current to reach the PMOS peak current limit.
- All of the above conditions have associated status bits that provide a real-time status of the condition.

Enable and Power Mode Control

- SD1 can be enabled and disabled either by the flexible power sequencer or by I²C.
- The SD1FPS register configures if it is part of the sequence, and the master and slots numbers that it is assigned to.
- The bits PWR_MD_SD1[1:0] control whether the step-down is in normal-power mode or low-power mode.
 - The step-down can be configured to dynamically transition to low-power mode when the PMIC transitions to the DevSlp state.
 - The step-down can also be forced to transition to low-power mode through an I²C command. See [\(Table 3\)](#) in the *Resource Power Mode* section for additional information.

Detailed Description—Step-Down Regulators (SD2/3–2A Output)

SD2 and SD3 are step-down converters with the following features:

- Programmable output voltage from 0.600V to 2.194V in 6.25mV steps for SD2.
- Programmable output voltage from 0.600V to 3.78V in 12.5mV steps for SD3.
- ±2% Initial output accuracy.
- Capable of 2A continuous output current.
- Capable of powering up into a prebiased output.
- Automatic transition from pulse-skipping mode to fixed-frequency mode to provide high-efficiency across load range.
- Programmable low-power mode (LPM) to enable efficient low-power PMIC states.
- Soft-start to minimize inrush current.
- Inductor current limits to limit power output to a short circuit or overload.
- Programmable brownout and over-voltage comparators.

Output Monitoring

SD2 and SD3 have multiple ways of ensuring the health of their output.

- There is a programmable brownout monitor that sets an interrupt flag (SD2_UV_I/SD3_UV_I) when the output voltage falls below the programmed brownout threshold.
 - If the SD2_UV_M/SD3_UV_M mask bit is unmasked, this allows the brownout on the output of the step-down to initiate a power-down sequence.
 - When the step-down is first enabled, either through I²C or by the sequencer, the step-down's control circuit attempts to ramp the output voltage as fast as possible to the target output (programmed by SDVOUT[7:0]/SD3VOUT[7:0]) limited only by the PMOS peak current limit. During this process of output voltage ramp, the brownout output is prevented from being triggered until the end of the soft-start period (determined by the specified ramp-up slew rate). However, if the output capacitance is large enough, the soft-start process completes before the output reaches the rising UV threshold and thereby the UV interrupt would get set, although the output would eventually rise above the UV threshold.
 - When the output voltage for SD2 or SD3 is increased through I²C (programmed by SD2VOUT[7:0]/SD3VOUT[7:0]) after they have been enabled, the step-down control circuit changes the

output voltage target directly to the final value. In such a case, the brownout comparator provides an undervoltage assertion. If the undervoltage assertion is not masked by SD2_UV_M/SD3_UV_M, a power-down sequence occurs. If such a use case is foreseen, it is recommended to set the mask bits first and then change the output voltage. Alternatively, the change in output voltage should be done in small steps. Note that even if the mask bit is set, the corresponding interrupt bit is still set.

- Note that a load transient on the output of the step-down at a fast slew rate and a large magnitude has the capability to cause an output voltage droop that can cause the UV comparator to trip and flag an undervoltage event, if the brownout threshold is set high (such as 90%).
- There is a programmable overvoltage monitor that sets an interrupt flag (SD2_OV_I/SD3_OV_I) when the output voltage rises above the programmed overvoltage threshold.
 - If the SD2_OV_M/SD3_OV_M mask bit is unmasked, this allows the overvoltage on the output of the step-down to initiate a power-down sequence.
 - When the step-down is first enabled, either through I²C or by the sequencer, the step-down control circuit attempts to ramp the output voltage as fast as possible to the target output (programmed by SD2VOUT[7:0]/SD3VOUT[7:0]) limited only by the PMOS peak current limit. During this process of output voltage ramp, the over-voltage output is prevented from being triggered until the end of the soft-start period (determined by the specified ramp-up slew rate).
 - When the output voltage for SD2 or SD3 is increased through I²C (programmed by SD2VOUT[7:0]/SD3VOUT[7:0]) after they have been enabled, the step-down's control circuit changes the output voltage target directly to the final value. The step-down output voltage increases as a function of the output capacitance and load. In such a case, the over-voltage comparator provides an over-voltage assertion. If the overvoltage assertion is not masked by SD1_OV_M/SD1_OV_M, a power-down sequence occurs. If such a use case is foreseen, it is recommended to set the mask bits first and then change the output voltage. Alternatively, the change in output voltage should be done in small steps. Note that even if the mask bit is set, the corresponding interrupt bit is still set.
 - Note that a sudden load release with a high slew rate and magnitude has the potential to cause a momentary over-shoot on the output of the step-down that can trip the OV comparator output. If such use cases are expected, the OV threshold should be set as high as allowed.
- All of the above conditions have associated status bits that provide a real-time status of the condition.

Enable and Power Mode Control

- SD2/3 can be enabled and disabled either by the flexible power sequencer or by I²C.
- The SD2FPS/SD3FPS registers configure if they are part of the sequence, and the master and slots numbers that they are assigned to.
- The bits PWR_MD_SD2[1:0]/PWR_MD_SD3[1:0] control whether the step-down is in normal-power mode or low-power mode.
 - The step-down can be configured to dynamically transition to low-power mode when the PMIC transitions to the DevSlp state.
 - The step-down can also be forced to transition to low-power mode through an I²C command. See ([Table 3](#)) in the *Resource Power Mode* section for additional information.

Active Discharge Resistor

SD2/3 have an active-discharge resistance that can be enabled and disabled with SDxADDIS. Enabling the active discharge feature helps ensure a complete and timely power-down of all system peripherals. The default condition of the active-discharge resistor feature is enabled, such that when the step-down converter is disabled, an internal 100Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When the step-down converter is enabled, the discharge resistor is disconnected from the output.

Soft-Start

The SD2/3 regulators have a soft-start feature to limit the inrush current during startup. The soft-start feature is achieved by limiting the slew rate of the output voltage during startup (dV_{OUT_SDx}/dt).

During soft-start the output voltage for the regulator ramps at a fixed rate of 17mV/μs to its final value. The soft-start

time(μ s) is calculated by $V_{OUT_SDx}/17\text{mV}$.

If $V_{OUT_SDx} = 1.8\text{V}$, the startup time is $105\mu\text{s}$.

Register and Reset Conditions

See the [PMIC Register](#) section for additional information.

Detailed Description—150mA PMOS LDO (LDO2, LDO4, LDO5, LDO6)

The MAX77714 has nine linear regulators (LDOs).

The four NMOS regulators are capless designs that are stable with or without an output decoupling capacitor. Additionally, the PMOS regulators have adjustable compensation that allows for the use of remote output capacitors.

All regulators can be operated in low-power mode, where the no-load quiescent current drops to 1.5mA. In low-power mode, each output supports a maximum load of 5mA.

All regulators have an output voltage power-OK interrupt signal that is integrated into the MAX77714 interrupt architecture.

Features and Benefits

- Nine Linear Regulators
 - General Performance
 - $\pm 3\%$ Output Accuracy LDOx and $\pm 4.5\%$ for LDO4 (0.4V) Over Load/Line/Temperature
 - 50mV Dropout at Full Load
 - 63dB PSRR at 10kHz
 - 1.5mA Low-Power Mode
 - Short-Circuit and Thermal-Overload Protection
 - Dynamically Programmable Output Voltage
 - Power-OK Interrupt
 - Programmable Soft-Start Rate: 100mV/ μ s or 5mV/ μ s
 - Soft-Start into Prebiased Output
 - Four N-Channel Regulators (LDO0/1/7/8)
 - 0.8V to 5.5V Input Range
 - 29mA Quiescent Supply Current
 - No Output Capacitor Required in Normal Operating Mode (cap required for low-power mode)
 - Five Standard P-Channel Regulators (LDO2/3/4/5/6)
 - 1.7V to 5.5V Input Range
 - 20mA Quiescent Supply Current
 - Remote Capacitor Design with Register Adjustable Compensation to Optimize Transient Performance

Simplified Block Diagram

The nine LDOs of the MAX77714 are derived of five basic topologies as shown in [\(Table 5\)](#).

The PMOS regulators (PDRVx) operate and draw power from their power inputs (IN_LDOxx), which have a minimum operating supply voltage of 1.7V (V_{IN_LDOx}). The control registers and some input circuitry operate from the main system supply (MBATT) and hold their contents when the regulator input voltage (V_{IN_LDOx}) drops to 0V.

The NMOS regulators (NDRVx) gate drive operates from the main system supply (MBATT), while the load current is provided by the regulator input (IN_LDOxx). The input voltage (V_{IN_LDOx}) for the NMOS regulators extends down to 0.8V. To provide adequate gate drive for the NMOS output device, the NMOS output voltage should be more than 1.5V lower than the main system supply voltage (V_{MBATT}). The control registers are also powered from MBATT.

NMOS regulators works into dropout with the V_{IN_LDOx} to V_{OUT_LDOx} voltage determined by $I_{LOAD} \times R_{DO}$ where R_{DO} is the dropout resistance (typically 200mW). As dropout voltage decreases (by reducing load) below 0.3V, the PSRR and load regulation degrades.

All PMOS regulators are compensated at their output and require a remote output capacitance large enough to prevent oscillation. The NMOS regulators are internally compensated, but an additional output capacitor can be added to improve immunity to high-frequency noise and allow stable low-power mode operation. See the [Output Capacitor Selection](#) section for additional information.

Table 5. Basic LDO Topologies

| NAME | DESCRIPTION | LDO |
|-------|---------------------------------------------|------------------------|
| PDRV1 | Power Device: PMOS Output Current: 150mA | LDO2, LDO4, LDO5, LDO6 |
| PDRV2 | Power Device: PMOS Output Current: 300mA | LDO3 |
| NDRV1 | Power Device: NMOS Output Current: 150mA | LDO0, LDO1 |
| NDRV2 | Power Device: NMOS Output Current: 300mA | LDO8 |
| NDRV3 | Power Device: NMOS Output Current: 450mA | LDO7 |

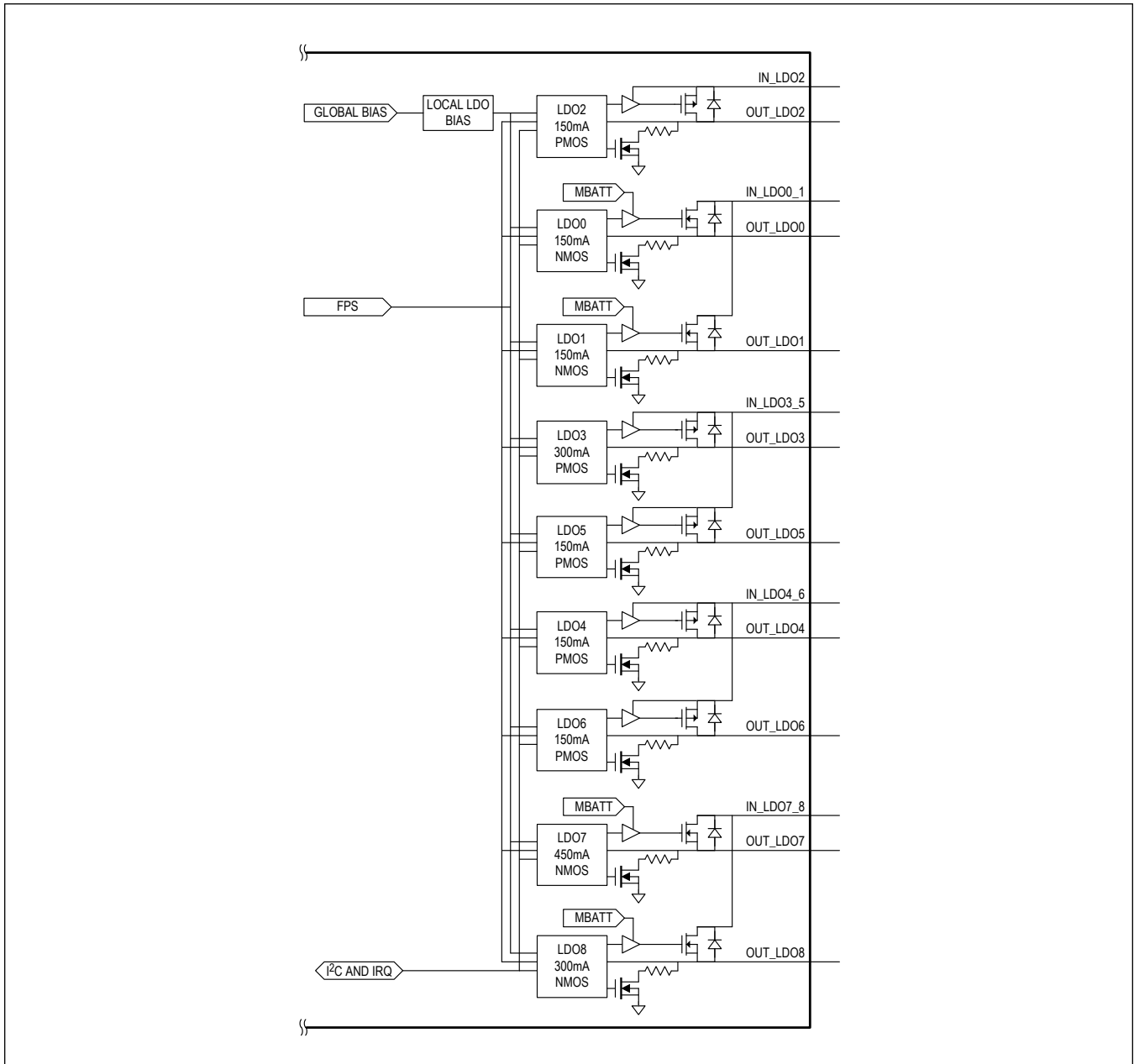


Figure 13. Linear Regulator Functional Diagram

Active-Discharge Resistor

Each linear regulator has an active-discharge resistor feature that can be enabled/disabled with ADE_Lx_. Enabling the active discharge feature helps ensure a complete and timely power-down of all system peripherals. The default condition of the active-discharge resistor feature is enabled so that whenever V_{MBATT} is below $V_{MBATTUVLO}$ all regulators are disabled with their active-discharge resistors turned on. When V_{MBATT} is less than 1.0V, the NMOS transistors that control the active-discharge resistors lose their gate drive and become open.

Input Capacitor Selection

Sufficient input bypass capacitance is required for stable operation of the LDO. Choose an effective input bypass capacitance (C_{IN_LDO}) of at least $1\mu\text{F}$ after derating. A $2.2\mu\text{F}$ ceramic capacitor is sufficient for most use cases. Larger values of C_{IN_LDO} improve the decoupling for the LDO regulator.

C_{IN_LDO} reduces the current peaks drawn from the battery or input power source during LDO regulator operation. The impedance of the input capacitor should be very low (i.e., $\leq 5\text{m}\Omega + \leq 500\text{pH}$) for frequencies up to 2MHz. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

As the case sizes of ceramic surface-mount capacitors decrease, their capacitance versus DC bias voltage characteristic becomes poor. Due to this characteristic, it is possible for 0603 case size capacitors to perform well while 0402 case size capacitors of the same value perform poorly. Consider the input capacitance value after initial tolerance, bias voltage, aging, and temperature derating. Analog Devices recommends a nominal capacitance value of $1\mu\text{F}$ which, in 0402 case size, can derate to $0.4\mu\text{F}$.

Output Capacitor Selection

Choose the output bypass capacitance (C_{OUT_LDO}) to be $2.2\mu\text{F}$. Larger values of C_{OUT_LDO} improve PSRR and load transient performance but increases the input surge currents during soft-start and output voltage changes.

C_{OUT_LDO} is required to keep the LDO stable. The impedance of the output capacitor should be very low (i.e., $\leq 5\text{m}\Omega + \leq 500\text{pH}$) for frequencies up to 2MHz. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

As the case sizes of ceramic surface-mount capacitors decrease, their capacitance versus DC bias voltage characteristic becomes poor. Due to this characteristic, it is possible for 0603 case size capacitors to perform well while 0402 case size capacitors of the same value perform poorly. Consider the output capacitance value after initial tolerance, bias voltage, aging, and temperature derating. Analog Devices recommends a nominal capacitance value of $2.2\mu\text{F}$ which, in 0402 case size, can derate to $1.1\mu\text{F}$.

P-Channel Linear Regulator Output Capacitor

P-channel LDOs require an output capacitor to maintain stable output voltage regulation. Adjustable compensation allows for flexibility when designing the PCB and placing the output capacitor. The default compensation is factory programmable; additionally, the compensation is register adjustable when the LDO is off.

In many LDO designs, there is little-to-no flexibility in the physical placement of the output capacitor on the PCB. However, the LDO implementation within the device provides adjustable compensation for the p-channel LDOs. This adjustable compensation allows flexibility in the placement of the output capacitor on the PCB. However, as the output capacitor is placed farther from the device, slower compensation values are required to maintain stability; these slower compensation values decrease performance.

For optimum p-channel LDO performance, place the output capacitor as close to the LDO output as possible and program $\text{COMP_Lx} = 0\text{b}00$. In situations where the full LDO performance is not required, the output capacitor can be placed farther away from the LDO output with slower compensation values. This option becomes especially useful when the LDO output capacitor can be eliminated and the load's local input capacitor becomes the only capacitance on the LDO output node.

Warning: The COMP_Lx bits should only be changed when the LDO is disabled. If the compensation bits are changed when the LDO is enabled, the output voltage glitches as the compensation changes.

N-Channel Linear Regulator Output Capacitor

N-channel LDOs technically do not require an output capacitor to maintain stable output voltage regulation if they are in normal mode (i.e., they can be capless). However, a n-channel LDO does require an output capacitor to maintain stable output voltage regulation in low-power mode. In either mode (normal or low-power), the LDO performs best with an output capacitor (C_{OUTx}) as recommended in the [Output Capacitor Selection](#) section of the datasheet.

Note that the $\text{COMP_Lx}[1:0]$ bits for n-channel LDOs must be set to $0\text{b}00$.

Bias

A small section of bias circuitry is required to be on when any of the LDOs are enabled. LDO enable signal from the FPS OR the L_B_EN from I²C enables the LDO bias circuits. In addition, whenever the LDO bias is enabled, the global bias for the MAX77714 is also enabled. The LDO bias circuitry takes t_{LBIAS} to turn on. If the LDO bias circuit is off and an LDO is enabled, the total time before the output starts slewing up is $t_{LBIAS} + t_{LON}$. If the LDO bias is on and an LDO is enabled, the total time before the output starts slewing is t_{LON} .

If the sequencing of a group of regulators is particularly important, it may be desirable to force the LDO bias to be on with the L_B_EN bit to ensure that the LDOs enables in a consistent manner with the shortest latency. Note that whenever L_B_EN is set, the global bias circuits and LDO bias circuits are enabled. The combined bias circuitry current is I_{QBIAAS} . To ensure that the system always operates with the lowest quiescent current possible, it is a good idea to clear L_B_EN when it is not needed.

LDO Power Modes

Linear regulators and step-down regulators have very similar power mode controls. Each linear regulator is independently controlled with PWR_MD_Lx[1:0] and each step-down regulator is independently controlled with PWR_MD_SDx[1:0]. In addition to enable and disable control, each linear regulator has a special low-power mode that reduced the quiescent current to 1.5 μ A. In low-power mode, each regulator supports a load of up to 5mA (I_{MAXxx}). The load regulation performance degrades proportionally with the reduced load current.

Several usage options are available for low-power mode. To force individual regulators to low-power mode, set PWR_MD_Lx to 0b10. To force a group of regulators to enter and exit low-power mode in unison, set their individual PWR_MD_Lx_bits to 0b10. When set for this “group and/or dynamic” low-power mode, the low-power mode is enabled when the global low-power mode signal is high. The global low-power mode signal is driven by the GLBL_LPM bit or through a GPIO.

When a linear regulator is configured to be part of a flexible power sequence (FPSSRC_Lx), the power mode bits (PWR_MD_Lx) are still used to configure low-power mode and normal-power mode, but the flexible power sequencer itself controls whether the regulator is enabled or disabled.

Soft-Start and Dynamic Voltage Scaling (DVS)

The linear regulators have a programmable soft-start rate. When a linear regulator is enabled, the output voltage ramps to its final voltage at a slew rate of either 5mV/ms or 100mV/ms, depending on the state of the SS_Lx bit. The 5mV/ms ramp rate limits the input inrush current to around 10mA on a 300mA regulator with a 2.2 μ F output capacitor and no load. The 100mV/ms ramp rate results in a 200mA inrush current on a 300mA regulator with a 2.2 μ F output capacitor and no load, but achieves regulation within 50ms. The soft-start ramp rate is also the rate of change at the output when changing dynamically between two output voltages while enabled (DVS). This includes both positive and negative output voltage transitions.

The LDO soft-start circuitry supports starting into a prebiased output. For example, if the output capacitor has an initial voltage of 0.4V when the regulator is enabled, the regulator gracefully increases the capacitor voltage to the required target voltage such as 1.2V. This is unlike other regulators without the start into prebias feature where they can force the output capacitor voltage to 0V before the soft-start ramp begins.

During a soft-start event or a DVS transition, the regulators output current increases by $C_{OUT} \times dV/dt$. In the event that the load current plus the additional current imposed by the soft-start or DVS transition, reach the regulator's current limit, the current limit is enforced. When the current limit is enforced, the advertised transition rate (dV/dt) does not occur.

Power-OK (POK) Comparators for Linear Regulators

Each linear regulator includes a POK comparator. The POK comparator signals (POK_Lx) indicate when each output has lost regulation (i.e., the output voltage is below V_{POKTHL}). The POK signal has a 25 μ s noise immunity filter ($t_{POKNFLDO}$).

When any of the POK signals (POK_Lx) go low, a maskable interrupt is generated. POK is the only interrupt available for the device's LDOs. The block level LDO interrupt register is IRQ_LVL2_Lx and the top level LDO interrupt is IRQ_LDO.

Overvoltage Clamp

Each LDO has an overvoltage clamp that allows it to sink current when the output voltage is above its target voltage. This

overvoltage clamp for a given LDO is disabled when that LDO is in low-power mode. If an LDO is in normal-power mode, then the overvoltage clamp is enabled/disabled with `OVCLMP_EN_Lx` (default enabled). The following bulleted list briefly describes three typical application scenarios that pertain to the overvoltage clamp.

Warning: If an LDO's overvoltage clamp is disabled (`OVCLMP_EN_Lx = 0`), the output loading is very low ($<10\mu\text{A}$), and the junction temperature of the device is hot ($>70^\circ\text{C}$) the output voltage may rise above its regulation point.

Typical application scenarios for the overvoltage clamp:

- LDOs Load Leaking Current into the LDOs Output. Some LDO loads leak current into an LDO output during certain operating modes. This is typically seen with microprocessor loads. For example, a microprocessor with 3.3V, 2.5V, 1.8V, and 1.0V supply rails is running in standby mode. In this mode the higher voltage rails can leak currents of several milliamps into the lower voltage rails. If the 1.0V rail is supplied by an LDO, the LDO output voltage rises based on the amount of leakage current. With the LDO overvoltage clamp enabled, when the output voltage rises above its target regulation voltage, the overvoltage clamp sinks current from the output capacitor, which brings the output voltage back within regulation.
- Negative Load Transient to 0A: When the LDO load current quickly ramps to 0A (i.e., 300mA to 0A load transient with 1 μs transition time), the output voltage can overshoot (i.e., soar). Since the LDO cannot turn off its pass device with an intently fast load transition, the LDO output voltage overshoots. In this instance, when the output voltage soars above target regulation voltage, the overvoltage clamp sinks current from the output capacitor, which brings the output voltage back within regulation.
- Negative Dynamic Voltage Transition: When the LDO output target voltage is decreased (i.e., 1.2V to 0.8V) when the system loading is light, the energy in the output capacitor tends to hold the output voltage up. When the output voltage is above its target regulation voltage, the overvoltage clamp sinks current from the output capacitor, which brings the output voltage back within regulation.

Nontypical Applications:

There are some nontypical applications for this overvoltage clamp that are not discussed.

- Two LDO outputs can be connected together to give one output with more current capability. In this case, you typically want one LDO's output voltage to be set 1LSB higher than the other LDO. The LDO with the lower output voltage should deactivate its overvoltage clamp.
- Similar to the above, a step-down and LDO output can be connected together to give more current. In this case, the LDO output should be set lower than the step-down so that the step-down delivers the bulk of the load current (i.e., step-down is more efficient). The LDO would only become active during transient conditions or high load conditions. In this case, the LDO overvoltage clamp should be disabled.

Detailed Description—GPIO

GPIO

The MAX77714 has eight GPIO channels. It can be configured as GPO, GPI, and also has an ALT mode.

When configured as a general purpose output (GPO), the GPO is programmable to be push-pull or open-drain. When a GPIO is configured as a general purpose output, do not enable the internal pull-up or internal pull-down resistors which corresponds with that GPO.

When configured as a general purpose input (GPI), the GPI is programmable to have either a high-impedance, 100k Ω pulldown, or 100k Ω pullup. Additionally, interrupt inputs with programmable debounce timers are available.

The GPI edge(s) that triggers interrupts are selectable with REF_{IRQx}. When a GPI interrupt is enabled and the selected edge(s) are detected, EDG_{Ex} is set in the INT_LVL2_GPIO register and IRQ_GPIO is set in the top-level interrupt register. If the top-level interrupt mask is cleared (IRQ_GPIOM), the external interrupt signal nIRQ is asserted.

Alternate Mode

In addition to the GPO and GPI configurations, each GPIO has an alternate mode.

When a GPIO is in an alternate mode device may internally force the direction (i.e., output or input) and/or logic level of the GPIO. However, other options such as debounce times and rising/falling edge triggered interrupt settings are still valid in alternate mode.

Table 6. GPIO Alternate Modes

| GPIOx | ALTERNATE MODES |
|-------|----------------------------------------------------------|
| GPIO0 | Active-High, Open-Drain, Flexible Power Sequencer Output |
| GPIO1 | Active-High, Open-Drain, Flexible Power Sequencer Output |
| GPIO2 | Active-High, Open-Drain, Flexible Power Sequencer Output |
| GPIO3 | ACOK input |
| GPIO4 | 32kHz Output (32K_OUT0) |
| GPIO5 | 32kHz Output (32K_OUT1) |
| GPIO6 | 32kHz Output (32K_OUT2) |
| GPIO7 | Active-High, Open-Drain, Flexible Power Sequencer Output |

Features and Benefits

- Eight GPIO
- MBATT and GPIO_INB Input Power Sources
 - Four GPIOs per input
 - Input Voltage Range from 1.7V to 5.5V
- GPI
 - GPI to ACOK
 - GPI
 - Flexible Edge Trigger Support
 - Selectable Debounce Time
 - Optional pullup/pulldown
- GPO
 - Push-Pull
 - Open-Drain
 - Four GPO programmable to Flexible Power Sequencer
 - Three GPO to 32kHz Output Option
 - 12mA Sink Current Allows for LED Drive

GPIO Programming Matrix

Table 7. GPIO Programming Matrix

| GPIOx GPI | | | | | | | | | |
|---------------------------------------------------------------------------------|----------------|-------------------|--------------------|-------------------|---------|----------------|------|------|------|
| Comment | DBNCx[1:0] | REFE_IRQx[1:0] | DOx | DIx | DIRx | PPDRVx | PUEx | PDEx | AMEx |
| GPI | Debounce Times | Interrupt Options | 0 | Input Logic Level | 1 = GPI | 0 | 0 | 0 | 0 |
| GPI with Internal Pullup | Debounce Times | Interrupt Options | 0 | Input Logic Level | 1 = GPI | 0 | 1 | 0 | 0 |
| GPI with Internal Pulldown | Debounce Times | Interrupt Options | 1 | Input Logic Level | 1 = GPI | 0 | 0 | 1 | 0 |
| GPIOx GPO | | | | | | | | | |
| GPO Push-Pull | 0 | 0 | Output Logic Level | 0 | 0 = GPO | 1 = push-pull | 0 | 0 | 0 |
| GPO Open-Drain | 0 | 0 | Output Logic Level | 0 | 0 = GPO | 0 = open-drain | 0 | 0 | 0 |
| GPIO0/1/2/7 Alternative Mode Active-High Flexible Power Sequencer Output | | | | | | | | | |
| Comment | DBNCx[1:0] | REFE_IRQx[1:0] | DOx | DIx | DIRx | PPDRVx | PUEx | PDEx | AMEx |
| GPO Flexible Power Sequencer Output, Push-Pull | 0 | 0 | set by FPS | 0 | 0 | 1 = push-pull | 0 | 0 | 1 |
| GPO Flexible Power Sequencer Output, Open-Drain | 0 | 0 | set by FPS | 0 | 0 | 0 = open-drain | 0 | 0 | 1 |
| GPIO4/5/6 Alternative Mode 32kHz Output (32K_OUT1) | | | | | | | | | |
| Comment | DBNCx[1:0] | REFE_IRQx[1:0] | DOx | DIx | DIRx | PPDRVx | PUEx | PDEx | AMEx |
| GPO 32kHz Output, Push-Pull | 0 | 0 | set by XIN | 0 | 0 | 1 = push-pull | 0 | 0 | 1 |
| GPO 32kHz Output, Open-Drain | 0 | 0 | set by XIN | 0 | 0 | 0 = open-drain | 0 | 0 | 1 |
| GPIO3 Alternative Mode ACOK (Level Triggered) | | | | | | | | | |
| Comment | DBNC3[1:0] | REFE_IRQx[1:0] | DO3 | DI3 | DIR3 | PPDRV3 | PUE3 | PDE3 | AME3 |
| GPI | Debounce Times | Interrupt Options | 0 | Input Logic Level | 1 = GPI | 0 | 0 | 0 | 1 |
| GPI with Internal Pullup | Debounce Times | Interrupt Options | 0 | Input Logic Level | 1 = GPI | 0 | 1 | 0 | 1 |
| GPI with Internal Pulldown | Debounce Times | Interrupt Options | 1 | Input Logic Level | 1 = GPI | 0 | 0 | 1 | 1 |

Detailed Description—32kHz Oscillator

The MAX77714 provides a 32kHz clock signal for the real-time clock and the central state machine. The 32kHz clock signal is derived from either an external 32kHz crystal or an external 32kHz clock source.

Features: 32kHz Oscillator

- Low-jitter mode reduces cycle-to-cycle jitter to 15ns
- Low-power mode lowers power consumption
- Dedicated clock output, additional outputs selectable as GPIO alternate modes
- Allows use of board-mounted crystal ballast capacitors or on-chip crystal ballast capacitors
- Internal ballast capacitor options support 6.5pF, 7.5pF, and 12.5pF crystals
- Bypass mode supports external clock input
- Backup silicon oscillator allows continued functionality if crystal fails

Operation Modes

The MAX77714 32kHz oscillator supports two hardware configurations, selectable by an OTP option. In normal mode, the oscillator drives an external crystal to derive a 32kHz clock signal. In bypass mode, the oscillator accepts a 32kHz square wave from an external clock source. CRYSTAL_CONFIG indicates the active operation mode.

In bypass mode, the oscillator buffers and passes through the input clock. The frequency detector detects abnormally low or high frequencies (below f_{DET_MIN} and above f_{DET_MAX}), but does not consider duty cycle or jitter.

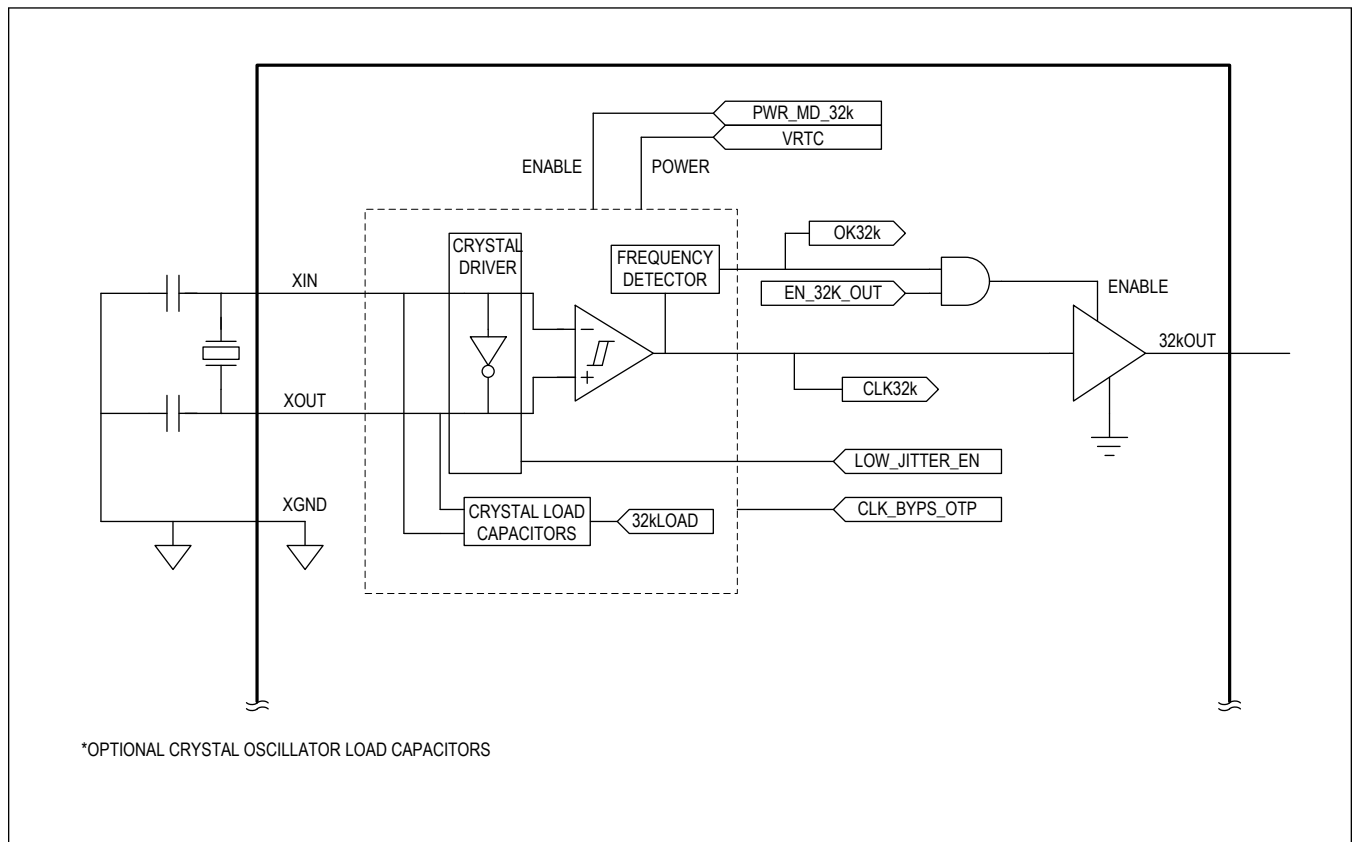


Figure 14. Block Diagram—32kHz Normal-Mode Operation

Low-Jitter Mode and Low-Power Mode

The crystal driver features two modes of operation: low-power mode and low-jitter mode. In low-jitter mode, the crystal driver current consumption is 24µA which allows for 15ns cycle-to-cycle jitter (tJIT_LPM) and duty cycle to between 45% and 55%. In low-power mode, the crystal driver current consumption is low (IOSC_LPM, 1.5µA) which corresponds to an increased cycle-to-cycle jitter and wider duty cycle (40% to 60%).

Power mode control is independently managed by the ON/OFF Controller based on the system state (ACTIVE, HIBERNATE, and STANDBY). When a system state transition occurs, the crystal driver automatically changes power mode as configured with 32K_LJ_x.

Internal Ballast Capacitors

The crystal driver has four options for internal ballast capacitance, selectable with an OTP option (32KLOAD_OTP). (Table 8) shows the total crystal load capacitance (internal and external) for common configurations. XIN and XOUT typically have 3pf of parasitic capacitance each (C_{PAR}) which factors in the total load capacitance calculation. For any internal and external load capacitance configuration, C_{LOAD} can be calculated using the formula $C_{LOAD} = (C_{INT} + C_{EXT} + C_{PAR}) / 2$.

Changing the internal load capacitance while the system is in operation is not recommended.

Table 8. 32kHz Crystal Oscillator Load Capacitance

| 32KLOAD | PARASITIC CAPACITANCE FROM XIN TO GND AND XOUT TO GND (C _{PAR}) | INTERNAL LOAD CAPACITANCE FROM XIN TO GND AND XOUT TO GND (C _{INT}) | EXTERNAL LOAD CAPACITANCE FROM XIN TO GND AND XOUT TO GND (C _{EXT}) | TOTAL LOAD CAPACITANCE ON THE CRYSTAL (C _{LOAD}) |
|---------|---------------------------------------------------------------------------|-------------------------------------------------------------------------------|-------------------------------------------------------------------------------|------------------------------------------------------------|
| 0b00 | 3pF | None | 10pF | 6.5pF |
| 0b00 | 3pF | None | 12pF | 7.5pF |
| 0b00 | 3pF | None | 22pF | 12.5pF |
| 0b01 | 3pF | 10pF | None | 6.5pF |
| 0b10 | 3pF | 12pF | None | 7.5pF |
| 0b11 | 3pF | 22pF | None | 12.5pF |

Buffered Output

The oscillator clocks a dedicated 32kHz buffered output (32KOUT) which provides a low-jitter 32kHz clock source to the system. The buffer is configurable to be either a push-pull, or open-drain output stage. The supply for the push-pull output stage is configurable to be one of three voltage rails: LDO12, BUCK3 or LSW1 (V32KOUT). For the buffered output to meet the low-jitter spec (t-JIT_LPM), the following conditions must be satisfied:

- The primary oscillator must generate the 32kHz clock (32KSOURCE = 0).
- If a crystal is used (normal mode), the oscillator must be configured for low-jitter operation.
- If an external clock is used (bypass mode), the external clock must meet the low-jitter spec.
- The buffer must be configured for the push-pull output stage.

Additional 32kHz outputs are available from GPIO alternative modes; see the [GPIO](#) section for more information.

The FBB3 and LSW1 supply inputs to the buffer can be unpowered when their respective inputs are disabled. In such cases, the unpowered inputs are not backpowered from the powered inputs. Before enabling the buffer (EN32KOUT = 1), the selected supply must have reached its programmed output voltage; otherwise, runt pulses may appear at 32KOUT.

Silicon Oscillator

The MAX77714 includes a silicon oscillator which permits continued system operation in the event that the crystal oscillator fails. The silicon oscillator has reduced accuracy and higher jitter than a crystal oscillator and is not suitable for timekeeping or applications requiring low jitter; however, it offers greater reliability than the crystal oscillator and is sufficiently accurate for continued operation of device's core functionality.

During normal operation, the device derives its 32kHz clock from the crystal oscillator or internal silicon oscillator

depending on the oscillator OTP selection. There are two conditions that cause it to use the silicon oscillator instead: if the crystal oscillator fails to start up in a timely manner, or if it fails during operation. The latter case results in an asynchronous reset of all registers in the device. In both cases, the device generates an interrupt (XTAL_FAIL_I) to notify the AP that a crystal fault caused the device to start up and operate using the silicon oscillator.

Once the system is operating with the silicon oscillator, software can periodically check XOSCOK to see if the crystal has restabilized. If software determines that the crystal is stable enough to use, it can set XOSC_RETRY to initiate a glitchless transition back to the crystal oscillator. If the crystal oscillator is not OK (XOSCOK = 0), the transition does not occur.

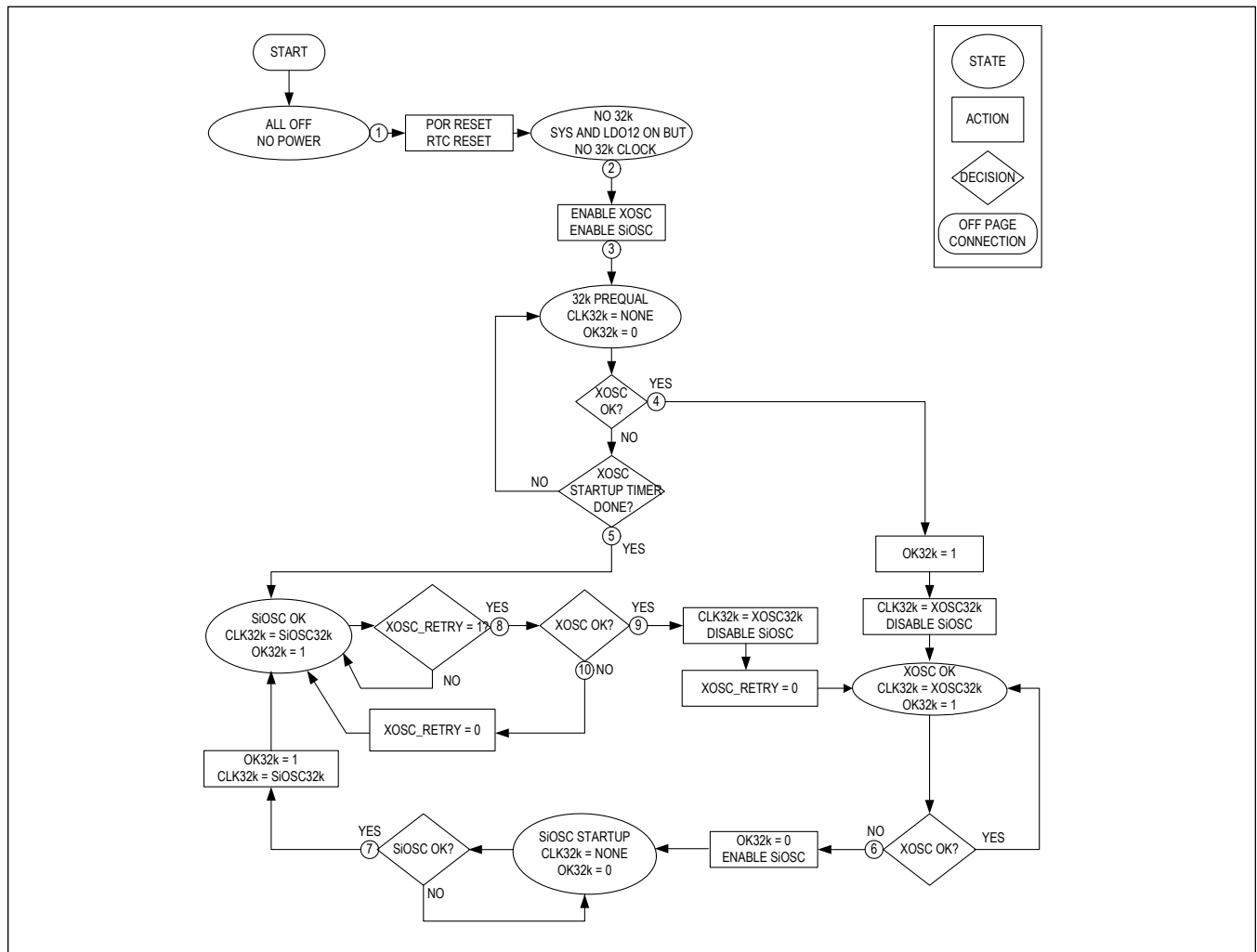


Figure 15. Flow Chart—Silicon Oscillator

Detailed Description—Backup Battery Charger

The backup battery charger is a constant voltage (CV) and constant current (CC) style charger with a series output resistance. The backup battery charger is enabled and disabled with BBCEN. The charge current, charger voltage, output current, and output resistance are adjustable with the CNFG_BBC register. The backup battery charger is suitable for the following types of backup cells:

- Super capacitor (a.k.a., gold cap, double-layer electrolytic)
- Standard capacitors (tantalum, electrolytic, ceramic)

- Rechargeable lithium manganese cells

Features

- 800 μ A maximum CC-CV backup battery charger.
- 2.5V to 3.5V adjustable backup battery setting with \pm 3% tolerance.
- Seamless transition of RTC supply from V_{MBATT} to V_{BBATT} when V_{MBATT} drops below V_{MBATT_UVLO} threshold.

Detailed Description—Real-Time Clock (RTC)

The real-time clock (RTC) is responsible for keeping track of the time. It records seconds, minutes, hours, days, months, and years with a calendar structure that accounts for leap years. The RTC is further equipped with two alarms and has a host of maskable capabilities.

Through a set of configuration registers, various modes of operation are possible. RTC supports both “Binary”, and “Binary Coded Decimal”, and supports features such as AM/PM, and 24/12 modes of operation. Additional sudden momentary power loss (SMPL) is available.

Features

- Gregorian Calendar with Leap Year Correction
- Two Alarms
- Maskable Interrupts
 - 1s and 60s
 - Alarm 1 & 2
 - SMPL
- Binary and BCD Modes
- 12/24 Hour Modes
- Sudden Momentary Power Loss (SMPL)
- Double Buffered Read/Write Registers Allows Asynchronous Register Access
- Operates down to 1.71V

Writing to RTC

In order to safely write to various registers on-board the RTC, all RTC registers (except RTCINT register, bit 0 of UPDATE0 register, and bit 4 of UPDATE0 register) have a corresponding “Write Buffer”. When the user writes to the RTC, the user is actually performing a write to these “Write Buffers”. Therefore, in writing to RTC there are two steps needed to update a particular register or set of registers:

1. User writes desired value(s) to the register(s) located between 0x01 and 0x24. Behind the scene, only the “Write Buffers” are updated with these new values.
2. The user then writes a 1 to UDR bit 0 of the “UPDATE0 Register” at address 0x04 to transfer the modified “Write Buffers” to the corresponding time registers.

The logic subsequently would perform a transfer of data from Write Buffers to the actual registers and then clears the “UDR” bit automatically as well as clearing the Write Buffers (marking them as not modified).

Under the hood, the logic first does a double synchronization of the UDR bit to the 32.768kHz clock before using it as an enable bit to transfer from Write buffers to the actual registers thus allowing a safe update of these two unsynchronized clock events.

Example 1. Pseudo code for setting clock to Saturday, Jan 01, 2011, 1:00:00 PM

```
Set RTCCNTL to 0x01    //12hr mode, BCD mode
Set RTCUPDATE0 to 0x01 //transfer RTCCNTL modification to RTC
Set RTCSEC to 0x00    //0 second
Set RTCMIN to 0x00    //0 minute
Set RTCHOUR to 0x41   //1 PM
Set RTCDOW to 0x40    //Saturday
```

```
Set RTCMONTH to 0x01 //January
Set RTCYEAR to 0x11 //11
Set RTCDOM to 0x01 //First
Set RTCUPDATE0 to 0x01 //transfer write buffers to counters
Wait 16 ms for write to complete
Set RTCSEC to 0x... //new write
```

Example 2. Pseudo code for setting ALARM1 to every Wednesday at 7:30:00 AM:

```
Set RTCCNTL to 0x01 //12hr mode, BCD mode
Set RTCUPDATE0 to 0x01 //transfer RTCCNTL modification to RTC
Set RTCSECA1 to 0x80 //0 sec, enabled
Set RTCMINA1 to 0xB0 //30 minute, enabled
Set RTCHOURA1 to 0x87 //7 AM, enabled
Set RTCDOWA1 to 0x08 //Wednesday, enabled
Set RTCMONTHA1 to 0x00 //Disabled
Set RTCYEARA1 to 0x00 //Disabled
Set RTCDOMA1 to 0x00 //Disabled
Set RTCUPDATE0 to 0x01 //transfer write buffers to counters
Wait 16ms for write to complete
Set RTCSEC to 0x... //new write
```

Reading from RTC

Corresponding to most timing registers are a series of Read Buffers.

In order to safely read from various registers on-board the RTC, all RTC registers (except RTCINT register and bit 0 and 4 of UPDATE0 Register) have a corresponding Read Buffer. When the user reads from the RTC, the user is actually performing a read from the Read Buffers. Therefore, there are two steps needed to read a particular register or set of registers:

1. The user writes a 1 to RBUDR bit 4 of the UPDATE0 Register at address 0x04 to transfer most timing registers to the Read Buffers. Behind the scene, the Read Buffers are updated.
2. The user then reads from the desired register location.

After step 1, the logic subsequently performs a transfer of data from the actual registers to the Read Buffers and then clears the RBUDR bit.

The logic first does a double synchronization of the RBUDR bit to the 32.768 kHz clock before using it as a clock (RBUDR_sync) to transfer from the actual registers to the Read Buffers, thus allowing a safe update of these 2 unsynchronized clock events.

Example 3. Pseudo code for reading the time:

```
Set RTCUPDATE0 to 0x10 //transfer timekeeper counters to read buffers
Wait 16ms for read to complete
Read RTCSEC //second
Read RTCMIN //minute
Read RTCHOUR //hour
Read RTCDOW //Day of Week
Read RTCMONTH //Month
Read RTCYEAR //Year
```

Read RTCDOM //Day of Month

Example 4. Pseudo code for reading ALARM1 setting:

Set RTCUPDATE0 to 0x10 // transfer timekeeper counters to read buffers

Wait 16ms for read to complete

Read RTCSECA1 //sec

Read RTCMINA1 //minute

Read RTCHOURA1 //hour

Read RTCDOWA1 //Day of Week

Read RTCMONTHA1 //Month

Read RTCYEARA1 //Year

Read RTCDOMA1 //Day of Month

Sudden Momentary Power Loss (SMPL)

The SMPL function allows the system to recover if power is briefly lost due to a poor battery connection. If V_{MBATT} falls below and returns above the UVLO threshold within the SMPL timer threshold (SMPLT[1:0]) and SMPL is enabled (SMPL_EN = 1), SMPL initiates a power-up sequence and the SMPL interrupt bit is set. If the SMPL timer expires before V_{MBATT} returns, the SMPL enable bit is automatically cleared in order to prevent power-up on subsequent SMPL events.

To ensure proper operation of the SMPL state machine, initialization software should clear and set SMPL_EN after each power on event.

Detailed Description—I²C Interface

I²C Slave Address

The device implements 7-bit slave addressing. An I²C bus master initiates communication with a slave device by issuing a START condition followed by the slave address. The device responds to its two slave addresses; all other slave addresses are not acknowledged by the device, (optional) with the exception of the General Call address (Software Reset option).

Table 9. MAX77714 Slave Addresses

| OTP_I2CADDR[1:0] | RTC SLAVE ADDRESS WRITE | RTC SLAVE ADDRESS READ | PMIC/GPIO SLAVE ADDRESS WRITE | PMIC/GPIO SLAVE ADDRESS READ |
|------------------|-------------------------|------------------------|-------------------------------|------------------------------|
| 0b00 | 0x90, 0b1001_0000 | 0x91, 0b1001_0001 | 0x38, 0b0011_1000 | 0x39, 0b0011_1001 |
| 0b01 | 0x94, 0b1001_0100 | 0x95, 0b1001_0101 | 0x3C, 0b0011_1100 | 0x3D, 0b0011_1101 |
| 0b10 | 0x0D, 0b1101_0000 | 0xD1, 0b1101_0001 | 0x78, 0b0111_1000 | 0x79, 0b0111_1001 |
| 0b11 | 0xD4, 0b1101_0100 | 0xD5, 0b1101_0101 | 0x7C, 0b0111_1100 | 0x7D, 0b0111_1101 |

Register Map

RTC

| ADDRESS | NAME | MSB | | | | | | | LSB |
|-----------------|---------------------------------|-----------|-------------|-------------|--------------|------------|------------|---------|---------|
| RTC_FUNC | | | | | | | | | |
| 0x00 | RTCINT[7:0] | RSVD | RSVD | RSVD | RTC1S | SMPL | RTCA2 | RTCA1 | RTC60S |
| 0x01 | RTCINTM[7:0] | RSVD | RSVD | RSVD | RTC1SM | SMPLM | RTCA2M | RTCA1M | RTC60SM |
| 0x02 | RTCCNTLM[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | HRMODEM | BCDM |
| 0x03 | RTCCNTL[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | HRMODE | BCD |
| 0x04 | RTCUPDATE0[7:0] | RSVD | RSVD | RSVD | RBUDR | RSVD | FREEZE_SEC | FCUR | UDR |
| 0x05 | RTCUPDATE1[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RBUDF | UDF |
| 0x06 | RTCSMPL[7:0] | SMPL_EN | RSVD | RSVD | RSVD | SMPLT[1:0] | | RSVD | RSVD |
| 0x07 | RTCSEC[7:0] | RSVD | SEC[6:0] | | | | | | |
| 0x08 | RTCMIN[7:0] | RSVD | MIN[6:0] | | | | | | |
| 0x09 | RTCHOUR[7:0] | RSVD | AMPM | HOUR[5:0] | | | | | |
| 0x0A | RTCDOW[7:0] | RSVD | SAT | FRI | THU | WED | TUE | MON | SUN |
| 0x0B | RTCMONTH[7:0] | RSVD | RSVD | RSVD | MONTH[4:0] | | | | |
| 0x0C | RTCYEAR[7:0] | YEAR[7:0] | | | | | | | |
| 0x0D | RTCDOM[7:0] | RSVD | RSVD | DAY[5:0] | | | | | |
| 0x0E | RTCSECA1[7:0] | AESECA1 | SECA1[6:0] | | | | | | |
| 0x0F | RTCMINA1[7:0] | AEMINA1 | MINA1[6:0] | | | | | | |
| 0x10 | RTCHOURA1[7:0] | AHOURA1 | AMPMA1 | HOURA1[5:0] | | | | | |
| 0x11 | RTCDOWA1[7:0] | AEDOWA1 | SATA1 | FRIA1 | THUA1 | WEDA1 | TUEA1 | MONA1 | SUNA1 |
| 0x12 | RTCMONTHA1[7:0] | AEMONA1 | RSVD | RSVD | MONTHA1[4:0] | | | | |
| 0x13 | RTCYEARA1[7:0] | AEYEARA1 | YEARA1[6:0] | | | | | | |
| 0x14 | RTCDOMA1[7:0] | AEDOMA1 | RSVD | DAYA1[5:0] | | | | | |
| 0x15 | RTCSECA2[7:0] | AESECA2 | SECA2[6:0] | | | | | | |
| 0x16 | RTCMINA2[7:0] | AEMINA2 | MINA2[6:0] | | | | | | |
| 0x17 | RTCHOURA2[7:0] | AHOURA2 | AMPMA2 | HOURA2[5:0] | | | | | |
| 0x18 | RTCDOWA2[7:0] | AEDOWA2 | SATA2 | FRIA2 | THUA2 | WEDA2 | TUEA2 | MONA2 | SUNA2 |

| ADDRESS | NAME | MSB | | | | | | | LSB |
|---------|----------------------------------|--------------|-------------|------------|--------------|------|------|------|-----------------|
| 0x19 | RTCMONTHA2[7:0] | AEMON A2 | RSVD | RSVD | MONTHA2[4:0] | | | | |
| 0x1A | RTCYEARA2[7:0] | AEYEAR A2 | YEARA2[6:0] | | | | | | |
| 0x1B | RTCDOMA2[7:0] | AEDOM A2 | RSVD | DAYA2[5:0] | | | | | |
| 0x25 | RTC_TIME_OK[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RTC_T IME_OK |

Register Details

[RTCINT \(0x00\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| Field | RSVD | RSVD | RSVD | RTC1S | SMPL | RTCA2 | RTCA1 | RTC60S |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0x0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|---------------------------------------------------------------------------------------------------------|---------------------------------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RTC1S | 4 | RTC Periodic 1 Second Timer Expired Interrupt 0b0 = 1s Timer did not expire 0b1 = 1s Time expired | |
| SMPL | 3 | SMPL Event Interrupt | 0: No Interrupt 1: Interrupt |
| RTCA2 | 2 | RTC Alarm 2 Interrupt 0b0 = No interrupt 0b1 = Interrupt | |
| RTCA1 | 1 | RTC Alarm 1 Interrupt 0b0 = No interrupt 0b1 = Interrupt | |
| RTC60S | 0 | RTC 60 Second Timer Expired Interrupt 0b0 = 60s Timer did not expire 0b1 = 60s Timer expired | |

[RTCINTM \(0x01\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | RTC1SM | SMPLM | RTCA2M | RTCA1M | RTC60SM |
| Reset | 0b0 | 0b0 | 0x0 | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RTC1SM | 4 | RTC Periodic 1 Second Timer Expired Interrupt MASK 0b0 = Not Masked 0b1 = Masked |
| SMPLM | 3 | SMPL Event Interrupt 0b0 = Not Masked 0b1 = Masked |
| RTCA2M | 2 | RTC Alarm 2 Interrupt 0b0 = Not Masked 0b1 = Masked |
| RTCA1M | 1 | RTC Alarm 1 Interrupt 0b0 = Not Masked 0b1 = Masked |
| RTC60SM | 0 | RTC 60 Second Timer Expired Interrupt 0b0 = Not Masked 0b1 = Masked |

RTCCNTLM (0x02)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | HRMODEM | BCDM |
| Reset | 0b0 | 0b0 | 0x0 | 0b0 | 0b0 | 0b0 | 0b1 | 0b1 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 4 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 3 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 2 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| HRMODEM | 1 | Access Control of HRMODE Bit in Register RTCCNTL 0b0 = Writes to Bit 1 (HRMODE) of register address 0x03 (RTCCNTL) is not allowed. 0b1 = Writes to Bit 1 (HRMODE) of register address 0x03 (RTCCNTL) is allowed. | 0 1: Writes to Bit 0 (HRMODE) of register address 0x03 (RTCCNTL) is allowed. |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|
| BCDM | 0 | Access Control of BCD Bit in Register RTCCNTL 0b0 = Writes to Bit 0 (BCD) of register address 0x03 (RTCCNTL) is not allowed. 0b1 = Writes to Bit 0 (BCD) of register address 0x03 (RTCCNTL) is allowed. | 0: Writes to Bit 0 (BCD) of register address 0x03 (RTCCNTL) is not allowed. 1: Writes to Bit 0 (BCD) of register address 0x03 (RTCCNTL) is allowed. |

RTCCNTL (0x03)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | HRMODE | BCD |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 4 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 3 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 2 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| HRMODE | 1 | Hour Format Control Note that AMPM bit defined for the HOUR or HOURA register only makes sense for the 12-hour mode as the 24-hour mode already has AM/PM implied. 0b0 = 12-Hour mode 0b1 = 24-Hour mode If HRMODEM = 0, writes to HRMODE are not allowed. When switching between 12-hour and 24-hour mode, the registers do not automatically update. User must reprogram all registers. | |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------|
| BCD | 0 | Data Mode for Time and Calendar Updates 0b0 = Binary 0b1 = Binary Coded Decimal (BCD) If BCDM = 0 writes to BCD are not allowed. When switching between binary and BCD, the time contents are no longer valid and must be reinitialized. | 0: Binary 1: Binary Coded Decimal (BCD) |

RTCUPDATE0 (0x04)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | RBUDR | RSVD | FREEZE_SEC | FCUR | UDR |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b1 | 0b0 | 0b1 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RBUDR | 4 | Access control to update RTC registers by transferring data from the actual registers to the Read Buffers. 0b0 = No action 0b1 = Update Read Buffers Typical transfer time from timekeeper counters to read is 15ms after RBUDR is set. RBUDR is internally cleared after the registers data has been transferred. |
| RSVD | 3 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| FREEZE_SEC | 2 | This bit freezes the SEC counter from incrementing. 0b0 = SEC counter increments normally 0b1 = SEC counter stops incrementing, which stops all subsequent registers in the timer string (MIN, HOUR, DAY, etc.). This setting effectively stops the clock. |
| FCUR | 1 | Flags Cleared Upon Read Control Bit 0b0 = User must write 0 to clear UDF and RBUDF 0b1 = UDF and RBUDF cleared upon read |
| UDR | 0 | Access control to update RTC registers by transferring data from the Write Buffers to the actual registers. 0b0 = No action 0b1 = Update register Typical transfer time from Write Buffers to the timekeeper counters is 15ms after UDR is set. UDR is internally cleared after the registers data has been transferred. |

[RTCUPDATE1 \(0x05\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RBUDF | UDF |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b1 | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 4 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 3 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 2 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RBUDF | 1 | <p>This bit is an Update Flag that indicates when an actual transfer of data from the actual registers to Read Buffers occurs. When this bit is 1, then the user can initiate a new read operation, otherwise it is not safe to do so.</p> <p>0b0 = Update not done 0b1 = Update done</p> <p>Typical update time is 15ms after the RBUDR bit is set. If FCUR bit (RTCUPDATE0 register) is 1, this bit is automatically cleared after a read operation. If FCUR is 0, the user must write a 0 to clear it.</p> |
| UDF | 0 | <p>This bit is an Update Flag that indicates when an actual transfer of data from the Write Buffers to the corresponding register occurs. When this bit is 1, then the user can initiate a new write operation, otherwise it is not safe to do so.</p> <p>0b0 = Update not done 0b1 = Update done</p> <p>Typical update time is 15ms after the UDR bit is set. If FCUR bit (RTCUPDATE0 register) is 1, this bit is automatically cleared after a read operation. If FCUR is 0, the user must write a 0 to clear it.</p> |

[RTC SMPL \(0x06\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|---|-------------|-------------|
| Field | SMPL_EN | RSVD | RSVD | RSVD | SMPLT[1:0] | | RSVD | RSVD |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b00 | | 0b0 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------|
| SMPL_EN | 7 | <p>SMPL Feature Enable Control</p> <p>0b0 = SMPL Disabled 0b1 = SMPL Enabled</p> |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 4 | There is no physical bit at this location. Write to 0. Reads are don't care. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------------------------------------|
| SMPLT | 3:2 | Sets the SMPL Timer Threshold 0b00 = 0.5s 0b01 = 1.0s 0b10 = 1.5s 0b11 = 2.0s |
| RSVD | 1 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 0 | There is no physical bit at this location. Write to 0. Reads are don't care. |

RTCSEC (0x07)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|---|---|---|---|---|
| Field | RSVD | SEC[6:0] | | | | | | |
| Reset | 0b0 | 0b00000000 | | | | | | |
| Access Type | Write, Read | Write, Read | | | | | | |
| BITFIELD | BITS | DESCRIPTION | | | | | | |
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. | | | | | | |
| SEC | 6:0 | RTC Seconds Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through 59. In BCD format, valid data for B6 through B4 are 0 through 5, and valid data for B3 through B0 are 0 through 9. | | | | | | |

RTCMIN (0x08)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|---|---|---|---|---|
| Field | RSVD | MIN[6:0] | | | | | | |
| Reset | 0b0 | 0b00000000 | | | | | | |
| Access Type | Write, Read | Write, Read | | | | | | |
| BITFIELD | BITS | DESCRIPTION | | | | | | |
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. | | | | | | |
| MIN | 6:0 | RTC Minutes Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through 59. In BCD format, valid data for B6 through B4 are 0 through 5, and valid data for B3 through B0 are 0 through 9. | | | | | | |

RTCHOUR (0x09)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|------------------------------------------------------------------------------|-------------|---|---|---|---|---|
| Field | RSVD | AMPM | HOUR[5:0] | | | | | |
| Reset | 0b0 | 0b0 | 0b0000000 | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |
| BITFIELD | BITS | DESCRIPTION | | | | | | |
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AMPM | 6 | AM/PM Selection. AMPM is only valid when the clock is set for 12-hour mode (HRMODE = 0). When the clock is set for 24-hour mode, this bit is a don't care. 0b0 = AM 0b1 = PM |
| HOUR | 5:0 | RTC Hours Counter Register Note that there are two possibilities for values chosen for B5 through B0 depending on current status of HRMODE Bit: If HRMODE = 1 (24-Hour Mode) • Binary mode (BCD = 0): B5 is zero, and B4 through B0 valid values are 0 through 23. • BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 2, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 23). If HRMODE = 0 (12-Hour Mode) • Binary mode (BCD = 0): B5 and B4 are 0, and valid values for B3 through B0 are 1 through 12. • BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 1, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 12). |

RTCDOW (0x0A)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | SAT | FRI | THU | WED | TUE | MON | SUN |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b1 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| SAT | 6 | Bits B6 through B0 each represent one day of the week. As such, only one bit is set at a time. B[6:0] = 100_0000 represents Saturday |
| FRI | 5 | B[6:0] = 010_0000 represents Friday |
| THU | 4 | B[6:0] = 001_0000 represents Thursday |
| WED | 3 | B[6:0] = 000_1000 represents Wednesday |
| TUE | 2 | B[6:0] = 000_0100 represents Tuesday |
| MON | 1 | B[6:0] = 000_0010 represents Monday |
| SUN | 0 | B[6:0] = 000_0001 represents Sunday |

RTCMONTH (0x0B)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|---|---|---|---|
| Field | RSVD | RSVD | RSVD | MONTH[4:0] | | | | |
| Reset | 0b0 | 0b0 | 0b0 | 0b00001 | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|------------------------------------------------------------------------------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| MONTH | 4:0 | RTC Months Counter Register In Binary format (BCD = 0), valid values for B4 through B0 are 1 through 12. In BCD format (BCD = 1), valid data for B4 is either 0 or 1, and valid data for B3 through B0 are 0 through 9 (the full value in BCD format does not exceed 12 and must be greater than zero). |

RTCYEAR (0x0C)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field | YEAR[7:0] | | | | | | | |
| Reset | 0b00000000 | | | | | | | |
| Access Type | Write, Read | | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| YEAR | 7:0 | RTC Years Counter Register In Binary format (BCD = 0), valid values for B7 through B0 are 0 through 99. In BCD format (BCD = 1), valid data for B7 through B4 are 0 through 9, and similarly valid data for B3 through B0 are 0 through 9. |

RTCDOM (0x0D)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|---|---|---|---|---|
| Field | RSVD | RSVD | DAY[5:0] | | | | | |
| Reset | 0b0 | 0b0 | 0b000001 | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| DAY | 5:0 | RTC Days in a Month Register In Binary format (BCD = 0), valid values for B5 through B0 are 1 through 31. In BCD format (BCD = 1), valid data for B4 through B5 are 0 through 3, and valid data for B3 through B0 are 0 through 9 (the full value should be greater than 0 but not exceed 31). Furthermore, there is a restriction on choosing number of days in a month according to the selected month and year as shown below: <ul style="list-style-type: none"> • For months 1, 3, 5, 7, 8, 10, and 12 the selected value for B5 through B0 must be 1 through 31. • For months 4, 6, 9, and 11 the selected value for B5 through B0 must be 1 through 30. • For month 2, or month of Feb., the selected value for B5 through B0 must be 1 through 28 for normal years, or must be 1 through 29 for leap years. Does not account for solar years. Leap years are those that are evenly divisible by 4. 0, 4, 8, . . . 24, 28, . . . 72, 76 . . . 92, 96. |

[RTCSECA1 \(0x0E\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|---|-------------|---|---|---|---|---|
| Field | AESECA1 | | SECA1[6:0] | | | | | |
| Reset | 0b0 | | 0b0000000 | | | | | |
| Access Type | Write, Read | | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------|
| AESECA1 | 7 | Alarm Enable Control | 0: Alarm disable 1: Alarm enable |
| SECA1 | 6:0 | RTC Seconds Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through 59. In BCD format, valid data for B6 through B4 are 0 through 5, and valid data for B3 through B0 are 0 through 9. | |

[RTCMINA1 \(0x0F\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|---|-------------|---|---|---|---|---|
| Field | AEMINA1 | | MINA1[6:0] | | | | | |
| Reset | 0b0 | | 0x0000001 | | | | | |
| Access Type | Write, Read | | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------|
| AEMINA1 | 7 | Alarm Enable Control | 0: Alarm disable 1: Alarm enable |
| MINA1 | 6:0 | RTC Minutes Alarm Register If the value of MINA1 is equal to the value of MIN and AEMINA1 is 1, an RTCA1 alarm interrupt is generated. RTC Minutes Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through 59. In BCD format, valid data for B6 through B4 are 0 through 5, and valid data for B3 through B0 are 0 through 9. | |

[RTCHOURA1 \(0x10\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|---|---|---|---|---|
| Field | AEHOURA1 | AMPMA1 | HOURA1[5:0] | | | | | |
| Reset | 0b0 | 0b0 | 0b000001 | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------|
| AEHOURA1 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AMPMA1 | 6 | AM/PM Selection AMPMA is only valid when the clock is set for 12-hour mode (HRMODE = 0). When the clock is set for 24-hour mode, this bit is a don't care. 0b0 = AM 0b1 = PM |
| HOURA1 | 5:0 | RTC Hours Alarm Register If the value of HOURA1 is equal to the value of HOUR and AEHOURA1 is 1, an RTCA1 alarm interrupt is generated. RTC Hours Counter Register Note that there are two possibilities for values chosen for B5 through B0 depending on current status of HRMODE Bit: If HRMODE = 1 (24-Hour Mode) • Binary mode (BCD = 0): B5 is zero, and B4 through B0 valid values are 0 through 23. • BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 2, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 23). If HRMODE = 0 (12-Hour Mode) • Binary mode (BCD = 0): B5 and B4 are 0, and valid values for B3 through B0 are 1 through 12. • BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 1, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 12). |

RTCDOWA1 (0x11)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | AEDOWA1 | SATA1 | FRIA1 | THUA1 | WEDA1 | TUEA1 | MONA1 | SUNA1 |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b1 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AEDOWA1 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |
| SATA1 | 6 | RTC Day Of Week Alarm Register If the value of RTCDOWA1 is equal to the value of DOW and AEDOWA1 is 1, an RTCA1 alarm interrupt is generated. Bits B6 through B0 each represent one day of the week. As such, only one bit is set at a time. B[6:0] = 100_0000 represents Saturday |
| FRIA1 | 5 | B[6:0] = 010_0000 represents Friday |
| THUA1 | 4 | B[6:0] = 001_0000 represents Thursday |
| WEDA1 | 3 | B[6:0] = 000_1000 represents Wednesday |
| TUEA1 | 2 | B[6:0] = 000_0100 represents Tuesday |
| MONA1 | 1 | B[6:0] = 000_0010 represents Monday |
| SUNA1 | 0 | B[6:0] = 000_0001 represents Sunday |

[RTCMONTHA1 \(0x12\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|--------------|---|---|---|---|
| Field | AEMONA1 | RSVD | RSVD | MONTHA1[4:0] | | | | |
| Reset | 0b0 | 0b0 | 0b0 | 0b00000 | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------|
| AEMONA1 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| MONTHA1 | 4:0 | RTC Month Alarm Register If the value of MONTHA1 is equal to the value of MONTH and AEMONA1 is 1, an RTCA1 alarm interrupt is generated. |

[RTCYEARA1 \(0x13\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|---|---|---|---|---|---|
| Field | AEYEARA1 | YEARA1[6:0] | | | | | | |
| Reset | 0b0 | 0b0000000 | | | | | | |
| Access Type | Write, Read | Write, Read | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AEYEARA1 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |
| YEARA1 | 6:0 | RTC Year Alarm Register If the value of YEARA1 is equal to the value of YEAR and AEYEARA1 is 1, an RTCA1 alarm interrupt is generated. RTC Years Counter Register In Binary format (BDC = 0), valid values for B7 through B0 are 0 through 99. In BCD format (BCD = 1), valid data for B7 through B4 are 0 through 9, and similarly valid data for B3 through B0 are 0 through 9. |

[RTCDOMA1 \(0x14\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|---|---|---|---|---|
| Field | AEDOMA1 | RSVD | DAYA1[5:0] | | | | | |
| Reset | 0b0 | 0b0 | 0b000000 | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|------------------------------------------------------------------------------|
| AEDOMA1 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| DAYA1 | 5:0 | RTC Day Of Month Alarm 1 Register If the value of DAYA1 is equal to the value of DAY and AEDAYA1 is 1, an RTCA1 alarm interrupt is generated. |

RTCSECA2 (0x15)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|---|---|---|---|---|---|
| Field | AESECA2 | SECA2[6:0] | | | | | | |
| Reset | 0b0 | 0b0000000 | | | | | | |
| Access Type | Write, Read | Write, Read | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AESECA2 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |
| SECA2 | 6:0 | RTC Seconds Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through 59. In BCD format, valid data for B6 through B4 are 0 through 5, and valid data for B3 through B0 are 0 through 9. |

RTCMINA2 (0x16)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|---|---|---|---|---|---|
| Field | AEMINA2 | MINA2[6:0] | | | | | | |
| Reset | 0b0 | 0b0000001 | | | | | | |
| Access Type | Write, Read | Write, Read | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AEMINA2 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b2 = Alarm enabled |
| MINA2 | 6:0 | RTC Minutes Alarm Register If the value of MINA2 is equal to the value of MIN and AEMINA2 is 1, an RTCA2 alarm interrupt is generated. RTC Minutes Counter Register In Binary format (BCD = 0), valid values for B6 through B0 are 0 through 59. In BCD format, valid data for B6 through B4 are 0 through 5, and valid data for B3 through B0 are 0 through 9. |

RTCHOURA2 (0x17)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|---|---|---|---|---|
| Field | AEHOURA2 | AMPMA2 | HOURA2[5:0] | | | | | |
| Reset | 0b0 | 0b0 | 0b000000 | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AEHOURA2 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |
| AMPM A2 | 6 | AM/PM Selection. AMPM is only valid when the clock is set for 12-hour mode (HRMODE = 0). When the clock is set for 24-hour mode, this bit is a don't care. 0b0 = AM 0b1 = PM |
| HOURA2 | 5:0 | RTC Hours Alarm Register If the value of HOURA2 is equal to the value of HOUR and AEHOURA2 is 1, an RTCA2 alarm interrupt is generated. RTC Hours Counter Register Note that there are two possibilities for values chosen for B5 through B0 depending on current status of HRMODE Bit: If HRMODE = 1 (24-Hour Mode) • Binary mode (BCD = 0): B5 is zero, and B4 through B0 valid values are 0 through 23. • BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 2, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 23). If HRMODE = 0 (12-Hour Mode) • Binary mode (BCD = 0): B5 and B4 are 0, and valid values for B3 through B0 are 1 through 12. • BCD mode (BCD = 1): Valid values for B5 through B4 are 0 through 1, and valid values for B3 through B0 are 0 through 9 (the full number does not exceed 12). |

RTCDOWA2 (0x18)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | AEDOWA2 | SATA2 | FRIA2 | THUA2 | WEDA2 | TUEA2 | MONA2 | SUNA2 |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b1 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AEDOWA2 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |
| SATA2 | 6 | RTC Day Of Week Alarm Register If the value of RTCDOWA2 is equal to the value of DOW and AEDOWA2 is 1, an RTCA2 alarm interrupt is generated. Bits B6 through B0 each represent one day of the week. As such, only one bit is set at a time. B[6:0] = 100_0000 represents Saturday |
| FRIA2 | 5 | B[6:0] = 010_0000 represents Friday |
| THUA2 | 4 | B[6:0] = 001_0000 represents Thursday |
| WEDA2 | 3 | B[6:0] = 000_1000 represents Wednesday |
| TUEA2 | 2 | B[6:0] = 000_0100 represents Tuesday |
| MONA2 | 1 | B[6:0] = 000_0010 represents Monday |
| SUNA2 | 0 | B[6:0] = 000_0001 represents Sunday |

RTCMONTHA2 (0x19)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|--------------|---|---|---|---|
| Field | AEMONA2 | RSVD | RSVD | MONTHA2[4:0] | | | | |
| Reset | 0b0 | 0b0 | 0b0 | 0b00000 | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | | | | |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------|
| AEMONA2 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled | 0: Alarm disable 1: Alarm enable |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. | |
| MONTHA2 | 4:0 | RTC Month Alarm Register If the value of MONTHA2 is equal to the value of MONTH and AEMONA2 is 1, an RTCA2 alarm interrupt is generated. | |

RTCYEARA2 (0x1A)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|---|---|---|---|---|---|
| Field | AEYEARA2 | YEARA2[6:0] | | | | | | |
| Reset | 0b0 | 0b0000000 | | | | | | |
| Access Type | Write, Read | Write, Read | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AEYEARA2 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |
| YEARA2 | 6:0 | RTC Year Alarm Register If the value of YEARA2 is equal to the value of YEAR and AEYEARA2 is 1, an RTCA2 alarm interrupt is generated. RTC Years Counter Register In Binary format (BDC = 0), valid values for B7 through B0 are 0 through 99. In BCD format (BCD = 1), valid data for B7 through B4 are 0 through 9, and similarly valid data for B3 through B0 are 0 through 9. |

RTCDOMA2 (0x1B)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|---|---|---|---|---|
| Field | AEDOMA2 | RSVD | DAYA2[5:0] | | | | | |
| Reset | 0b0 | 0b0 | 0b000000 | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| AEDOMA2 | 7 | Alarm Enable Control 0b0 = Alarm disabled 0b1 = Alarm enabled |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| DAYA2 | 5:0 | RTC Day Of Month Alarm 2 Register If the value of DAYA2 is equal to the value of DAY and AEDAYA2 is 1, an RTCA2 alarm interrupt is generated. |

RTC_TIME_OK (0x25)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RTC_TIME_OK |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 6 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 5 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 4 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 3 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 2 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 1 | There is no physical bit at this location. Write to 0. Reads are don't care. |
| RTC_TIME_OK | 0 | <p>RTC_TIME_OK bit can be used by the customer to use as a RTC data validity bit.</p> <p>This bit is by default 0, communicating that the RTC time keeping register data is either holding RESET default or holding a value which is not current.</p> <p>In the application, when the customer updates the time keeping register, they should write 1 to this bit and every time this bit is read and holds "1" implies that the RTC data is current/valid. If the VRTC < VRTCULO, then this bit is reset to 0.</p> |

PMIC-GPIO

| ADDRESS | NAME | MSB | | | | | | | LSB |
|---------------|----------------------------------------|----------------|----------------|----------------|----------------|----------------|------------------|----------------|----------------|
| CLOGIC | | | | | | | | | |
| 0x00 | INT_TOP[7:0] | IRQ_GL BL | IRQ_SD | IRQ_LD O | IRQ_GPI O | IRQ_RT C | RSVD | IRQ_ON OFF | IRQ |
| 0x01 | INT_MBATTRST_TEMP[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | MBATTR ESET_R | TJALRM 1_R | TJALRM 2_R |
| 0x02 | INT_LVL2_ONOFF[7:0] | RSVD | RSVD | ACOK_R | ACOK_F | EN0_R | EN0_F | EN0_1S EC | MRWRN |
| 0x03 | INT_LVL2_SD0_3[7:0] | SD0_OV _I | SD0_UV _I | SD1_OV _I | SD1_UV _I | SD2_OV _I | SD2_UV _I | SD3_OV _I | SD3_UV _I |
| 0x04 | INT_LVL2_L0_7[7:0] | IRQ_LVL 2_7 | IRQ_LVL 2_6 | IRQ_LVL 2_5 | IRQ_LVL 2_4 | IRQ_LVL 2_3 | IRQ_LVL 2_2 | IRQ_LVL 2_1 | IRQ_LVL 2_0 |

| ADDRESS | NAME | MSB | | | | | | | LSB |
|---------|-----------------------------------------|-----------------|------------------|----------------------|------------|------------------|------------------|-----------------|----------------|
| 0x05 | INT_LVL2_L8[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | IRQ_LVL2_8 |
| 0x06 | INT_LVL2_GPIO[7:0] | EDGE7 | EDGE6 | EDGE5 | EDGE4 | EDGE3 | EDGE2 | EDGE1 | EDGE0 |
| 0x07 | INT_TOPM[7:0] | IRQ_GLBLM | IRQ_SDM | IRQ_LDOM | IRQ_GPIOM | IRQ_RTCM | RSVD | IRQ_ONOFFM | GLBLM |
| 0x08 | INTM_MBATTRST_TEMP[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | MBATTRESETM | TJALRM1M | TJALRM2M |
| 0x09 | INTM_ONOFF[7:0] | RSVD | RSVD | ACOK_HIGHM | ACOK_LOWM | EN0_RM | EN0_FM | EN0_1SECM | MRWRNM |
| 0x0A | INTM_SD0_3[7:0] | SD0_OVM | SD0_UVM | SD1_OVM | SD1_UVM | SD2_OVM | SD2_UVM | SD3_OVM | SD3_UVM |
| 0x0B | INT_MSK_L0_7[7:0] | IRQ_MSK_L7 | IRQ_MSK_L6 | IRQ_MSK_L5 | IRQ_MSK_L4 | IRQ_MSK_L3 | IRQ_MSK_L2 | IRQ_MSK_L1 | IRQ_MSK_L0 |
| 0x0C | INT_MSK_L8[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | IRQ_MSK_L8 |
| 0x0D | STAT_MBATTRST_TEMP[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | MBATTRESET_S | TJALRM1 | TJALRM2 |
| 0x0E | STAT_ONOFF[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | EN0 | ACOK |
| 0x10 | POERC0[7:0] | RSTIN | MBU | MBO | MBLS | TOVLD | HDRST | WTCHDG | SHDN |
| 0x11 | POERC1[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | 32K_OK | BRDY_OK |
| 0x20 | STAT_SD0_3[7:0] | SD0_OVS | SD0_UVS | SD1_OVS | SD1_UVS | SD2_OVS | SD2_UVS | SD3_OVS | SD3_UVS |
| 0x30 | 32K_STATUS[7:0] | RSVD | RSVD | SIOSSK | XOSSK | 32KSOURCE | 32KLOAD[1:0] | | CRYSTAL_CONFIG |
| 0x31 | 32K_CONFIG[7:0] | RSVD | RSVD | RSVD | XOSC_RETRY | RSVD | PWR_MD_32k[1:0] | | 32KSOURCE_OTP |
| 0x90 | CNFG_GLBL1[7:0] | RSVD | MBLPD | MBATT_RESET_HYS[1:0] | | MBATT_RESET[2:0] | | | MBATT_RSTEN |
| 0x91 | CNFG_GLBL2[7:0] | RSVD | RSVD | RSVD | GLBL_LPM | WDTSLPC | WDTEN | TWD[1:0] | |
| 0x92 | CNFG_GLBL3[7:0] | RSVD | RSVD | RSVD | SRCFPS0 | ENFPS0 | SRCFPS1 | ENFPS1 | WDTC |
| 0x93 | CNFG1_ONOFF[7:0] | RSVD | SFT_RST | MRT[2:0] | | | SLPEN | PWR_OFF | ENODLY |
| 0x94 | CNFG2_ONOFF[7:0] | MR_RST_WK | SFT_RST_WK | WD_RST_WK | WK_AC_OK | WK_MB_ATT | WK_ALARM1R | WK_ALARM2R | WK_EN0 |
| 0x95 | MSTR_PU_PD[7:0] | RSVD | MSTR_PU[2:0] | | | RSVD | MSTR_PD[2:0] | | |
| 0x96 | MSTR_SLPEXTENT[7:0] | RSVD | MSTR_SLPEXT[2:0] | | | RSVD | MSTR_SLPEXT[2:0] | | |
| 0x97 | BUCK_PWR_MD[7:0] | PWR_MD_SD3[1:0] | | PWR_MD_SD2[1:0] | | PWR_MD_SD1[1:0] | | PWR_MD_SD0[1:0] | |
| 0x98 | LDO_PWR_MD0_3[7:0] | PWR_MD_L0[1:0] | | PWR_MD_L1[1:0] | | PWR_MD_L2[1:0] | | PWR_MD_L3[1:0] | |
| 0x99 | LDO_PWR_MD4_7[7:0] | PWR_MD_L4[1:0] | | PWR_MD_L5[1:0] | | PWR_MD_L6[1:0] | | PWR_MD_L7[1:0] | |
| 0x9A | LDO_PWR_MD8[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | PWR_MD_L8[1:0] | |
| 0x9B | LDO0FPS[7:0] | FPSSRC_L0[1:0] | | LDO0UPSLT[2:0] | | | LDO0DNSLT[2:0] | | |

| ADDRESS | NAME | MSB | | | | | | | LSB |
|-------------|--------------------------------|-------------------|------|-----------------|-----------------|------|----------------|--------------|-----------------|
| 0x9C | LDO1FPS[7:0] | FPSSRC_L1[1:0] | | | LDO1UPSLT[2:0] | | | | LDO1DNSLT[2:0] |
| 0x9D | LDO2FPS[7:0] | FPSSRC_L2[1:0] | | | LDO2UPSLT[2:0] | | | | LDO2DNSLT[2:0] |
| 0x9E | LDO3FPS[7:0] | FPSSRC_L3[1:0] | | | LDO3UPSLT[2:0] | | | | LDO3DNSLT[2:0] |
| 0x9F | LDO4FPS[7:0] | FPSSRC_L4[1:0] | | | LDO4UPSLT[2:0] | | | | LDO4DNSLT[2:0] |
| 0xA0 | LDO5FPS[7:0] | FPSSRC_L5[1:0] | | | LDO5UPSLT[2:0] | | | | LDO5DNSLT[2:0] |
| 0xA1 | LDO6FPS[7:0] | FPSSRC_L6[1:0] | | | LDO6UPSLT[2:0] | | | | LDO6DNSLT[2:0] |
| 0xA2 | LDO7FPS[7:0] | FPSSRC_L7[1:0] | | | LDO7UPSLT[2:0] | | | | LDO7DNSLT[2:0] |
| 0xA3 | LDO8FPS[7:0] | FPSSRC_L8[1:0] | | | LDO8UPSLT[2:0] | | | | LDO8DNSLT[2:0] |
| 0xA4 | SD0FPS[7:0] | FPSSRC_SD0[1:0] | | | SD0UPSLT[2:0] | | | | SD0DNSLT[2:0] |
| 0xA5 | SD1FPS[7:0] | FPSSRC_SD1[1:0] | | | SD1UPSLT[2:0] | | | | SD1DNSLT[2:0] |
| 0xA6 | SD2FPS[7:0] | FPSSRC_SD2[1:0] | | | SD2UPSLT[2:0] | | | | SD2DNSLT[2:0] |
| 0xA7 | SD3FPS[7:0] | FPSSRC_SD3[1:0] | | | SD3UPSLT[2:0] | | | | SD3DNSLT[2:0] |
| 0xA8 | GPIO0FPS[7:0] | FPSSRC_GPIO0[1:0] | | | GPIO0UPSLT[2:0] | | | | GPIO0DNSLT[2:0] |
| 0xA9 | GPIO1FPS[7:0] | FPSSRC_GPIO1[1:0] | | | GPIO1UPSLT[2:0] | | | | GPIO1DNSLT[2:0] |
| 0xAA | GPIO2FPS[7:0] | FPSSRC_GPIO2[1:0] | | | GPIO2UPSLT[2:0] | | | | GPIO2DNSLT[2:0] |
| 0xAB | GPIO7FPS[7:0] | FPSSRC_GPIO7[1:0] | | | GPIO7UPSLT[2:0] | | | | GPIO7DNSLT[2:0] |
| 0xAC | RSTIOFPS[7:0] | FPSSRC_RSTIO[1:0] | | | RST7UPSLT[2:0] | | | | RST7DNSLT[2:0] |
| OVERLAP | | | | | | | | | |
| BUCK | | | | | | | | | |
| 0x40 | SD0_CNFG1[7:0] | RSVD | | | | | | | SD0VOUT[6:0] |
| 0x41 | SD1_CNFG1[7:0] | RSVD | | | | | | | SD1VOUT[6:0] |
| 0x42 | SD2_CNFG1[7:0] | | | | | | | | SD2VOUT[7:0] |
| 0x43 | SD3_CNFG1[7:0] | | | | | | | | SD3VOUT[7:0] |
| 0x44 | SD0_CNFG2[7:0] | RSVD | RSVD | SD0_SS RAMP | RSVD | RSVD | SD0FSR EN | SD0ADD IS | SD0FPW MEN |
| 0x45 | SD0_CNFG3[7:0] | SD0_BO_THR[1:0] | | SD0_BO_HYS[1:0] | | RSVD | SD0_BO_PR[1:0] | | SD0_OV _THR |
| 0x46 | SD1_CNFG2[7:0] | RSVD | RSVD | SD1_SS RAMP | RSVD | RSVD | SD0FSR EN | SD0ADD IS | SD0FPW MEN |
| 0x47 | SD1_CNFG3[7:0] | SD1_BO_THR[1:0] | | SD1_BO_HYS[1:0] | | RSVD | SD1_BO_PR[1:0] | | SD1_OV _THR |
| 0x48 | SD2_CNFG2[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | SD2ADD IS | SD2FPW MEN |
| 0x49 | SD2_CNFG3[7:0] | SD2_BO_THR[1:0] | | SD2_BO_HYS[1:0] | | RSVD | SD2_BO_PR[1:0] | | SD2_OV _THR |
| 0x4A | SD3_CNFG2[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | SD3ADD IS | SD3FPW MEN |
| 0x4B | SD3_CNFG3[7:0] | SD3_BO_THR[1:0] | | SD3_BO_HYS[1:0] | | RSVD | SD3_BO_PR[1:0] | | SD3_OV _THR |
| OVERLAP | | | | | | | | | |

| ADDRESS | NAME | MSB | | | | | | | LSB |
|-------------|-----------------------------------|----------------------|----------------|------------------|------|--------|--------|--------|--------|
| LDO | | | | | | | | | |
| 0x50 | LDO_CNFG1_L0[7:0] | RSVD | RSVD | VOUT_LDO_L0[5:0] | | | | | |
| 0x51 | LDO_CNFG2_L0[7:0] | OVCLM P_EN_L 0 | ALPM_E N_L0 | RSVD | RSVD | POK_L0 | RSVD | ADE_L0 | SS_L0 |
| 0x52 | LDO_CNFG1_L1[7:0] | RSVD | RSVD | VOUT_LDO_L1[5:0] | | | | | |
| 0x53 | LDO_CNFG2_L1[7:0] | OVCLM P_EN_L 1 | ALPM_E N_L1 | RSVD | RSVD | POK_L1 | RSVD | ADE_L1 | SS_L1 |
| 0x54 | LDO_CNFG1_L2[7:0] | RSVD | RSVD | VOUT_LDO_L2[5:0] | | | | | |
| 0x55 | LDO_CNFG2_L2[7:0] | OVCLM P_EN_L 2 | ALPM_E N_L2 | COMP_L2[1:0] | | POK_L2 | RSVD | ADE_L2 | SS_L2 |
| 0x56 | LDO_CNFG1_L3[7:0] | RSVD | RSVD | VOUT_LDO_L3[5:0] | | | | | |
| 0x57 | LDO_CNFG2_L3[7:0] | OVCLM P_EN_L 3 | ALPM_E N_L3 | COMP_L3[1:0] | | POK_L3 | RSVD | ADE_L3 | SS_L3 |
| 0x58 | LDO_CNFG1_L4[7:0] | RSVD | RSVD | VOUT_LDO_L4[5:0] | | | | | |
| 0x59 | LDO_CNFG2_L4[7:0] | OVCLM P_EN_L 4 | ALPM_E N_L4 | COMP_L4[1:0] | | POK_L4 | RSVD | ADE_L4 | SS_L4 |
| 0x5A | LDO_CNFG1_L5[7:0] | RSVD | RSVD | VOUT_LDO_L5[5:0] | | | | | |
| 0x5B | LDO_CNFG2_L5[7:0] | OVCLM P_EN_L 5 | ALPM_E N_L5 | COMP_L5[1:0] | | POK_L5 | RSVD | ADE_L5 | SS_L5 |
| 0x5C | LDO_CNFG1_L6[7:0] | RSVD | RSVD | VOUT_LDO_L6[5:0] | | | | | |
| 0x5D | LDO_CNFG2_L6[7:0] | OVCLM P_EN_L 6 | ALPM_E N_L6 | COMP_L6[1:0] | | POK_L6 | RSVD | ADE_L6 | SS_L6 |
| 0x5E | LDO_CNFG1_L7[7:0] | RSVD | RSVD | VOUT_LDO_L7[5:0] | | | | | |
| 0x5F | LDO_CNFG2_L7[7:0] | OVCLM P_EN_L 7 | ALPM_E N_L7 | COMP_L7[1:0] | | POK_L7 | RSVD | ADE_L7 | SS_L7 |
| 0x60 | LDO_CNFG1_L8[7:0] | RSVD | RSVD | VOUT_LDO_L8[5:0] | | | | | |
| 0x61 | LDO_CNFG2_L8[7:0] | OVCLM P_EN_L 8 | ALPM_E N_L8 | RSVD[1:0] | | POK_L8 | RSVD | ADE_L8 | SS_L8 |
| 0x62 | LDO_CNFG3[7:0] | RSVD[6:0] | | | | | | | L_B_EN |
| OVERLAP | | | | | | | | | |
| GPIO | | | | | | | | | |
| 0x70 | CNFG_GPIO0[7:0] | DBNC0[1:0] | REFE_IRQ[1:0] | DO0 | DI0 | DIR0 | PPDRV0 | | |
| 0x71 | CNFG_GPIO1[7:0] | DBNC1[1:0] | REFE_IRQ[1:0] | DO1 | DI1 | DIR1 | PPDRV1 | | |
| 0x72 | CNFG_GPIO2[7:0] | DBNC2[1:0] | REFE_IRQ[1:0] | DO2 | DI2 | DIR2 | PPDRV2 | | |
| 0x73 | CNFG_GPIO3[7:0] | DBNC3[1:0] | REFE_IRQ[1:0] | DO3 | DI3 | DIR3 | PPDRV3 | | |
| 0x74 | CNFG_GPIO4[7:0] | DBNC4[1:0] | REFE_IRQ[1:0] | DO4 | DI4 | DIR4 | PPDRV4 | | |
| 0x75 | CNFG_GPIO5[7:0] | DBNC5[1:0] | REFE_IRQ[1:0] | DO5 | DI5 | DIR5 | PPDRV5 | | |
| 0x76 | CNFG_GPIO6[7:0] | DBNC6[1:0] | REFE_IRQ[1:0] | DO6 | DI6 | DIR6 | PPDRV6 | | |
| 0x77 | CNFG_GPIO7[7:0] | DBNC7[1:0] | REFE_IRQ[1:0] | DO7 | DI7 | DIR7 | PPDRV7 | | |

| ADDRESS | NAME | MSB | | | | | | | LSB |
|--------------|--------------------------------|------------|---------------|------------|------------|-----------|------|-------|--------|
| 0x78 | PUE_GPIO[7:0] | PUE7 | PUE6 | PUE5 | PUE4 | PUE3 | PUE2 | PUE1 | PUE0 |
| 0x79 | PDE_GPIO[7:0] | PDE7 | PDE6 | PDE5 | PDE4 | PDE3 | PDE2 | PDE1 | PDE0 |
| 0x7A | AME_GPIO[7:0] | AME7 | AME6 | AME5 | AME4 | AME3 | AME2 | AME1 | AME0 |
| OVERLAP | | | | | | | | | |
| SBIAS | | | | | | | | | |
| 0xB0 | CID0[7:0] | SR[7:0] | | | | | | | |
| 0xB1 | CID1[7:0] | SR[15:8] | | | | | | | |
| 0xB2 | CID2[7:0] | SR[23:16] | | | | | | | |
| 0xB3 | CID3[7:0] | DIDM[3:0] | | | | DIDO[3:0] | | | |
| 0xB4 | CID4[7:0] | DRV[7:0] | | | | | | | |
| BBC | | | | | | | | | |
| 0x80 | CNFG_BBC[7:0] | BBCRS[1:0] | BBCLO WIEN | BBCVS[1:0] | BBCCS[1:0] | BBCEN | | | |
| I2C | | | | | | | | | |
| 0xC0 | I2C_CTRL1[7:0] | RSVD | RSVD | RSVD | PAIR | RSVD | RSVD | WD_EN | HS_EXT |
| 0xC1 | I2C_CTRL2[7:0] | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | I2CWP |

Register Details

[INT_TOP \(0x00\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| Field | IRQ_GLBL | IRQ_SD | IRQ_LDO | IRQ_GPIO | IRQ_RTC | RSVD | IRQ_ONOFF | IRQ |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| IRQ_GLBL | 7 | 0 = No unmasked interrupts pending in the INT_MBATTRST_TEMP register. 1 = There are unmasked interrupts pending in the INT_MBATTRST_TEMP register. |
| IRQ_SD | 6 | 0 = No unmasked interrupts pending in the INT_LVL2_SD0_3 register. 1 = There are unmasked interrupts pending in the INT_LVL2_SD0_3 register. |
| IRQ_LDO | 5 | 0 = No unmasked interrupts pending in the INT_LVL2_L0_7 and INT_LVL2_L8 register. 1 = There are unmasked interrupts pending in the INT_LVL2_L0_7 and INT_LVL2_L8 register. |
| IRQ_GPIO | 4 | 0 = No unmasked interrupts pending in the IRQ_LVL2_GPIO register 1 = There are unmasked interrupts pending in the IRQ_LVL2_GPIO register |
| IRQ_RTC | 3 | 0 = No unmasked interrupts pending in the RTCINT register. 1 = There are unmasked interrupts pending in the RTCINT register. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| IRQ_ONOFF | 1 | 0 = No unmasked interrupts pending in the INT_LVL2_ONOFF register. 1 = There are unmasked interrupts pending in the INT_LVL2_ONOFF register. |
| IRQ | 0 | 0 = Unmasked gate drive is logic low. 1 = Unmasked gate drive is logic high. |

INT_MBATTRST_TEMP (0x01)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|-----------|-----------|-----------|-----------|-----------|------------------|---------------|---------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | MBATTRES ET_R | TJALRM1_ R | TJALRM2_ R |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| MBATTRESET_R | 2 | 0 = MBATT has not fallen below programmed MBATTRESET since the last time this bit was read. 1 = MBATT has fallen below programmed MBATTRESET since the last time this bit was read. |
| TJALRM1_R | 1 | 0 = T _J has not risen above TJALRM1 since the last time this bit was read. 1 = T _J has risen above TJALRM1 since the last time this bit was read. |
| TJALRM2_R | 0 | 0 = T _J has not risen above TJALRM2 since the last time this bit was read. 1 = T _J has risen above TJALRM2 since the last time this bit was read. |

INT_LVL2_ONOFF (0x02)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| Field | RSVD | RSVD | ACOK_R | ACOK_F | EN0_R | EN0_F | EN0_1SEC | MRWRN |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ACOK_R | 5 | 0 = No ACOK rising edges have occurred since the last time this bit was read. 1 = An ACOK rising edge has occurred since the last time this bit was read. |
| ACOK_F | 4 | 0 = No ACOK falling edges have occurred since the last time this bit was read. 1 = An ACOK falling edge has occurred since the last time this bit was read. |
| EN0_R | 3 | 0 = No EN0 rising edges have occurred since the last time this bit was read. 1 = An EN0 rising edge has occurred since the last time this bit was read. |
| EN0_F | 2 | 0 = No EN0 falling edges have occurred since the last time this bit was read. 1 = An EN0 falling edge has occurred since the last time this bit was read. |
| EN0_1SEC | 1 | 0 = EN0 has not been active for 1 second since the last time this bit was read. 1 = EN0 has been active for 1 second since the last time this bit was read. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MRWRN | 0 | The time for the hard power off warning is one setting shorter than what is programmed by MRT[2:0]. When MRT[2:0] = 0b000, MRWRN is essentially a don't care. 0 = EN0 has not been active for MRT[2:0]-1 since the last time this bit was read. 1 = EN0 has been active for MRT[2:0]-1 since the last time this bit was read. |

INT_LVL2_SD0_3 (0x03)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| Field | SD0_OV_I | SD0_UV_I | SD1_OV_I | SD1_UV_I | SD2_OV_I | SD2_UV_I | SD3_OV_I | SD3_UV_I |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All | Read Clears All |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD0_OV_I | 7 | 0 = SD0 output HAS NOT risen above the rising OV threshold since the last time this bit was read. 1 = SD0 output HAS risen above the rising OV threshold since the last time this bit was read. |
| SD0_UV_I | 6 | 0 = SD0 was enabled and SD0 output HAS NOT fallen below the falling UV threshold since the last time this bit was read, OR, SD1 was disabled. 1 = SD0 was enabled and SD0 output HAS fallen below the falling UV threshold since the last time this bit was read. |
| SD1_OV_I | 5 | 0 = SD1 output HAS NOT risen above the rising OV threshold since the last time this bit was read. 1 = SD1 output HAS risen above the rising OV threshold since the last time this bit was read. |
| SD1_UV_I | 4 | 0 = SD1 was enabled and SD1 output HAS NOT fallen below the falling UV threshold since the last time this bit was read, OR, SD1 was disabled. 1 = SD1 was enabled and SD1 output HAS fallen below the falling UV threshold since the last time this bit was read. |
| SD2_OV_I | 3 | 0 = SD2 output HAS NOT risen above the rising OV threshold since the last time this bit was read. 1 = SD2 output HAS risen above the rising OV threshold since the last time this bit was read. |
| SD2_UV_I | 2 | 0 = SD2 was enabled and SD2 output HAS NOT fallen below the falling UV threshold since the last time this bit was read, OR, SD2 was disabled. 1 = SD2 was enabled and SD2 output HAS fallen below the falling UV threshold since the last time this bit was read. |
| SD3_OV_I | 1 | 0 = SD3 output HAS NOT risen above the rising OV threshold since the last time this bit was read. 1 = SD3 output HAS risen above the rising OV threshold since the last time this bit was read. |
| SD3_UV_I | 0 | 0 = SD3 was enabled and SD3 output HAS NOT fallen below the falling UV threshold since the last time this bit was read, OR, SD3 was disabled. 1 = SD3 was enabled and SD3 output HAS fallen below the falling UV threshold since the last time this bit was read. |

[INT_LVL2_L0_7 \(0x04\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|------------|------------|------------|------------|------------|------------|------------|------------|
| Field | IRQ_LVL2_7 | IRQ_LVL2_6 | IRQ_LVL2_5 | IRQ_LVL2_4 | IRQ_LVL2_3 | IRQ_LVL2_2 | IRQ_LVL2_1 | IRQ_LVL2_0 |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|------------------------------------------------------------------------------------------------------------------------------|
| IRQ_LVL2_7 | 7 | 1: An interrupt has occurred. Cleared when read. 0: No interrupt has occurred since the last time this register was read. |
| IRQ_LVL2_6 | 6 | 1: An interrupt has occurred. Cleared when read. 0: No interrupt has occurred since the last time this register was read. |
| IRQ_LVL2_5 | 5 | 1: An interrupt has occurred. Cleared when read. 0: No interrupt has occurred since the last time this register was read. |
| IRQ_LVL2_4 | 4 | 1: An interrupt has occurred. Cleared when read. 0: No interrupt has occurred since the last time this register was read. |
| IRQ_LVL2_3 | 3 | 1: An interrupt has occurred. Cleared when read. 0: No interrupt has occurred since the last time this register was read. |
| IRQ_LVL2_2 | 2 | 1: An interrupt has occurred. Cleared when read. 0: No interrupt has occurred since the last time this register was read. |
| IRQ_LVL2_1 | 1 | 1: An interrupt has occurred. Cleared when read. 0: No interrupt has occurred since the last time this register was read. |
| IRQ_LVL2_0 | 0 | 1: An interrupt has occurred. Cleared when read. 0: No interrupt has occurred since the last time this register was read. |

[INT_LVL2_L8 \(0x05\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | IRQ_LVL2_8 |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 1 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| IRQ_LVL2_8 | 0 | 1: An interrupt has occurred. Cleared when read. 0: No interrupt has occurred since the last time this register was read. |

INT_LVL2_GPIO (0x06)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | EDGE7 | EDGE6 | EDGE5 | EDGE4 | EDGE3 | EDGE2 | EDGE1 | EDGE0 |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| EDGE7 | 7 | GPIOx Edge Detection Interrupt 0 = No edges have been detected on GPIOx since the last time this bit was read. 1 = An edge corresponding to REFE_IRQx has been detected on GPIOx since the last time this bit was read. Note that REFE_IRQx = 0b00 sets an interrupt mask which forces EDGE _x to 0. |
| EDGE6 | 6 | GPIOx Edge Detection Interrupt 0 = No edges have been detected on GPIOx since the last time this bit was read. 1 = An edge corresponding to REFE_IRQx has been detected on GPIOx since the last time this bit was read. Note that REFE_IRQx = 0b00 sets an interrupt mask which forces EDGE _x to 0. |
| EDGE5 | 5 | GPIOx Edge Detection Interrupt 0 = No edges have been detected on GPIOx since the last time this bit was read. 1 = An edge corresponding to REFE_IRQx has been detected on GPIOx since the last time this bit was read. Note that REFE_IRQx = 0b00 sets an interrupt mask which forces EDGE _x to 0. |
| EDGE4 | 4 | GPIOx Edge Detection Interrupt 0 = No edges have been detected on GPIOx since the last time this bit was read. 1 = An edge corresponding to REFE_IRQx has been detected on GPIOx since the last time this bit was read. Note that REFE_IRQx = 0b00 sets an interrupt mask which forces EDGE _x to 0. |
| EDGE3 | 3 | GPIOx Edge Detection Interrupt 0 = No edges have been detected on GPIOx since the last time this bit was read. 1 = An edge corresponding to REFE_IRQx has been detected on GPIOx since the last time this bit was read. Note that REFE_IRQx = 0b00 sets an interrupt mask which forces EDGE _x to 0. |
| EDGE2 | 2 | GPIOx Edge Detection Interrupt 0 = No edges have been detected on GPIOx since the last time this bit was read. 1 = An edge corresponding to REFE_IRQx has been detected on GPIOx since the last time this bit was read. Note that REFE_IRQx = 0b00 sets an interrupt mask which forces EDGE _x to 0. |
| EDGE1 | 1 | GPIOx Edge Detection Interrupt 0 = No edges have been detected on GPIOx since the last time this bit was read. 1 = An edge corresponding to REFE_IRQx has been detected on GPIOx since the last time this bit was read. Note that REFE_IRQx = 0b00 sets an interrupt mask which forces EDGE _x to 0. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| EDGE0 | 0 | GPIOx Edge Detection Interrupt 0 = No edges have been detected on GPIOx since the last time this bit was read. 1 = An edge corresponding to REFE_IRQx has been detected on GPIOx since the last time this bit was read. Note that REFE_IRQx = 0b00 sets an interrupt mask which forces EDGE _x to 0. |

INT_TOPM (0x07)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|-----------|-----------|-----------|-----------|-----------|------------|-----------|
| Field | IRQ_GLBLM | IRQ_SDM | IRQ_LDOM | IRQ_GPIOM | IRQ_RTCM | RSVD | IRQ_ONOFFM | GLBLM |
| Reset | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 | 0b0 | 0b1 | 0b1 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| IRQ_GLBLM | 7 | IRQ_GLBLM blocks the interrupts from the global resources (INTLBT register) from affecting the nIRQ pin. Be careful not to confuse IRQ_GLBLM with GLBLM. GLBLM blocks all interrupts from affecting the nIRQ pin. 0 = Unmasked 1 = Masked |
| IRQ_SDM | 6 | 0 = Unmasked 1 = Masked |
| IRQ_LDOM | 5 | 0 = Unmasked 1 = Masked |
| IRQ_GPIOM | 4 | 0 = Unmasked 1 = Masked |
| IRQ_RTCM | 3 | 0 = Unmasked 1 = Masked |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| IRQ_ONOFFM | 1 | 0 = Unmasked 1 = Masked |
| GLBLM | 0 | IRQ_GLBLM blocks the interrupts from the global resources (INT_MBATTRST_TEMP register) from affecting the nIRQ pin. Be careful not to confuse IRQ_GLBLM with GLBLM. GLBLM blocks all interrupts from affecting the nIRQ. 0 = Unmasked 1 = Masked |

INTM_MBATTRST_TEMP (0x08)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|-----------|-----------|-----------|-----------|--------------|-----------|-----------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | MBATTRES ETM | TJALRM1M | TJALRM2M |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b1 | 0b1 | 0b1 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|-------------------------------------------------------------|
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| MBATTRESETM | 2 | 0 = Unmasked 1 = Masked |
| TJALRM1M | 1 | 0 = Unmasked 1 = Masked |
| TJALRM2M | 0 | 0 = Unmasked 1 = Masked |

INTM_ONOFF (0x09)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-----------|-----------|----------------|---------------|-----------|-----------|---------------|-----------|
| Field | RSVD | RSVD | ACOK_HIG HM | ACOK_LO WM | EN0_RM | EN0_FM | EN0_1SEC M | MRWRNM |
| Reset | 0b0 | 0b0 | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|-------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ACOK_HIGHM | 5 | 0 = Unmasked 1 = Masked |
| ACOK_LOWM | 4 | 0 = Unmasked 1 = Masked |
| EN0_RM | 3 | 0 = Unmasked 1 = Masked |
| EN0_FM | 2 | 0 = Unmasked 1 = Masked |
| EN0_1SECM | 1 | 0 = Unmasked 1 = Masked |
| MRWRNM | 0 | 0 = Unmasked 1 = Masked |

INTM_SD0_3 (0x0A)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | SD0_OV_M | SD0_UV_M | SD1_OV_M | SD1_UV_M | SD2_OV_M | SD2_UV_M | SD3_OV_M | SD3_UV_M |
| Reset | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD0_OV_M | 7 | 0 = During an output over-voltage event, SD0_OV_I is set to 1. nIRQ is driven low due to an output over-voltage event. 1 = During an output over-voltage event, SD0_OV_I is set to 1. nIRQ is not driven low due to an output over-voltage event. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD0_UV_M | 6 | 0 = During an output under-voltage event, SD0_UV_I is set to 1. nIRQ is driven low due to an output under-voltage event. 1 = During an output under-voltage event, SD0_UV_I is set to 1. nIRQ is not driven low due to an output under-voltage event. |
| SD1_OV_M | 5 | 0 = During an output over-voltage event, SD1_OV_I is set to 1. nIRQ is driven low due to an output over-voltage event. 1 = During an output over-voltage event, SD1_OV_I is set to 1. nIRQ is not driven low due to an output over-voltage event. |
| SD1_UV_M | 4 | 0 = During an output under-voltage event, SD1_UV_I is set to 1. nIRQ is driven low due to an output under-voltage event. 1 = During an output under-voltage event, SD1_UV_I is set to 1. nIRQ is not driven low due to an output under-voltage event. |
| SD2_OV_M | 3 | 0 = During an output over-voltage event, SD2_OV_I is set to 1. nIRQ is driven low due to an output over-voltage event. 1 = During an output over-voltage event, SD2_OV_I is set to 1. nIRQ is not driven low due to an output over-voltage event. |
| SD2_UV_M | 2 | 0 = During an output under-voltage event, SD2_UV_I is set to 1. nIRQ is driven low due to an output under-voltage event. 1 = During an output under-voltage event, SD2_UV_I is set to 1. nIRQ is not driven low due to an output under-voltage event. |
| SD3_OV_M | 1 | 0 = During an output over-voltage event, SD3_OV_I is set to 1. nIRQ is driven low due to an output over-voltage event. 1 = During an output over-voltage event, SD3_OV_I is set to 1. nIRQ is not driven low due to an output over-voltage event. |
| SD3_UV_M | 0 | 0 = During an output under-voltage event, SD3_UV_I is set to 1. nIRQ is driven low due to an output under-voltage event. 1 = During an output under-voltage event, SD3_UV_I is set to 1. nIRQ is not driven low due to an output under-voltage event. |

INT_MSK_L0_7 (0x0B)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | IRQ_MSK_L7 | IRQ_MSK_L6 | IRQ_MSK_L5 | IRQ_MSK_L4 | IRQ_MSK_L3 | IRQ_MSK_L2 | IRQ_MSK_L1 | IRQ_MSK_L0 |
| Reset | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 | 0b1 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|-----------------------------------------------------------------------------------------------------|
| IRQ_MSK_L7 | 7 | 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. |
| IRQ_MSK_L6 | 6 | 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. |
| IRQ_MSK_L5 | 5 | 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. |
| IRQ_MSK_L4 | 4 | 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. |
| IRQ_MSK_L3 | 3 | 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|-----------------------------------------------------------------------------------------------------|
| IRQ_MSK_L2 | 2 | 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. |
| IRQ_MSK_L1 | 1 | 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. |
| IRQ_MSK_L0 | 0 | 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. |

INT_MSK_L8 (0x0C)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | IRQ_MSK_L8 |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b1 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|-----------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 1 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| IRQ_MSK_L8 | 0 | 1: Interrupt is masked and nIRQ is not driven low due to an LDO event. 0: Interrupt is unmasked. |

STAT_MBATTRST_TEMP (0x0D)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|-----------|-----------|-----------|-----------|------------------|-----------|-----------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | MBATTRES ET_S | TJALRM1 | TJALRM2 |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|----------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| MBATTRESET_S | 2 | 0 = $V_{MBATT} > V_{MBATTRESET}$ 1 = $V_{MBATT} < V_{MBATTRESET}$ |
| TJALRM1 | 1 | 0 = $T_J < TJ120$ 1 = $T_J > TJ120$ |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------|
| TJALRM2 | 0 | 0 = $T_J < T_{J140}$ 1 = $T_J > T_{J140}$ |

STAT_ONOFF (0x0E)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | EN0 | ACOK |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| EN0 | 1 | For OTP_EN0AL = 0 0 = EN0 is not active (logic low). 1 = EN0 is active (logic high). For OTP_EN0AL = 1 0 = EN0 is not active (logic high). 1 = EN0 is active (logic low). |
| ACOK | 0 | For OTP_ACOKAL = 0 0 = ACOK is not active (logic low). 1 = ACOK is active (logic high). For OTP_ACOKAL = 1 0 = ACOK is not active (logic high). 1 = ACOK is active (logic low). |

POERC0 (0x10)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| Field | RSTIN | MBU | MBO | MBLSD | TOVLD | HDRST | WTCHDG | SHDN |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSTIN | 7 | 0 = The reset input signal (RSI) did not cause a global shutdown. 1 = The reset input signal (RSI) caused a global shutdown. |
| MBU | 6 | 0 = Main battery undervoltage event did not cause a global shutdown. 1 = The main battery caused a global shutdown by falling below its UVLO threshold ($V_{MBATT} < V_{MBATTUVLO}$). If the sudden momentary power loss (SMPL) function is enabled, the PMIC can automatically recover from a momentary power loss. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MBO | 5 | 0 = Main battery overvoltage event did not cause a global shutdown. 1 = The main battery caused a global shutdown by rising above its OVLO threshold ($V_{MBATT} < V_{MBATTOVLO}$). |
| MBLSD | 4 | 0 = Main battery low did not cause a global shutdown. 1 = Main battery low caused a global shutdown because MBLPD is set and $V_{MBATT} < V_{MBATTRESET}$. |
| TOVLD | 3 | 0 = The junction temperature did not cause a global shutdown. 1 = The junction temperature caused a global shutdown by rising above T_{JSHDN} . |
| HDRST | 2 | 0 = The hard-reset function did not cause a global shutdown. 1 = The hard-reset function caused a global shutdown. |
| WTCHDG | 1 | 0 = The system watchdog timer did not cause a global shutdown. 1 = The system watchdog timer caused a global shutdown. |
| SHDN | 0 | 0 = The shutdown pin did not cause a global shutdown. 1 = The shutdown pin caused a global shutdown. |

POERC1 (0x11)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|------------------------|------------------------|------------------------|------------------------|------------------------|------------------------|------------------------|------------------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | 32K_OK | BRDY_OK |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write Clears All, Read | Write Clears All, Read | Write Clears All, Read | Write Clears All, Read | Write Clears All, Read | Write Clears All, Read | Write Clears All, Read | Write Clears All, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| 32K_OK | 1 | Write 1 to clear 0 = The 32kHz oscillator did not cause a global shutdown. 1 = The 32kHz oscillator caused a global shutdown. |
| BRDY_OK | 0 | Write 1 to clear 0 = The BRDY did not cause a global shutdown. 1 = The BRDY caused a global shutdown. |

STAT_SD0_3 (0x20)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| Field | SD0_OV_S | SD0_UV_S | SD1_OV_S | SD1_UV_S | SD2_OV_S | SD2_UV_S | SD3_OV_S | SD3_UV_S |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|------------------------------------------------------------------------------------------------------------------------|
| SD0_OV_S | 7 | 0 = SD0 output HAS NOT risen above the rising OV threshold. 1 = SD0 output HAS risen above the rising OV threshold. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD0_UV_S | 6 | 0 = SD0 is enabled and SD1 output HAS NOT fallen below the falling UV threshold OR, SD0 is disabled. 1 = SD0 is enabled and SD1 output HAS fallen below the falling UV threshold. |
| SD1_OV_S | 5 | 0 = SD1 output HAS NOT risen above the rising OV threshold. 1 = SD1 output HAS risen above the rising OV threshold. |
| SD1_UV_S | 4 | 0 = SD1 is enabled and SD1 output HAS NOT fallen below the falling UV threshold OR, SD1 is disabled. 1 = SD1 is enabled and SD1 output HAS fallen below the falling UV threshold. |
| SD2_OV_S | 3 | 0 = SD2 output HAS NOT risen above the rising OV threshold. 1 = SD2 output HAS risen above the rising OV threshold. |
| SD2_UV_S | 2 | 0 = SD2 is enabled and SD2 output HAS NOT fallen below the falling UV threshold OR, SD2 is disabled. 1 = SD2 is enabled and SD2 output HAS fallen below the falling UV threshold. |
| SD3_OV_S | 1 | 0 = SD3 output HAS NOT risen above the rising OV threshold. 1 = SD3 output HAS risen above the rising OV threshold. |
| SD3_UV_S | 0 | 0 = SD3 is enabled and SD3 output HAS NOT fallen below the falling UV threshold OR, SD3 is disabled. 1 = SD3 is enabled and SD3 output HAS fallen below the falling UV threshold. |

32K_STATUS (0x30)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------|-----------|-----------|-----------|-----------|--------------|---|----------------|
| Field | RSVD | RSVD | SIOSCOK | XOSCOK | 32KSOURCE | 32KLOAD[1:0] | | CRYSTAL_CONFIG |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b10 | | 0b0 |
| Access Type | Read Only | Read Only | Read Only | Read Only | Read Only | Read Only | | Read Only |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| SIOSCOK | 5 | Silicon Oscillator OK Indicator 0 = The silicon oscillator is disabled or the clock is not yet stable. 1 = The silicon oscillator is enabled and is generating a clock. During normal operation this bit is interchangeable with 32KSOURCE. The values may differ when transitioning between silicon and crystal oscillators. |
| XOSCOK | 4 | Crystal Oscillator OK Indicator 0 = The crystal oscillator is not generating a valid clock. 1 = The crystal oscillator is generating a valid clock. |
| 32KSOURCE | 3 | Primary Source of Internal Oscillator 0 = XOSC is the primary source for 32kHz oscillator (silicon oscillator is used initially to get the PMIC up and running while the XOSC is settling). 1 = Silicon oscillator is used as the primary source for 32K oscillator. |
| 32KLOAD | 2:1 | Internal Crystal Load Capacitance 0b00 = None 0b01 = 10pF 0b10 = 12pF 0b11 = 22pF |

| BITFIELD | BITS | DESCRIPTION |
|----------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CRYSTAL_CONFIG | 0 | Primary Oscillator Clock Source Indicator 0 = Normal mode. Oscillator is generating the clock from a crystal on XIN and XOUT or silicon oscillator. 1 = Bypass mode. Oscillator is deriving the clock from an external clock driving XIN. |

32K_CONFIG (0x31)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-----------------|---|---------------|
| Field | RSVD | RSVD | RSVD | XOSC_RETRY | RSVD | PWR_MD_32k[1:0] | | 32KSOURCE_OTP |
| Reset | 0b0 | 0b0 | 0b0 | 0b1 | 0b0 | OTP | | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|---------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| XOSC_RETRY | 4 | Crystal Oscillator Retry When the system is operating with the backup silicon oscillator and the crystal oscillator is stable (XOSCOK = 1), setting this bit causes the system to switch back to the crystal oscillator. If the crystal oscillator is not stable (XOSCOK = 0) or the system is already using the crystal oscillator, setting this bit has no effect. This bit clears after the operation is complete. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| PWR_MD_32k | 2:1 | 32kHz Oscillator Mode of Operation 0b00 = Low-power mode 0b01 = Global low-power mode. The oscillator operates in low-jitter mode when the global low-power mode signal is low. When the global low-power mode signal is high, the oscillator operates in low-power mode. 0b10 = Same as 0b00 0b11 = Low-jitter mode |
| 32KSOURCE_OTP | 0 | Primary Source of Internal Oscillator 0 = XOSC is the primary source for 32kHz oscillator (silicon oscillator is used initially to get the PMIC up and running while the XOSC is settling) 1 = Silicon oscillator is used as the primary source for 32kHz oscillator |

CNFG_GLBL1 (0x90)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|----------------------|---|------------------|---|---|---------------|
| Field | RSVD | MBLPD | MBATT_RESET_HYS[1:0] | | MBATT_RESET[2:0] | | | MBATT_RESETEN |
| Reset | 0b0 | OTP | OTP | | OTP | | | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | | Write, Read | | | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |

| BITFIELD | BITS | DESCRIPTION |
|-----------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MBLPD | 6 | 0 = MBATT < MBATT_RESET falling (MBATTLOWB) does not cause a global shutdown. 1 = MBATT < MBATT_RESET falling (MBATTLOWB) forces a global shutdown. |
| MBATT_RESET_HYS | 5:4 | 0x00 = 100mV 0x02 = 300mV 0x01 = 200mV 0x03 = 400mV |
| MBATT_RESET | 3:1 | 0b000 = 2.7V 0b100 = 3.1V 0b001 = 2.8V 0b101 = 3.2V 0b010 = 2.9V 0b110 = 3.3V 0b011 = 3.0V 0b111 = 3.4V |
| MBATT_RSTEN | 0 | 0 = The low-battery monitor only generates the MBATT < MBATT_RESET status bit and the MBATTRESET_R interrupt bit. 1 = In addition to the bits mentioned above, the low-battery monitor also pulls nRST_IO low. |

CNFG_GLBL2 (0x91)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|---|
| Field | RSVD | RSVD | RSVD | GLBL_LPM | WDTSLPC | WDTEN | TWD[1:0] | |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b11 | |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| GLBL_LPM | 4 | 0 = The global low-power mode signal is logic low. Devices that have been programmed to follow the global low-power mode signal operates in their normal power modes. 1 = The global low-power mode signal is logic high. Devices that have been programmed to follow the global low-power mode signal operates in their low-power modes. |
| WDTSLPC | 3 | 0 = The system watchdog timer does not automatically clear in the sleep state. 1 = The system watchdog timer automatically clears in the sleep state. |
| WDTEN | 2 | 0 = System watchdog timer disabled 1 = System watchdog timer enabled If OTP_WDTEN = 0, then WDTEN can be changed at any time. If OTP_WDTEN = 1, then once WDTEN is set, the watchdog timer cannot be disabled by clearing WDTEN. Once enabled, the system watchdog timer runs until a global shutdown occurs. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TWD | 1:0 | 0b00 = 2s 0b01 = 16s 0b10 = 64s 0b11 = 128s If OTP_WDTT = 0, then TWD can be changed at any time. If the value of TWD needs to be changed, clear the system watchdog timer first (WDTC[1:0] = 0b01), then change the value of TWD. If OTP_WDTT = 1, then TWD can only be changed when WDTC = 0. |

CNFG_GLBL3 (0x92)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | SRCFPS0 | ENFPS0 | SRCFPS1 | ENFPS1 | WDTC |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| SRCFPS0 | 4 | 0b0 = EN0 hardware input 0b1 = ENFPS0 software bit |
| ENFPS0 | 3 | 0 = Disable FPS0 1 = Enable FPS0 ENFPS0 is a don't care if SRCFPS0 = 0 |
| SRCFPS1 | 2 | 0b0 = EN1 hardware input 0b1 = ENFPS1 software bit |
| ENFPS1 | 1 | 0 = Disable FPS1 1 = Enable FPS1 ENFPS1 is a don't care if SRCFPS1 = 0 |
| WDTC | 0 | Writing 0b1 to these bits clears the watchdog timer. These bits automatically reset to 0b0 after they are written to 0b1. 0b0 = The system watchdog timer is not cleared. 0b1 = The system watchdog timer is cleared. |

CNFG1_ONOFF (0x93)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|---|---|-------------|-------------|-------------|
| Field | RSVD | SFT_RST | MRT[2:0] | | | SLPEN | PWR_OFF | ENODLY |
| Reset | 0b0 | 0x0 | OTP | | | 0b0 | 0b0 | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | | | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SFT_RST | 6 | 0 = No action 1 = Generates a global shutdown event that initiates the FPS0 and FPS1 power-down event and generates a reset. If both SFT_RST and PWR_OFF are set, the resulting action is SFT_RST. This bit self clears at the end of the global shutdown event. |
| MRT | 5:3 | 3b000 = 2s 3b001 = 3s 3b010 = 4s 3b011 = 5s 3b100 = 6s 3b101 = 8s 3b110 = 10s 3b111 = 12s |
| SLPEN | 2 | 0 = Pulling EN1 low does not place the AP into sleep mode. 1 = Pulling EN1 low places the AP into sleep mode. |
| PWR_OFF | 1 | 0 = No action 1 = Generates a global shutdown event that initiates the FPS0 and FPS1 power-down event but does not generate a reset. Note that PWR_OFF is cleared at the end of any global shutdown event that it generates. |
| ENODLY | 0 | 0 = The only delay for EN0 is the debounce circuit. 1 = In addition to the debounce circuit, there is an addition 1 second delay for EN0. |

CNFG2_ONOFF (0x94)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | MR_RST_WK | SFT_RST_WK | WD_RST_WK | WK_ACOK | WK_MBATT | WK_ALARM1R | WK_ALARM2R | WK_EN0 |
| Reset | OTP | 0b1 | 0b0 | 0b0 | OTP | 0b1 | 0b1 | 0b1 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MR_RST_WK | 7 | 0 = An MR_RST event does not generate a wakeup signal (device resides in standby state). 1 = An MR_RST event generates a wakeup signal (device moves to ON state)". |
| SFT_RST_WK | 6 | 0 = An SFT_RST event does not generate a wakeup signal (device resides in standby state). 1 = An SFT_RST event generates a wakeup signal (device moves to ON state). |
| WD_RST_WK | 5 | 0 = An WD_RST event does not generate a wakeup signal (device resides in standby state). 1 = An WD_RST event generates a wakeup signal (device moves to ON state). |
| WK_ACOK | 4 | 0 = An ACOK event does not generate a wakeup signal. 1 = An ACOK event generates a wakeup signal. |
| WK_MBATT | 3 | 0 = A valid MBATT event does not generate a wakeup signal. 1 = A valid MBATT event generates a wakeup signal. |
| WK_ALARM1R | 2 | 0 = An ALARM1_R event does not generate a wakeup signal. 1 = An ALARM1_R event generates a wakeup signal. |
| WK_ALARM2R | 1 | 0 = An ALARM2_R event does not generate a wakeup signal. 1 = An ALARM2_R event generates a wakeup signal. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------|
| WK_EN0 | 0 | 0 = An EN0 event does not generate a wakeup signal. 1 = An EN0 event generates a wakeup signal. |

MSTR_PU_PD (0x95)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|--------------|---|---|-------------|--------------|---|---|
| Field | RSVD | MSTR_PU[2:0] | | | RSVD | MSTR_PD[2:0] | | |
| Reset | 0b0 | OTP | | | 0b0 | OTP | | |
| Access Type | Write, Read | Write, Read | | | Write, Read | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| MSTR_PU | 6:4 | 3'b000 = 31μs 3'b001 = 63μs 3'b010 = 127μs 3'b011 = 253μs 3'b100 = 508μs 3'b101 = 984μs 3'b110 = 1936μs 3'b111 = 3904μs |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| MSTR_PD | 2:0 | 3'b000 = 31μs 3'b001 = 63μs 3'b010 = 127μs 3'b011 = 253μs 3'b100 = 508μs 3'b101 = 984μs 3'b110 = 1936μs 3'b111 = 3904μs |

MSTR_SLPENTRY_EXIT (0x96)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|--------------------|---|---|-------------|------------------|---|---|
| Field | RSVD | MSTR_SLPENTRY[2:0] | | | RSVD | MSTR_SLPEXT[2:0] | | |
| Reset | 0b0 | OTP | | | 0b0 | OTP | | |
| Access Type | Write, Read | Write, Read | | | Write, Read | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|---------------|------|----------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| MSTR_SLPENTRY | 6:4 | 3'b000 = 31μs 3'b001 = 63μs 3'b010 = 127μs 3'b011 = 253μs 3'b100 = 508μs 3'b101 = 984μs 3'b110 = 1936μs 3'b111 = 3904μs |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MSTR_SLPEXT | 2:0 | 3'b000 = 31 μ s 3'b001 = 63 μ s 3'b010 = 127 μ s 3'b011 = 253 μ s 3'b100 = 508 μ s 3'b101 = 984 μ s 3'b110 = 1936 μ s 3'b111 = 3904 μ s |

BUCK_PWR_MD (0x97)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------|---|-----------------|---|-----------------|---|-----------------|---|
| Field | PWR_MD_SD3[1:0] | | PWR_MD_SD2[1:0] | | PWR_MD_SD1[1:0] | | PWR_MD_SD0[1:0] | |
| Reset | OTP | | OTP | | OTP | | OTP | |
| Access Type | Write, Read | | Write, Read | | Write, Read | | Write, Read | |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|---------------------------------------------------------------------------------------------------------------------|
| PWR_MD_SD3 | 7:6 | 0b00 = Output disabled 0b01 = Global low-power mode 0b10 = Forced low-power mode 0b11 = Forced normal-mode |
| PWR_MD_SD2 | 5:4 | 0b00 = Output disabled 0b01 = Global low-power mode 0b10 = Forced low-power mode 0b11 = Forced normal-mode |
| PWR_MD_SD1 | 3:2 | 0b00 = Output disabled 0b01 = Global low-power mode 0b10 = Forced low-power mode 0b11 = Forced normal-mode |
| PWR_MD_SD0 | 1:0 | 0b00 = Output disabled 0b01 = Global low-power mode 0b10 = Forced low-power mode 0b11 = Forced normal-mode |

LDO_PWR_MD0_3 (0x98)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|----------------|---|----------------|---|
| Field | PWR_MD_L0[1:0] | | PWR_MD_L1[1:0] | | PWR_MD_L2[1:0] | | PWR_MD_L3[1:0] | |
| Reset | OTP | | OTP | | OTP | | OTP | |
| Access Type | Write, Read | | Write, Read | | Write, Read | | Write, Read | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PWR_MD_L0 | 7:6 | <p>When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal Mode. LDOx is forced into its normal operating mode.</p> <p>When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.</p> |
| PWR_MD_L1 | 5:4 | <p>When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-Power Mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.</p> <p>When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.</p> |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PWR_MD_L2 | 3:2 | <p>When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-Power Mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.</p> <p>When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.</p> |
| PWR_MD_L3 | 1:0 | <p>When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-Power Mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.</p> <p>When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.</p> |

LDO_PWR_MD4_7 (0x99)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|----------------|---|----------------|---|
| Field | PWR_MD_L4[1:0] | | PWR_MD_L5[1:0] | | PWR_MD_L6[1:0] | | PWR_MD_L7[1:0] | |
| Reset | OTP | | OTP | | OTP | | OTP | |
| Access Type | Write, Read | | Write, Read | | Write, Read | | Write, Read | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PWR_MD_L4 | 7:6 | <p>When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.</p> <p>When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.</p> |
| PWR_MD_L5 | 5:4 | <p>When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.</p> <p>When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.</p> |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PWR_MD_L6 | 3:2 | <p>When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.</p> <p>When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.</p> |
| PWR_MD_L7 | 1:0 | <p>When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.</p> <p>When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.</p> |

LDO_PWR_MD8 (0x9A)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|----------------|---|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | PWR_MD_L8[1:0] | |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | OTP | |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| PWR_MD_L8 | 1:0 | <p>When FPSSRC_Lx[1:0] = 0b11 0b00 = Output disabled. LDOx is off. 0b01 = Group low-power mode. LDOx operates in normal mode when the global low-power mode signal is low. When the global low-power mode signal is high, LDOx operates in low-power mode. 0b10 = Low-power Mode. LDOx is forced into low-power mode. The maximum load current is 5mA and the quiescent supply current is 1.5mA. 0b11 = Normal mode. LDOx is forced into its normal operating mode.</p> <p>When FPSSRC_Lx[1:0] ≠ 0b11 0b00 = Output disabled. LDOx is off. 0b01 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled when the flexible power sequencer is enabled. When LDOx is enabled, it operates in normal mode when the global low-power mode signal is low, and it operates in low-power mode when the global low-power mode signal is logic high. 0b10 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in low-power mode when the flexible power sequencer is enabled. 0b11 = LDOx is disabled when the flexible power sequencer set by FPSSRC_Lx is disabled. LDOx is enabled in normal-power mode when the flexible power sequencer is enabled.</p> |

LDO0FPS (0x9B)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|----------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_L0[1:0] | | LDO0UPSLT[2:0] | | | LDO0DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_L0 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx. |
| LDO0UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| LDO0DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

LDO1FPS (0x9C)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_L1[1:0] | | LDO1UPSLT[2:0] | | | LDO1DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_L1 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx. |
| LDO1UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| LDO1DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

LDO2FPS (0x9D)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_L2[1:0] | | LDO2UPSLT[2:0] | | | LDO2DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_L2 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx. |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| LDO2UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| LDO2DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

LDO3FPS (0x9E)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_L3[1:0] | | LDO3UPSLT[2:0] | | | LDO3DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_L3 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx. |
| LDO3UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| LDO3DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

[LDO4FPS \(0x9F\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_L4[1:0] | | LDO4UPSLT[2:0] | | | LDO4DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_L4 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx. |
| LDO4UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| LDO4DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

[LDO5FPS \(0xA0\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_L5[1:0] | | LDO5UPSLT[2:0] | | | LDO5DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_L5 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx. |
| LDO5UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| LDO5DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

LDO6FPS (0xA1)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_L6[1:0] | | LDO6UPSLT[2:0] | | | LDO6DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_L6 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx. |
| LDO6UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| LDO6DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

LDO7FPS (0xA2)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_L7[1:0] | | LDO7UPSLT[2:0] | | | LDO7DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_L7 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx. |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| LDO7UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| LDO7DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

LDO8FPS (0xA3)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|----------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_L8[1:0] | | LDO8UPSLT[2:0] | | | LDO8DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_L8 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence: • The LDO enables are controlled by PWR_MD_Lx. |
| LDO8UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| LDO8DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

[SD0FPS \(0xA4\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------|---|---------------|---|---|---------------|---|---|
| Field | FPSSRC_SD0[1:0] | | SD0UPSLT[2:0] | | | SD0DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_SD0 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence. |
| SD0UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| SD0DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

[SD1FPS \(0xA5\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------|---|---------------|---|---|---------------|---|---|
| Field | FPSSRC_SD1[1:0] | | SD1UPSLT[2:0] | | | SD1DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_SD1 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence. |
| SD1UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD1DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

SD2FPS (0xA6)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------|---|---------------|---|---|---------------|---|---|
| Field | FPSSRC_SD2[1:0] | | SD2UPSLT[2:0] | | | SD2DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_SD2 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence. |
| SD2UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| SD2DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

SD3FPS (0xA7)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------|---|---------------|---|---|---------------|---|---|
| Field | FPSSRC_SD3[1:0] | | SD3UPSLT[2:0] | | | SD3DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|----------------------------------------------------------------------------------------------------------|
| FPSSRC_SD3 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD3UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| SD3DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

GPIO0FPS (0xA8)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------------|---|-----------------|---|---|-----------------|---|---|
| Field | FPSSRC_GPIO0[1:0] | | GPIO0UPSLT[2:0] | | | GPIO0DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_GPIO0 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence. |
| GPIO0UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| GPIO0DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

GPIO1FPS (0xA9)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------------|---|-----------------|---|---|-----------------|---|---|
| Field | FPSSRC_GPIO1[1:0] | | GPIO1UPSLT[2:0] | | | GPIO1DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_GPIO1 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence. |
| GPIO1UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| GPIO1DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

GPIO2FPS (0xAA)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------------|---|-----------------|---|---|-----------------|---|---|
| Field | FPSSRC_GPIO2[1:0] | | GPIO2UPSLT[2:0] | | | GPIO2DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_GPIO2 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence. |
| GPIO2UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| GPIO2DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

[GPIO7FPS \(0xAB\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------------|---|-----------------|---|---|-----------------|---|---|
| Field | FPSSRC_GPIO7[1:0] | | GPIO7UPSLT[2:0] | | | GPIO7DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_GPIO7 | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence. |
| GPIO7UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |
| GPIO7DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

[RSTIOFPS \(0xAC\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------------|---|----------------|---|---|----------------|---|---|
| Field | FPSSRC_RSTIO[1:0] | | RST7UPSLT[2:0] | | | RST7DNSLT[2:0] | | |
| Reset | OTP | | OTP | | | OTP | | |
| Access Type | Write, Read | | Write, Read | | | Write, Read | | |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| FPSSRC_RSTIO | 7:6 | 0b00 = FPS0 0b01 = FPS1 0b10 = FPS1 0b11 = Not configured as part of a flexible power sequence. |
| RST7UPSLT | 5:3 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| RST7DNSLT | 2:0 | 3'b000 = Slot 0 3'b001 = Slot 1 3'b010 = Slot 2 3'b011 = Slot 3 3'b100 = Slot 4 3'b101 = Slot 5 3'b110 = Slot 6 3'b111 = Slot 7 |

SD0_CNFG1 (0x40)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|---|---|---|---|---|
| Field | RSVD | SD0VOUT[6:0] | | | | | | |
| Reset | 0b0 | OTP | | | | | | |
| Access Type | Write, Read | Write, Read | | | | | | |
| BITFIELD | BITS | DESCRIPTION | | | | | | |
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care | | | | | | |
| SD0VOUT | 6:0 | This 7-bit configuration is a linear transfer function that starts at 0.26V, ends at 1.52V, with 10mV increments. $VSD1 = 0.26V + ((SD0VOUT[6:0] - 1) \times 10mV)$ Note: The 0x00 setting is reserved. | | | | | | |

SD1_CNFG1 (0x41)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|---|---|---|---|---|
| Field | RSVD | SD1VOUT[6:0] | | | | | | |
| Reset | 0b0 | OTP | | | | | | |
| Access Type | Write, Read | Write, Read | | | | | | |
| BITFIELD | BITS | DESCRIPTION | | | | | | |
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care | | | | | | |
| SD1VOUT | 6:0 | This 7-bit configuration is a linear transfer function that starts at 0.26V, ends at 1.52V, with 10mV increments. $VSD1 = 0.26V + ((SD1VOUT[6:0] - 1) \times 10mV)$ Note: The 0x00 setting is reserved. | | | | | | |

SD2_CNFG1 (0x42)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|---|---|---|---|---|
| Field | SD2VOUT[7:0] | | | | | | | |
| Reset | OTP | | | | | | | |
| Access Type | Write, Read | | | | | | | |
| BITFIELD | BITS | DESCRIPTION | | | | | | |
| SD2VOUT | 7:0 | This 8-bit configuration is a linear transfer function that starts at 0.6V, ends at 2.194V, with 6.25mV increments. $VSD2 = 0.6V + (SD2VOUT[7:0] \times 6.25mV)$ | | | | | | |

[SD3_CNFG1 \(0x43\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|---|---|---|---|---|---|---|
| Field | SD3VOUT[7:0] | | | | | | | |
| Reset | OTP | | | | | | | |
| Access Type | Write, Read | | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD3VOUT | 7:0 | This 8-bit configuration is a linear transfer function that starts at 0.6V, ends at 3.7875V, with 12.5mV increments. $VSD3 = 0.6V + (SD3VOUT[7:0] \times 12.5mV)$ |

[SD0_CNFG2 \(0x44\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | SD0_SSRAMP | RSVD | RSVD | SD0FSREN | SD0ADDIS | SD0FPWMEN |
| Reset | 0b0 | 0b0 | OTP | 0b0 | 0b0 | 0b1 | OTP | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| SD0_SSRAMP | 5 | 0 = 2.5mV/ μ s Ramp rate 1 = 10mV/ μ s Ramp rate This bit was changed from function to OTP only to avoid the BUCKOV issue when the ramp rate if changed on the fly, from 10mV to 2.5mV. Customer does not change this setting on the fly, and to avoid a false trigger this bit is converted to OTP only. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| SD0FSREN | 2 | 0 = Active Discharge Disabled SD0 is allowed to operate in skip mode during the time the output voltage decreases (only if SD0FPWMEN = 0). In skip mode, SD0 cannot sink current from the output capacitor and the output voltage falling slew rate is a function of the external load. If the external load is heavy, then the output voltage falling slew rate becomes the fixed output voltage ramp rate. If the external load is light, then the output voltage falling slew rate becomes a function of the output capacitance and the external load. Note that the internal feedback string always imposes a 2 μ A load on the output. 1 = Active-discharge enabled. SD0 operates in forced PWM mode during the time the output voltage decreases. With forced PWM mode enabled, SD0 can sink current from the output capacitor to ensure that the output voltage falls at the rate fixed for output voltage ramp. To ensure a smooth output voltage decrease, the PWM mode remains engaged for 50 μ s after the output voltage decreases to its target voltage. |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD0ADDIS | 1 | 0 = The active discharge function is enabled. When SD0 converter is disabled, an internal 100Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When SD0 converter is enabled, the discharge resistor is disconnected from the output. 1 = The active discharge function is disabled. When SD1 converter is disabled, the internal 100Ω discharge resistor is not connected to the output, and the discharge rate is dependent on the output capacitance and the load present. |
| SD0FPWMEN | 0 | 0 = SD0 converter automatically skips pulses under light load conditions and transfers to fixed frequency operation as the load current increases. 1 = SD0 converter operates with fixed frequency under all load conditions. |

SD0_CNFG3 (0x45)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------|---|-----------------|---|-------------|----------------|---|----------------|
| Field | SD0_BO_THR[1:0] | | SD0_BO_HYS[1:0] | | RSVD | SD0_BO_PR[1:0] | | SD0_OV_T HR |
| Reset | OTP | | OTP | | 0x0 | 0b11 | | OTP |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD0_BO_THR | 7:6 | This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD0VOUT[6:0]), that starts at 75%, and ends at 90% in 5% increments. 2'b00 = 75% 2'b01 = 80% 2'b10 = 85% 2'b11 = 90% |
| SD0_BO_HYS | 5:4 | This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD0VOUT[6:0]), that starts at 5%, and ends at 20% in 5% increments. 2'b00 = 5% 2'b01 = 10% 2'b10 = 15% 2'b11 = 20% |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| SD0_BO_PR | 2:1 | This 2-bit configuration provides four settings for response time (and Iq). 2'b00 = Fast 2'b01 = Medium-fast 2'b10 = Medium-slow 2'b11 = Slow |
| SD0_OV_THR | 0 | This 1-bit configuration provides two options for SD0 output over-voltage comparator rising threshold, expressed as a % of the output voltage setting (SD0VOUT[6:0]). 0 = 108.3% 1 = 116.6% |

SD1_CNFG2 (0x46)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|-------------|-------------|----------------|-------------|-------------|-------------|-------------|---------------|
| Field | RSVD | RSVD | SD1_SSRA MP | RSVD | RSVD | SD0FSREN | SD0ADDIS | SD0FPWM EN |
| Reset | 0b0 | 0b0 | OTP | 0b0 | 0b0 | 0b1 | OTP | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. | |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. | |
| SD1_SSRA MP | 5 | This bit was changed from function to OTP only to avoid the BUCKOV issue when the ramp rate if changed on the fly from 10mV to 2.5mV. Customer does not change this setting on the fly, and to avoid any false trigger, this bit is converted to OTP only. | 0x0: 2.5mV/μs 0x1: 10mV/μs Ramp rate |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. | |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. | |
| SD0FSREN | 2 | <p>0 = Active discharge disabled. SD0 is allowed to operate in skip mode during the time the output voltage decreases (only if SD1FPWMEN = 0). In skip mode, SD1 cannot sink current from the output capacitor and the output voltage falling slew rate is a function of the external load. If the external load is heavy, then the output voltage falling slew rate becomes the fixed output voltage ramp rate. If the external load is light, then the output voltage falling slew rate becomes a function of the output capacitance and the external load. Note that the internal feedback string always imposes a 2μA load on the output.</p> <p>1 = Active discharge enabled. SD1 operates in forced PWM mode during the time the output voltage decreases. With forced PWM mode enabled, SD1 sinks current from the output capacitor to ensure that the output voltage falls at the rate fixed for output voltage ramp. To ensure a smooth output voltage decrease, the PWM mode remains engaged for 50μs after the output voltage decreases to its target voltage.</p> | |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|---------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| SD0ADDIS | 1 | 0 = The active discharge function is enabled. When the SD1 converter is disabled, an internal 100Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When the SD1 converter is enabled, the discharge resistor is disconnected from the output. 1 = The active discharge function is disabled. When the SD1 converter is disabled, the internal 100Ω discharge resistor is not connected to the output, and the discharge rate is dependent on the output capacitance and the load present. | |
| SD0FPWME N | 0 | 0 = SD0 converter automatically skips pulses under light load conditions and transfers to fixed frequency operation as the load current increases. 1 = SD0 converter operates with fixed frequency under all load conditions. | |

SD1_CNFG3 (0x47)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|-----------------|---|-----------------|---|-------------|----------------|---|----------------|
| Field | SD1_BO_THR[1:0] | | SD1_BO_HYS[1:0] | | RSVD | SD1_BO_PR[1:0] | | SD1_OV_T HR |
| Reset | OTP | | OTP | | 0b0 | 0b11 | | OTP |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD1_BO_THR | 7:6 | This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD1VOUT[6:0]), that starts at 75%, ends at 90% in 5% increments. 2'b00 = 75% 2'b01 = 80% 2'b10 = 85% 2'b11 = 90% |
| SD1_BO_HYS | 5:4 | This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD1VOUT[6:0]), that starts at 5%, ends at 20% in 5% increments. 2'b00 = 5% 2'b01 = 10% 2'b10 = 15% 2'b11 = 20% |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| SD1_BO_PR | 2:1 | This 2-bit configuration provides four settings for response time (and Iq). 2'b00 = Fast 2'b01 = Medium-fast 2'b10 = Medium-slow 2'b11 = Slow |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD1_OV_THR | 0 | This 1-bit configuration provides two options for SD1 output over-voltage comparator rising threshold, expressed as a % of the output voltage setting (SD1VOUT[6:0]). 0 = 108.3% 1 = 116.6% |

SD2_CNFG2 (0x48)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | SD2ADDIS | SD2FPWM EN |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | OTP | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| SD2ADDIS | 1 | 0 = The active discharge function is enabled. When the SD2 converter is disabled, an internal 100Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When the SD2 converter is enabled, the discharge resistor is disconnected from the output. 1 = The active discharge function is disabled. When the SD2 converter is disabled, the internal 100Ω discharge resistor is not connected to the output, and the discharge rate is dependent on the output capacitance and the load present. |
| SD2FPWMEN | 0 | 0 = SD2 converter automatically skips pulses under light load conditions and transfers to fixed frequency operation as the load current increases. 1 = SD2 converter operates with fixed frequency under all load conditions. |

SD2_CNFG3 (0x49)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------|---|-----------------|---|-------------|----------------|---|-------------|
| Field | SD2_BO_THR[1:0] | | SD2_BO_HYS[1:0] | | RSVD | SD2_BO_PR[1:0] | | SD2_OV_T HR |
| Reset | OTP | | OTP | | 0b0 | OTP | | OTP |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD2_BO_THR | 7:6 | This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD1VOUT[6:0]), that starts at 75%, ends at 90% in 5% increments. 2'b00 = 75% 2'b01 = 80% 2'b10 = 85% 2'b11 = 90% |
| SD2_BO_HYS | 5:4 | This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD2VOUT[6:0]), that starts at 5%, ends at 20% in 5% increments. 2'b00 = 5% 2'b01 = 10% 2'b10 = 15% 2'b11 = 20% |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| SD2_BO_PR | 2:1 | This 2-bit configuration provides four settings for response time (and Iq). 2'b00 = Fast 2'b01 = Medium-fast 2'b10 = Medium-slow 2'b11 = Slow |
| SD2_OV_THR | 0 | This 1-bit configuration provides two options for SD2 output over-voltage comparator rising threshold, expressed as a % of the output voltage setting (SD2VOUT[7:0]). 0 = 108.3% 1 = 116.6% |

SD3_CNFG2 (0x4A)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | SD3ADDIS | SD3FPWM EN |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | OTP | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------------------------------|
| RSVD | 7 | Blank. There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 6 | Blank. There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 5 | Blank. There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 4 | Blank. There is no physical bit at this location. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD3ADDIS | 1 | 0 = The active discharge function is enabled. When the SD3 converter is disabled, an internal 100Ω discharge resistor is connected to the output to discharge the energy stored in the output capacitor. When the SD3 converter is enabled, the discharge resistor is disconnected from the output. 1 = The active discharge function is disabled. When the SD3 converter is disabled, the internal 100Ω discharge resistor is not connected to the output, and the discharge rate is dependent on the output capacitance and the load present. |
| SD3FPWMEN | 0 | 0 = SD3 converter automatically skips pulses under light load conditions and transfers to fixed frequency operation as the load current increases. 1 = SD3 converter operates with fixed frequency under all load conditions. |

SD3_CNFG3 (0x4B)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-----------------|---|-----------------|---|-------------|----------------|---|-------------|
| Field | SD3_BO_THR[1:0] | | SD3_BO_HYS[1:0] | | RSVD | SD3_BO_PR[1:0] | | SD3_OV_THR |
| Reset | OTP | | OTP | | 0b0 | 0b11 | | OTP |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SD3_BO_THR | 7:6 | This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD1VOUT[6:0]), that starts at 75%, ends at 90% in 5% increments. 2'b00 = 75% 2'b01 = 80% 2'b10 = 85% 2'b11 = 90% |
| SD3_BO_HYS | 5:4 | This 2-bit configuration is a linear transfer function, expressed as a % of output voltage setting (SD3VOUT[6:0]), that starts at 5%, ends at 20% in 5% increments. 2'b00 = 5% 2'b01 = 10% 2'b10 = 15% 2'b11 = 20% |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| SD3_BO_PR | 2:1 | This 2-bit configuration provides four settings for response time (and Iq). 2'b00 = Fast 2'b01 = Medium-fast 2'b10 = Medium-slow 2'b11 = Slow |
| SD3_OV_THR | 0 | This 1-bit configuration provides two options for SD3 output over-voltage comparator rising threshold, expressed as a % of the output voltage setting (SD2VOUT[7:0]). 0 = 108.3% 1 = 116.6% |

LDO_CNFG1_L0 (0x50)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|------------------|---|---|---|---|---|
| Field | RSVD | RSVD | VOUT_LDO_L0[5:0] | | | | | |
| Reset | 0b0 | 0b0 | OTP | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| VOUT_LDO_L0 | 5:0 | This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 2.375V, with 25mV increments. $V_{LDO} = 0.8V + (V_{OUT_LDO}[5:0] \times 25mV)$. |

LDO_CNFG2_L0 (0x51)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | OVCLMP_EN_L0 | ALPM_EN_L0 | RSVD | RSVD | POK_L0 | RSVD | ADE_L0 | SS_L0 |
| Reset | OTP | OTP | 0b0 | 0b0 | 0b0 | 0b0 | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OVCLMP_EN_L0 | 7 | 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default). |
| ALPM_EN_L0 | 6 | 0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| POK_L0 | 3 | 0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ADE_L0 | 1 | 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. |
| SS_L0 | 0 | (Applies to both start-up and output voltage setting changes) 0 = Fast start-up and dynamic voltage change = 100mV/μs. 1 = Slow start-up and dynamic voltage change = 5mV/μs. |

[LDO_CNFG1_L1 \(0x52\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|------------------|---|---|---|---|---|
| Field | RSVD | RSVD | VOUT_LDO_L1[5:0] | | | | | |
| Reset | 0b0 | 0b0 | OTP | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| VOUT_LDO_L1 | 5:0 | This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 2.375V, with 25mV increments. $V_{LDO} = 0.8V + (V_{OUT_LDO}[5:0] \times 25mV)$. |

[LDO_CNFG2_L1 \(0x53\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | OVCLMP_EN_L1 | ALPM_EN_L1 | RSVD | RSVD | POK_L1 | RSVD | ADE_L1 | SS_L1 |
| Reset | OTP | OTP | 0b0 | 0b0 | 0b0 | 0b0 | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OVCLMP_EN_L1 | 7 | 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default). |
| ALPM_EN_L1 | 6 | 0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| POK_L1 | 3 | 0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ADE_L1 | 1 | 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. |
| SS_L1 | 0 | (Applies to both start-up and output voltage setting changes) 0 = Fast start-up and dynamic voltage change = 100mV/μs. 1 = Slow start-up and dynamic voltage change = 5mV/μs. |

LDO_CNFG1_L2 (0x54)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|------------------|---|---|---|---|---|
| Field | RSVD | RSVD | VOUT_LDO_L2[5:0] | | | | | |
| Reset | 0b0 | 0b0 | OTP | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| VOUT_LDO_L2 | 5:0 | This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 3.95V, with 50mV increments. VLDO = 0.8V + (VOUT_LDO[5:0] x 50mV). |

LDO_CNFG2_L2 (0x55)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|-------------|--------------|---|-------------|-------------|-------------|-------------|
| Field | OVCLMP_EN_L2 | ALPM_EN_L2 | COMP_L2[1:0] | | POK_L2 | RSVD | ADE_L2 | SS_L2 |
| Reset | OTP | OTP | OTP | | 0b0 | 0b0 | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OVCLMP_EN_L2 | 7 | 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default). |
| ALPM_EN_L2 | 6 | 0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled. |
| COMP_L2 | 5:4 | 0b00 = Fast transconductance setting for internal amplifier. Use this setting when the LDO output capacitor loop has a series R-L-C output impedance of 50mW, 5nH, and \geq COUT_x. This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., not remote). Load transient performance with this setting is 55mV typical between OUTxx and GND (default). |
| POK_L2 | 3 | 0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ADE_L2 | 1 | 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. |
| SS_L2 | 0 | (Applies to both start-up and output voltage setting changes) 0 = Fast start-up and dynamic voltage change = 100mV/ μ s. 1 = Slow start-up and dynamic voltage change = 5mV/ μ s. |

LDO_CNFG1_L3 (0x56)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|------------------|---|---|---|---|---|
| Field | RSVD | RSVD | VOUT_LDO_L3[5:0] | | | | | |
| Reset | 0b0 | 0b0 | OTP | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| VOUT_LDO_L3 | 5:0 | This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 3.95V, with 50mV increments. VLDO = 0.8V + (VOUT_LDO[5:0] x 50mV). |

LDO_CNFG2_L3 (0x57)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|-------------|--------------|---|-------------|-------------|-------------|-------------|
| Field | OVCLMP_EN_L3 | ALPM_EN_L3 | COMP_L3[1:0] | | POK_L3 | RSVD | ADE_L3 | SS_L3 |
| Reset | OTP | OTP | OTP | | 0b0 | 0b0 | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OVCLMP_EN_L3 | 7 | 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default). |
| ALPM_EN_L3 | 6 | 0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled. |
| COMP_L3 | 5:4 | 0b00 = Fast transconductance setting for internal amplifier. Use this setting when the LDOs output capacitor loop has a series R-L-C output impedance of 50mW, 5nH, and \geq COUT_x. This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., not remote). Load transient performance with this setting is 55mV typical between OUTxx and GND (default). |
| POK_L3 | 3 | 0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ADE_L3 | 1 | 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. |
| SS_L3 | 0 | (Applies to both start-up and output voltage setting changes) 0 = Fast start-up and dynamic voltage change = 100mV/ μ s. 1 = Slow start-up and dynamic voltage change = 5mV/ μ s. |

LDO_CNFG1_L4 (0x58)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|------------------|---|---|---|---|---|
| Field | RSVD | RSVD | VOUT_LDO_L4[5:0] | | | | | |
| Reset | 0b0 | 0b0 | OTP | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| VOUT_LDO_L4 | 5:0 | This 6-bit configuration is a linear transfer function that starts at 0.4V and ends at 1.275V, with 12.5mV increments. |

LDO_CNFG2_L4 (0x59)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|-------------|--------------|---|-------------|-------------|-------------|-------------|
| Field | OVCLMP_EN_L4 | ALPM_EN_L4 | COMP_L4[1:0] | | POK_L4 | RSVD | ADE_L4 | SS_L4 |
| Reset | OTP | OTP | OTP | | 0b0 | 0b0 | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OVCLMP_EN_L4 | 7 | 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default). |
| ALPM_EN_L4 | 6 | 0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled. |
| COMP_L4 | 5:4 | 0b00 = Fast transconductance setting for internal amplifier. Use this setting when the LDOs output capacitor loop has a series R-L-C output impedance of 50mW, 5nH, and \geq COU_T_4. This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., not remote). Load transient performance with this setting is 55mV typical between OUTxx and GND (default), |
| POK_L4 | 3 | 0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ADE_L4 | 1 | 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. |
| SS_L4 | 0 | (Applies to both start-up and output voltage setting changes) 0 = Fast start-up and dynamic voltage change = 100mV/ μ s. 1 = Slow start-up and dynamic voltage change = 5mV/ μ s. |

LDO_CNFG1_L5 (0x5A)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|------------------|---|---|---|---|---|
| Field | RSVD | RSVD | VOUT_LDO_L5[5:0] | | | | | |
| Reset | 0b0 | 0b0 | OTP | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| VOUT_LDO_L5 | 5:0 | This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 3.95V, with 50mV increments. VLDO = 0.8V + (VOUT_LDO[5:0] x 50mV). |

LDO_CNFG2_L5 (0x5B)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|-------------|--------------|---|-------------|-------------|-------------|-------------|
| Field | OVCLMP_EN_L5 | ALPM_EN_L5 | COMP_L5[1:0] | | POK_L5 | RSVD | ADE_L5 | SS_L5 |
| Reset | OTP | OTP | OTP | | 0b0 | 0b0 | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OVCLMP_EN_L5 | 7 | 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default). |
| ALPM_EN_L5 | 6 | 0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled. |
| COMP_L5 | 5:4 | 0b00 = Fast transconductance setting for internal amplifier. Use this setting when the LDOs output capacitor loop has a series R-L-C output impedance of 50mW, 5nH, and \geq COUT_x. This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., not remote). Load transient performance with this setting is 55mV typical between OUTxx and GND (default). |
| POK_L5 | 3 | 0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ADE_L5 | 1 | 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. |
| SS_L5 | 0 | (Applies to both start-up and output voltage setting changes) 0 = Fast start-up and dynamic voltage change = 100mV/ μ s. 1 = Slow start-up and dynamic voltage change = 5mV/ μ s. |

LDO_CNFG1_L6 (0x5C)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|------------------|---|---|---|---|---|
| Field | RSVD | RSVD | VOUT_LDO_L6[5:0] | | | | | |
| Reset | 0b0 | 0b0 | OTP | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| VOUT_LDO_L6 | 5:0 | This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 3.95V, with 50mV increments. VLDO = 0.8V + (VOUT_LDO[5:0] x 50mV). |

LDO_CNFG2_L6 (0x5D)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|-------------|--------------|---|-------------|-------------|-------------|-------------|
| Field | OVCLMP_EN_L6 | ALPM_EN_L6 | COMP_L6[1:0] | | POK_L6 | RSVD | ADE_L6 | SS_L6 |
| Reset | OTP | OTP | OTP | | 0b0 | 0b0 | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OVCLMP_EN_L6 | 7 | 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default). |
| ALPM_EN_L6 | 6 | 0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled. |
| COMP_L6 | 5:4 | 0b00 = Fast transconductance setting for internal amplifier. Use this setting when the LDOs output capacitor loop has a series R-L-C output impedance of 50mW, 5nH, and \geq COU _{T_x} . This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., not remote). Load transient performance with this setting is 55mV typical between OUT _{xx} and GND (default). |
| POK_L6 | 3 | 0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ADE_L6 | 1 | 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. |
| SS_L6 | 0 | (Applies to both start-up and output voltage setting changes) 0 = Fast startup and dynamic voltage change = 100mV/ μ s. 1 = Slow startup and dynamic voltage change = 5mV/ μ s. |

[LDO_CNFG1_L7 \(0x5E\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|------------------|---|---|---|---|---|
| Field | RSVD | RSVD | VOUT_LDO_L7[5:0] | | | | | |
| Reset | 0b0 | 0b0 | OTP | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| VOUT_LDO_L7 | 5:0 | This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 3.95V, with 50mV increments. VLDO = 0.8V + (VOUT_LDO[5:0] x 50mV). |

[LDO_CNFG2_L7 \(0x5F\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|-------------|--------------|---|-------------|-------------|-------------|-------------|
| Field | OVCLMP_EN_L7 | ALPM_EN_L7 | COMP_L7[1:0] | | POK_L7 | RSVD | ADE_L7 | SS_L7 |
| Reset | OTP | OTP | OTP | | 0b0 | 0b0 | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OVCLMP_EN_L7 | 7 | 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default). |
| ALPM_EN_L7 | 6 | 0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled. |
| COMP_L7 | 5:4 | 0b00 = Fast transconductance setting for internal amplifier. Use this setting when the LDOs output capacitor loop has a series R-L-C output impedance of 50mW, 5nH, and \geq COUT_x. This output impedance corresponds to an output capacitor that is placed directly at the output pins of the LDO (i.e., not remote). Load transient performance with this setting is 55mV typical between OUTxx and GND (default). |
| POK_L7 | 3 | 0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ADE_L7 | 1 | 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. |
| SS_L7 | 0 | (Applies to both start-up and output voltage setting changes) 0 = Fast startup and dynamic voltage change = 100mV/ μ s. 1 = Slow startup and dynamic voltage change = 5mV/ μ s. |

LDO_CNFG1_L8 (0x60)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|------------------|---|---|---|---|---|
| Field | RSVD | RSVD | VOUT_LDO_L8[5:0] | | | | | |
| Reset | 0b0 | 0b0 | OTP | | | | | |
| Access Type | Write, Read | Write, Read | Write, Read | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|-------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| VOUT_LDO_L8 | 5:0 | This 6-bit configuration is a linear transfer function that starts at 0.8V and ends at 3.95V, with 50mV increments. VLDO = 0.8V +(VOUT_LDO[5:0] x 50mV). |

LDO_CNFG2_L8 (0x61)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|--------------|-------------|-------------|---|-------------|-------------|-------------|-------------|
| Field | OVCLMP_EN_L8 | ALPM_EN_L8 | RSVD[1:0] | | POK_L8 | RSVD | ADE_L8 | SS_L8 |
| Reset | OTP | OTP | 0b00 | | 0b0 | 0b0 | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|--------------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OVCLMP_EN_L8 | 7 | 0 = Overvoltage clamp disabled. 1 = Overvoltage clamp enabled (default). |
| ALPM_EN_L8 | 6 | 0 = Auto low-power mode is disabled (default). 1 = Auto low-power mode is enabled. |
| RSVD | 5:4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| POK_L8 | 3 | 0 = The voltage is less than the POK threshold. 1 = The voltage is above the POK threshold. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| ADE_L8 | 1 | 0 = The active discharge function is disabled. When the regulator is disabled, the internal active-discharge resistor is not connected to its output and the output voltage decays at a rate that is determined by the output capacitance and the external load. When the regulator is enabled, the internal active-discharge resistor is not connected to its output. 1 = The active discharge function is enabled. When the regulator is disabled, an internal active-discharge resistor is connected to its output which discharges the energy stored in the output capacitance. When this regulator is enabled, the internal active-discharge resistor is disconnected from its output. |
| SS_L8 | 0 | (Applies to both start-up and output voltage setting changes) 0 = Fast startup and dynamic voltage change = 100mV/μs. 1 = Slow startup and dynamic voltage change = 5mV/μs. |

LDO_CNFG3 (0x62)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|-------------|
| Field | RSVD[6:0] | | | | | | | L_B_EN |
| Reset | 0b0000000 | | | | | | | 0b0 |
| Access Type | Write, Read | | | | | | | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------|
| RSVD | 7:1 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| L_B_EN | 0 | 0 = Bias is disabled if all LDOs are disabled (default). 1 = Bias is enabled. |

CNFG_GPIO0 (0x70)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---------------|---|-------------|-------------|-------------|-------------|
| Field | DBNC0[1:0] | | REFE_IRQ[1:0] | | DO0 | DI0 | DIR0 | PPDRV0 |
| Reset | 0b0 | | 0b0 | | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DBNC0 | 7:6 | When set for GPO (DIRx = 0): DBNCx are don't care when GPO. When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms |
| REFE_IRQ | 5:4 | When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO. When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt |
| DO0 | 3 | When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0) When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information. |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DI0 | 2 | When set for GPO (DIRx = 0): DIx is a don't care when GPO. When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored. |
| DIR0 | 1 | When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI) When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high |
| PPDRV0 | 0 | When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI. |

CNFG_GPIO1 (0x71)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|---|---------------|---|-------------|-------------|-------------|-------------|
| Field | DBNC1[1:0] | | REFE_IRQ[1:0] | | DO1 | DI1 | DIR1 | PPDRV1 |
| Reset | 0b0 | | 0b0 | | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DBNC1 | 7:6 | When set for GPO (DIRx = 0): DBNCx are don't care when GPO. When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| REFE_IRQ | 5:4 | <p>When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt</p> |
| DO1 | 3 | <p>When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0)</p> <p>When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.</p> |
| DI1 | 2 | <p>When set for GPO (DIRx = 0): DIx is a don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.</p> |
| DIR1 | 1 | <p>When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI)</p> <p>When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high</p> |
| PPDRV1 | 0 | <p>When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull</p> <p>When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.</p> |

CNFG_GPIO2 (0x72)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|---|---------------|---|-------------|-------------|-------------|-------------|
| Field | DBNC2[1:0] | | REFE_IRQ[1:0] | | DO2 | DI2 | DIR2 | PPDRV2 |
| Reset | 0b0 | | 0b0 | | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DBNC2 | 7:6 | <p>When set for GPO (DIRx = 0): DBNCx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms</p> |
| REFE_IRQ | 5:4 | <p>When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt</p> |
| DO2 | 3 | <p>When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0)</p> <p>When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.</p> |
| DI2 | 2 | <p>When set for GPO (DIRx = 0): DIx is a don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.</p> |
| DIR2 | 1 | <p>When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI)</p> <p>When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high</p> |
| PPDRV2 | 0 | <p>When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull</p> <p>When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.</p> |

[CNFG_GPIO3 \(0x73\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---------------|---|-------------|-------------|-------------|-------------|
| Field | DBNC3[1:0] | | REFE_IRQ[1:0] | | DO3 | DI3 | DIR3 | PPDRV3 |
| Reset | 0b0 | | 0b0 | | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DBNC3 | 7:6 | <p>When set for GPO (DIRx = 0): DBNCx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms</p> |
| REFE_IRQ | 5:4 | <p>When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt</p> |
| DO3 | 3 | <p>When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0)</p> <p>When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.</p> |
| DI3 | 2 | <p>When set for GPO (DIRx = 0): DIx is a don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.</p> |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DIR3 | 1 | <p>When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI)</p> <p>When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high</p> |
| PPDRV3 | 0 | <p>When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull</p> <p>When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.</p> |

CNFG_GPIO4 (0x74)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|---|---------------|---|-------------|-------------|-------------|-------------|
| Field | DBNC4[1:0] | | REFE_IRQ[1:0] | | DO4 | DI4 | DIR4 | PPDRV4 |
| Reset | 0b0 | | 0b0 | | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DBNC4 | 7:6 | <p>When set for GPO (DIRx = 0): DBNCx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms</p> |
| REFE_IRQ | 5:4 | <p>When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt</p> |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DO4 | 3 | When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0) When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information. |
| DI4 | 2 | When set for GPO (DIRx = 0): DIx is a don't care when GPO. When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored. |
| DIR4 | 1 | When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI) When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high |
| PPDRV4 | 0 | When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI. |

CNFG_GPIO5 (0x75)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|---|---------------|---|-------------|-------------|-------------|-------------|
| Field | DBNC5[1:0] | | REFE_IRQ[1:0] | | DO5 | DI5 | DIR5 | PPDRV5 |
| Reset | 0b0 | | 0b0 | | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DBNC5 | 7:6 | When set for GPO (DIRx = 0): DBNCx are don't care when GPO. When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| REFE_IRQ | 5:4 | <p>When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt</p> |
| DO5 | 3 | <p>When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0)</p> <p>When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.</p> |
| DI5 | 2 | <p>When set for GPO (DIRx = 0): DIx is a don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.</p> |
| DIR5 | 1 | <p>When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI)</p> <p>When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high</p> |
| PPDRV5 | 0 | <p>When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull</p> <p>When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.</p> |

CNFG_GPIO6 (0x76)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|---|---------------|---|-------------|-------------|-------------|-------------|
| Field | DBNC6[1:0] | | REFE_IRQ[1:0] | | DO6 | DI6 | DIR6 | PPDRV6 |
| Reset | 0b0 | | 0b0 | | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DBNC6 | 7:6 | <p>When set for GPO (DIRx = 0): DBNCx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms</p> |
| REFE_IRQ | 5:4 | <p>When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt</p> |
| DO6 | 3 | <p>When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0)</p> <p>When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.</p> |
| DI6 | 2 | <p>When set for GPO (DIRx = 0): DIx is a don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.</p> |
| DIR6 | 1 | <p>When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI)</p> <p>When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high</p> |
| PPDRV6 | 0 | <p>When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull</p> <p>When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.</p> |

[CNFG_GPIO7 \(0x77\)](#)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---------------|---|-------------|-------------|-------------|-------------|
| Field | DBNC7[1:0] | | REFE_IRQ[1:0] | | DO7 | DI7 | DIR7 | PPDRV7 |
| Reset | 0b0 | | 0b0 | | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | | Write, Read | | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DBNC7 | 7:6 | <p>When set for GPO (DIRx = 0): DBNCx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Debounce configuration. GPIx has the following debounce times for both rising and falling edges. 0b00 = No debounce 0b01 = 8ms 0b10 = 16ms 0b11 = 32ms</p> |
| REFE_IRQ | 5:4 | <p>When set for GPO (DIRx = 0): REFE_IRQx are don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Rising edge and falling edge interrupt configuration. GPIx has the interrupt behavior which is programmed with REFE_IRQx. 0b00 = Mask interrupt 0b01 = Falling edge interrupt 0b10 = Rising edge interrupt 0b11 = Falling and rising edge interrupt</p> |
| DO7 | 3 | <p>When set for GPO (DIRx = 0): GPO output drive level is programmed with DOx. 0 = Logic low 1 = Logic high (DRVx = 1) and open-drain (DRVx = 0)</p> <p>When set for GPI (DIRx = 1): 0 = Clear DOx to 0 and set PUEx to 1 to enable the internal pull-up. 1 = Set DOx to 1 and set PDEx to 1 to enable the internal pull-down. See the <i>GPIO Programming Matrix</i> section for more information.</p> |
| DI7 | 2 | <p>When set for GPO (DIRx = 0): DIx is a don't care when GPO.</p> <p>When set for GPI (DIRx = 1): Input Drive Level. GPIOx input logic level is specified by DIx. 0 = Input logic-low 1 = Input logic-high When DIRx = 1, this bit is read only, writes to this bit are ignored.</p> |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DIR7 | 1 | <p>When AMEx = 0: GPIOx direction. 0 = General purpose output (GPO) 1 = General purpose input (GPI)</p> <p>When AMEx = 1: When GPIO1/2/3/4 is set as an alternate mode output, write DIR1/2/3/4 (respectively) to 0 but note that the output is internally set to be active-high. When GPIO0/5/6 is set as an alternate mode input, DIR0/5/6 (respectively) determines if the signal is active high or active low. 0 = Active-low 1 = Active-high</p> |
| PPDRV7 | 0 | <p>When set for GPO (DIRx = 0): Push-pull output drive. GPIO output configuration is determined by PPDRVx. 0 = Open-drain 1 = Push-pull</p> <p>When set for GPI (DIRx = 1): PPDRVx is a don't care when GPI.</p> |

PUE_GPIO (0x78)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | PUE7 | PUE6 | PUE5 | PUE4 | PUE3 | PUE2 | PUE1 | PUE0 |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PUE7 | 7 | <p>GPOx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PUE6 | 6 | <p>GPOx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PUE5 | 5 | <p>GPOx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PUE4 | 4 | <p>GPIIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PUE3 | 3 | <p>GPIIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PUE2 | 2 | <p>GPIIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PUE1 | 1 | <p>GPIIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PUE0 | 0 | <p>GPIIx Pullup Enable 0 = Pullup disabled 1 = Pullup enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |

PDE_GPIO (0x79)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | PDE7 | PDE6 | PDE5 | PDE4 | PDE3 | PDE2 | PDE1 | PDE0 |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PDE7 | 7 | <p>GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PDE6 | 6 | <p>GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PDE5 | 5 | <p>GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PDE4 | 4 | <p>GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PDE3 | 3 | <p>GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PDE2 | 2 | <p>GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |
| PDE1 | 1 | <p>GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled</p> <p>See the <i>GPIO Programming Matrix</i> section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PDE0 | 0 | <p>GPOIx Pulldown Enable 0 = Pulldown disabled 1 = Pulldown enabled</p> <p>See the GPIO Programming Matrix section for more information.</p> <p>It is recommended that users disable the pullup and pulldown resistors for GPIO7 when it operates in alternate mode.</p> |

AME_GPIO (0x7A)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | AME7 | AME6 | AME5 | AME4 | AME3 | AME2 | AME1 | AME0 |
| Reset | OTP | OTP | OTP | OTP | OTP | OTP | OTP | OTP |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------|
| AME7 | 7 | Alternate Mode Enable for GPIO7. 0 = Standard GPI or GPO as programmed by DIR1. 1 = Flexible power sequencer active-high Output. |
| AME6 | 6 | Alternate Mode Enable for GPIO6. 0 = Standard GPI or GPO as programmed by DIR4. 1 = 32kHz output (32k_OUT1) |
| AME5 | 5 | Alternate Mode Enable for GPIO5. 0 = Standard GPI or GPO as programmed by DIR4. 1 = 32kHz output (32k_OUT1) |
| AME4 | 4 | Alternate Mode Enable for GPIO4. 0 = Standard GPI or GPO as programmed by DIR4. 1 = 32kHz output (32k_OUT1) |
| AME3 | 3 | Alternate Mode Enable for GPIO3. 0 = Standard GPI or GPO as programmed by DIR4. 1 = ACOK input |
| AME2 | 2 | Alternate Mode Enable for GPIO2. 0 = Standard GPI or GPO as programmed by DIR1. 1 = Flexible power sequencer active-high output. |
| AME1 | 1 | Alternate Mode Enable for GPIO1. 0 = Standard GPI or GPO as programmed by DIR1. 1 = Flexible power sequencer active-high output. |
| AME0 | 0 | Alternate Mode Enable for GPIO0. 0 = Standard GPI or GPO as programmed by DIR1. 1 = Flexible power sequencer active-high output. |

CID0 (0xB0)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|---|---|---|---|---|---|---|
| Field | SR[7:0] | | | | | | | |
| Reset | OTP | | | | | | | |
| Access Type | Write, Read | | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------|
| SR | 7:0 | SR[23:16] + SR[15:8] + SR[7:0] form a 24-bit serial number. |

CID1 (0xB1)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field | SR[15:8] | | | | | | | |
| Reset | OTP | | | | | | | |
| Access Type | Write, Read | | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------|
| SR | 7:0 | SR[23:16] + SR[15:8] + SR[7:0] form a 24-bit serial number. |

CID2 (0xB2)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field | SR[23:16] | | | | | | | |
| Reset | OTP | | | | | | | |
| Access Type | Write, Read | | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------|
| SR | 7:0 | SR[23:16] + SR[15:8] + SR[7:0] form a 24-bit serial number. |

CID3 (0xB3)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|---------------|---|---|---|-------------|---|---|---|
| Field | DIDM[3:0] | | | | DIDO[3:0] | | | |
| Reset | Metal Version | | | | OTP | | | |
| Access Type | Write, Read | | | | Write, Read | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DIDM | 7:4 | 4'b0000 = Initial metal mask (device version 1) 4'b0001 = First metal revision (device version 2) 4'b0010 and above are reserved for future revisions. |
| DIDO | 3:0 | 0x0 = Preproduction device 0x1 = Production device 0x2 = Experimental device 0x3 and above are reserved for future uses. |

CID4 (0xB4)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field | DRV[7:0] | | | | | | | |
| Reset | OTP | | | | | | | |
| Access Type | Write, Read | | | | | | | |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------|
| DRV | 7:0 | These bits track the OTP configuration for each part. |

CNFG BBC (0x80)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|---|---------------|-------------|---|-------------|---|-------------|
| Field | BBCRS[1:0] | | BBCLOWIE N | BBCVS[1:0] | | BBCCS[1:0] | | BBCEN |
| Reset | 0b01 | | 0b0 | 0b00 | | 0b00 | | 0b0 |
| Access Type | Write, Read | | Write, Read | Write, Read | | Write, Read | | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|-----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| BBCRS | 7:6 | 0x00 = 0.1kΩ 0x01 = 1kΩ 0x02 = 3kΩ 0x03 = 6kΩ |
| BBCLOWIEN | 5 | 0 = Enable 1 = Disable |
| BBCVS | 4:3 | 0x00 = 2.5V 0x01 = 3.0V 0x02 = 3.3V 0x03 = 3.5V |
| BBCCS | 2:1 | BBLOWIEN = 0 0x00 = 50μA 0x01 = 50μA 0x02 = 50μA 0x03 = 100μA BBLOWIEN = 1 0x00 = 200μA 0x01 = 600μA 0x10 = 800μA 0x11 = 400μA |
| BBCEN | 0 | 0 = Backup battery charger off 1 = Backup battery charger on |

I2C CTRL1 (0xC0)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | PAIR | RSVD | RSVD | WD_EN | HS_EXT |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| PAIR | 4 | 0 = Pair address mode is disabled and sequential mode is used for multiple register write protocol. 1 = Pair address mode is enabled for multiple register write protocol. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |

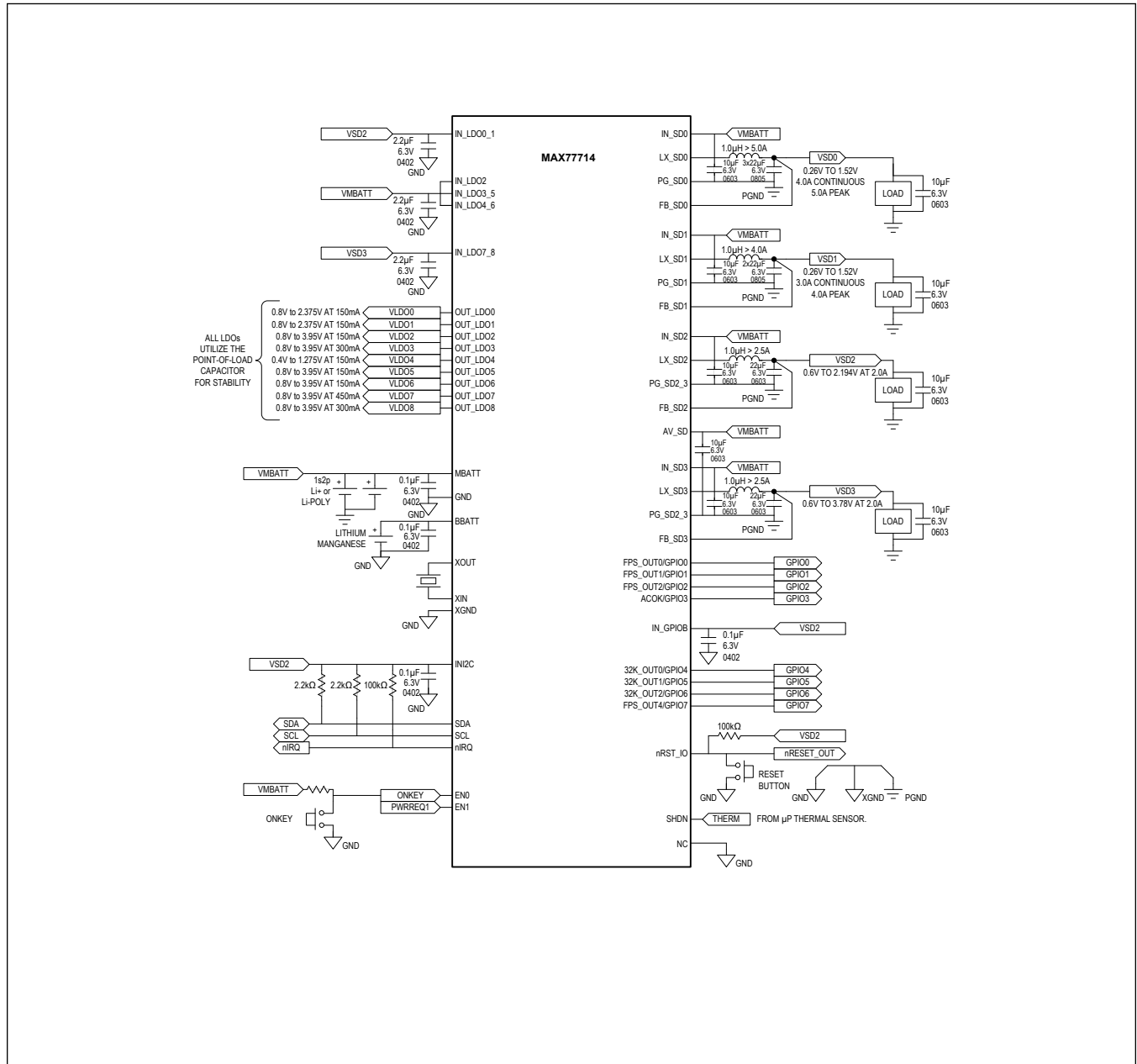
| BITFIELD | BITS | DESCRIPTION |
|----------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| WD_EN | 1 | 0 = Watchdog function is disabled (I ² C Rev 4.0 compliant) 1 = Watchdog function is enabled (SMBus compatible) |
| HS_EXT | 0 | 0 = HS-mode extension is disabled (I ² C Rev 4.0 compliant) 1 = HS-mode extension is enabled. HS-mode is enabled without HS-mode entrance code and keeps HS-mode during and after STOP condition. |

I²C_CTRL2 (0xC1)

| BIT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | I2CW P |
| Reset | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 | 0b0 |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD | BITS | DESCRIPTION |
|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RSVD | 7 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 6 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 5 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 4 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 3 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 2 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| RSVD | 1 | Reserved. Unutilized bit. Write to 0. Reads are don't care. |
| I2CW P | 0 | 0 = Disable write protect for all registers in the PMIC. Writes to any register through the I ² C write protocol results in the data value being written to the register. 1 = Enable write protect for all registers in the PMIC. Writes to any register through the I ² C write protocol does NOT result in the data value being written to the register. The STOP condition at the end of an I ² C transaction resets this bit back to its default value. |

Typical Application Circuit



MAX77714

Complete System PMIC, Featuring
13 Regulators, 8 GPIOs, RTC, and Flexible Power
Sequencing for Multicore Applications

Ordering Information

| PART NUMBER | TEMP. RANGE | PIN-PACKAGE |
|----------------|----------------|----------------------------------------------------------------|
| MAX77714EWC+T | -40°C to +85°C | 70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x01 |
| MAX77714FEWC+T | -40°C to +85°C | 70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x06 |
| MAX77714FEWC+ | -40°C to +85°C | 70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x06 |
| MAX77714GEWC+ | -40°C to +85°C | 70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x08 |
| MAX77714GEWC+T | -40°C to +85°C | 70-Bump, 0.4mm Pitch, WLP, 4.1mm x 3.25mm x 0.7mm; CID4 = 0x08 |

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

MAX77714

Complete System PMIC, Featuring 13 Regulators, 8 GPIOs, RTC, and Flexible Power Sequencing for Multicore Applications

Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|-----------------|---------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------|
| 0 | 4/18 | Initial release | — |
| 1 | 7/19 | Updated <i>Simplified Block Diagram</i> and TOC36, added MAX77714F to the <i>Ordering Information</i> table, and indicated which bits are OTP programmable in the <i>Register Map</i> tables | 2, 39, 81–83, 97, 100–104, 106–119, 121, 123–150, 163–166, 170 |
| 2 | 2/22 | Updated <i>Ordering Information</i> table | 166 |
| 3 | 11/22 | Updated Table 1 | 42, 43 |
| 4 | 5/23 | Updated <i>IN_SD0 to PG_SD0</i> , <i>IN_SD1 to PG_SD1</i> , and <i>IN_SD2 to PG_SD2</i> values in the <i>Absolute Maximum Ratings</i> section. Updated <i>Voltage Monitors</i> , <i>EN0 Functionality</i> , <i>EN0, Power-Off Event Recorder</i> , <i>Input Capacitor Selection</i> , <i>Output Capacitor Selection</i> , and <i>Internal Ballast Capacitors</i> sections. Updated <i>SD0_CNFG3 (0x45)</i> , <i>SD1_CNFG3 (0x47)</i> , <i>SD2_CNFG3 (0x49)</i> , and <i>SD3_CNFG3 (0x4B)</i> tables in the <i>Register Map</i> section. | 8, 42, 46, 53, 55, 66, 72, 131, 133–136 |